

M87X SERIES MEASUREMENT SYSTEM

Monitoring and Recording IED Manual



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FIRMWARE VERSION



The following table provides the most recent firmware and software versions. For best results, the Configurator version used should match with the firmware version. A complete list of firmware and software versions is provided on the 70 Series Utilities CD.

NOTE: Host firmware versions 3.0x require 70 Series IEDs with 64 MB SDRAM. Do not attempt to upgrade older 70 Series IEDs with insufficient memory to v3.0x.

Firmware Versions						
Description	Bios Version	DSP Firmware	Host Firmware	Configurator	Utilities CD	Release Date
M87x Product Release, New Hardware supported Dual Bus, Analog I/O	2.1/3.0*	1.21	2.05	2.31	2.43	03/24/06
M87x Product Release, Fault Location, Adjustable Sample Rate	3.40	1.30	2.17	2.43	2.56	12/21/07
M87x Product Release; Add Demand per phase for Watts ,VAr, & VA. Configurator & Biview improvements w/ modems. Change to Digital I/O default watchdog contact (Configurator setup). Support new version of hardware on P3x, P4x modules.	3.40	1.30	2.18	3.00A	2.57	10/17/08
M87x Product Release: Added 1mHz accuracy on M87x. Improved poll rate to 100ms for a single P40 transducer inputs module. Fault distance configuration is changed. Time sync with respect to DNP master is changed from the DNP master jamming the time to asking the master what time to jam. Increased waveform recording limit from 999 post trigger for longer recording.	3.40	1.31	2.19	3.02	2.58	09/30/2009
Mx7x Product Release, IEC61850 & SNTP; Avg 3-Ph Amps and Avg 3-Ph Volts	3.40	1.30	3.01.0	3.01	3.01	1/30/2009



Firmware Versions						
	Bios	DSP	Host		Utilities	Release
Description M87x Product Release: Added	Version	Firmware	Firmware	Configurator	CD	Date
1mHz accuracy on M87x. Improved poll rate to 100ms for a single P40 transducer inputs module. Fault distance configuration is changed. Time sync with respect to DNP master						
is changed from the DNP master jamming the time to asking the master what time to jam. Increased waveform recording limit from 999 post trigger for longer recording.	3.40	1.31	3.02.0	3.02	3.02	09/30/2009
M87x Product Release: Added virtual I/O to DR. Added Peak Fault Current Measurement. Improved password security. Added support for control characters for SMS.	3.40	1.31	3.04	3.04	3.04	10/15/2010
M87x Product Release: Added support for dual peak current input range M872 (S16, S17), IEEE C37.232 naming convention, periodic triggering, and 4 IEC 61850 buffered reports.	3.40	1.32	3.05	3.05	3.05	2/28/2011
M87x Product Release: Increased pre and post trigger times for DR recorders, modified base memory to 1MB	3.40	1.32	3.07	3.07	3.07	11/11/2011
M87x Product Release: New H12 Host Processor with and without E1 and E3 Ethernet options	N/A	1.33	4.01	4.01	4.01	3/15/13
M87x Product Release: Support for IEC 61850 Deadbands	N/A	1.33	4.02	4.02	4.02	4/25/13
M87x Product Release: IEC trigger options DNP3 certification	N/A	1.33	4.07	4.04	4.04	10/28/13
M871 Product Release: Support S1C split core option	N/A	1.34	4.082	4.06	4.06	11/14/14
M871 Product Release: Support new P33 module	N/A	1.35	4.09	4.09	4.09	6/22/15
Maintenance Upgrade	N/A	1.35	4.10	4.10	4.10	3/10/16
M87x – Add double point status object for input bit pairs, add IEC61850 support for P33 module	N/A	1.35	4.11	4.11	4.11	6/15/16
Correct Utilities CD Auto-Launch	N/A	1.35	4.11	4.11	4.12	7/11/16
Add .csv SER file; maintenance upgrade	N/A	1.35	4.13	4.13	4.13	2/16/17
BiView changes; maintenance upgrade	N/A	1.35	4.15	4.14	4.15	3/21/17



Firmware Versions						
Description	Bios Version	DSP Firmware	Host Firmware	Configurator	Utilities CD	Release Date
M87x Product Release: Support		1.35 M871				
for S2C split core option	N/A	1.36 M872	4.16	4.16	4.16	8/29/17
		1.35 M871				
Maintenance Upgrade	N/A	1.36 M872	4.17	4.17	4.17	4/5/18
Windows XP Support for		1.35 M871				
Configurator and BiView	N/A	1.36 M872	4.17	4.18	4.18	4/26/18

^{*} H10/H11

M87X MANUAL SET

ML0021	M87x User Manual
ML0022	70 SERIES UCA® Manual
ML0024	M87x Modbus Plus Module & Protocol
ML0025	70 SERIES Modbus Protocol
ML0026	70 SERIES DNP3 Protocol
ML0027	M870D Remote Display Manual – Obsolete Product
ML0034	70 SERIES IEC61850® Protocol Manual
ML0047	D650 Remote Display Manual

CERTIFICATION



Bitronics LLC certifies that the calibration of our products is based on measurements using equipment whose calibration is traceable to the United States National Institute of Standards Technology (NIST).

INSTALLATION AND MAINTENANCE

Bitronics LLC products are designed for ease of installation and maintenance. As with any product of this nature, installation and maintenance can present electrical hazards and should be performed only by properly trained and qualified personnel. If the equipment is used in a manner not specified by Bitronics LLC, the protection provided by the equipment may be impaired.

In order to maintain UL recognition, the following Conditions of Acceptability shall apply:

- a) Terminals and connectors that shall be connected to live voltages are restricted to non-field wiring applications only.
- b) After installation, all hazardous live parts shall be protected from contact by personnel or enclosed in a suitable enclosure.

WARRANTY AND ASSISTANCE

This product is warranted against defects in materials and workmanship for a period of one hundred and twenty (120) months from the date of their original shipment from the factory. Products repaired at the factory are likewise warranted for eighteen (18) months from the date the repaired product is shipped, or for the remainder of the product's original warranty, whichever is greater. Obligation under this warranty is limited to repairing or replacing, at our designated facility, any part or parts that our examination shows to be defective. Warranties only apply to products subject to normal use and service. There are no warranties, obligations, liabilities for consequential damages, or other liabilities on the part of Bitronics LLC except this warranty covering the repair of defective materials. The warranties of merchantability and fitness for a particular purpose are expressly excluded.

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SAFETY SECTION



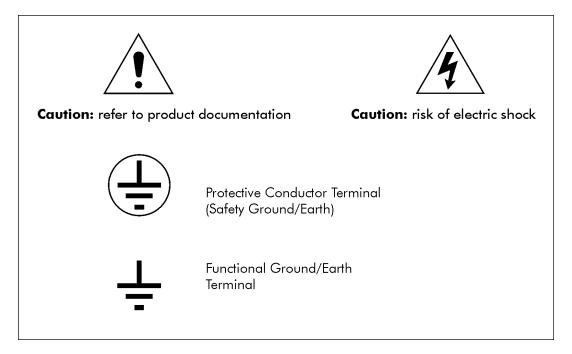
This Safety Section should be read before commencing any work on the equipment.

Health and safety

The information in the Safety Section of the product documentation is intended to ensure that products are properly installed and handled in order to maintain them in a safe condition. It is assumed that everyone who will be associated with the equipment will be familiar with the contents of the Safety Section.

Explanation of symbols and labels

The meaning of symbols and labels that may be used on the equipment or in the product documentation is given below.



Installing, Commissioning and Servicing



Equipment connections

Personnel undertaking installation, commissioning or servicing work on this equipment should be aware of the correct working procedures to ensure safety. The product documentation should be consulted before installing, commissioning or servicing the equipment.

Terminals exposed during installation, commissioning and maintenance may present a hazardous voltage unless the equipment is electrically isolated.

If there is unlocked access to the equipment, care should be taken by all personnel to avoid electric shock or energy hazards.



Voltage and current connections should be made using insulated crimp terminations to ensure that terminal block insulation requirements are maintained for safety. To ensure that wires are correctly terminated, the correct crimp terminal and tool for the wire size should be used.

Before energizing the equipment, it must be grounded (earthed) using the protective ground (earth) terminal, or the appropriate termination of the supply plug in the case of plug connected equipment. Omitting or disconnecting the equipment ground (earth) may cause a safety hazard.

The recommended minimum ground (earth) wire size is 2.5 mm² (#12 AWG), unless otherwise stated in the technical data section of the product documentation.

Before energizing the equipment, the following should be checked:

- 1. Voltage rating and polarity
- 2. CT circuit rating and integrity of connections
- 3. Protective fuse rating
- 4. Integrity of ground (earth) connection (*where applicable*)
- 5. Equipment operating conditions

The equipment should be operated within the specified electrical and environmental limits.



Current transformer circuits

Do not open the secondary circuit of a live CT since the high voltage produced may be lethal to personnel and could damage insulation.



Insulation and dielectric strength testing

Insulation testing may leave capacitors charged up to a hazardous voltage. At the end of each part of the test, the voltage should be gradually reduced to zero, to discharge capacitors, before the test leads are disconnected.



Removal and insertion of modules

All M87x active circuitry is located on removable modules. Unless a Module is specifically intended for Hot Swap (see documentation), it must not be inserted into or withdrawn from equipment while it is energized, since this may result in damage. Hot Swap modules may be installed and removed under power. Refer to the appropriate section or manual to determine if the particular module is Hot Swap compatible. For all other modules, remove all power from the unit before installing or removing any module.



All Hazardous Voltages MUST be removed from the M87x before removing or



installing the Power Supply Module (Vxx) or the Signal Input Module (S1x).



All connections to a module must be removed before removing the module. Do not attempt to install a module with signals connected.



Fiber optic communication

Where fiber optic communication devices are fitted, these should not be viewed directly. Optical power meters should be used to determine the operation or signal level of the device.



WARNING: EMISSIONS - CLASS A DEVICE (EN55011)

This is a Class A industrial device. Operation of this device in a residential area may cause harmful interference, which may require the user to take adequate measures.



DECOMMISSIONING AND DISPOSAL

1. Decommissioning

The auxiliary supply circuit in the equipment may include capacitors across the supply or to ground (earth). To avoid electric shock or energy hazards, after completely isolating the supplies to the relay (both poles of any dc supply), the capacitors should be safely discharged via the external terminals before decommissioning.

2. Disposal

It is recommended that incineration and disposal to watercourses is avoided. The product should be disposed of in a safe manner. Any products containing batteries should have them removed before disposal, taking precautions to avoid short circuits. Particular regulations within the country of operation may apply to the disposal of lithium batteries.

1.0 DESCRIPTION



1.1 Introduction

The M87x family of monitoring and recording IEDs with SubCycle[™] technology is a major breakthrough in power measurement technology. The M87x IEDs were designed to expand the limits of range, speed, and accuracy of measurement, speed of communications, and modularity. It combines a modular-by-board chassis featuring a CompactPCI[™] card cage, with a dual processor measurement system featuring a 32-bit floating point Digital Signal Processor (DSP) and a 486-based host processor.

1.2 Features

- □ Extensive measurement set including two sets of voltages and currents with corresponding power and energy on some models
- Simultaneous support of multiple protocols over multiple physical links
- Two completely independent Disturbance Recorders
- □ Two separate Waveform Recorders
- □ Trend Recorder
- Sequence of Event log
- Voltage Fluctuation Table to use for sag and swell reporting
- □ Two options for analog inputs, 8 voltages with 4 currents and 2 auxiliary voltages or 8 voltages with 6 currents
- □ 128 samples per cycle, 16-bit sampling.
- 32-bit floating point DSP, capable of 180 MFLOPS (Million Floating Point Operations Per Second). A 128-point complex Fast Fourier Transform (FFT) is performed in less than 50 microseconds.
- □ 486-class Host processor.
- Watchdog timer maximizes system reliability.
- □ 4 Configurable serial ports Three RS232/RS485 ports/one DB9M Service RS232 port
- □ Fully compatible CompactPCITM backplane and system bus.
- Rugged all-aluminum housing.
- □ Choice of standard chassis (C07A5) with 3 option cPCI expansion bays, intermediate chassis (C10A7) with 5 option bays or extended model (C12A8) with 6 option bays.
- Option modules include digital I/O (P30A, P31 and P33), Ethernet (E1/E3, P10, P11, P12), and transducer input (P40)
- □ Split-core CT options (3 or 4 for M871, 6 for M872)
- □ Optional detached display, D650 (replaced obsolete display M870D)

1.3 Specifications

Power Supply Input Voltage (Refer to Section 6 on Power supply)

Nominal: 24-250Vdc, 69-240Vac (50/60Hz)

Operating Range: 20-300Vdc, 55-275Vac (45-65Hz)

Burden: 50VA max, 20W max (C07A5)

70VA max, 25W max (C12A8 and C10A7)



(Refer to Section 7 on Signal input modules)

		Input Signals (S10, S11, S12, S1C)
CT Current	Configuration	4 Inputs. 3 Phase Currents and 1 Neutral.
Inputs (S10)	Nominal	5Aac
	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.04VA @ 5A rms, 60Hz (0.0016Ω @ 60Hz).
	Frequency	15-70Hz
CT Current	Configuration	4 Inputs. 3 Phase Currents and 1 Neutral.
Inputs (S11)	Nominal	1Aac/5Aac
	Peak Current	Linear to 20A symmetrical (28A peak) at all rated temperatures.
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.0016VA @ 1A rms, 60Hz (0.0016Ω @ 60Hz)/0.04VA @ 5A rms, 60Hz.
	Frequency	15-70Hz
CT Current	Configuration	4 Inputs. 3 Phase Currents and 1 Neutral.
Inputs (S12)	Nominal	1Aac
	Peak Current	Linear to 4A symmetrical (5.7A peak) at all rated temperatures.
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.0016VA @ 1Arms, 60Hz (0.0016Ω @ 60Hz).
	Frequency	15-70Hz
CT Current	Configuration	3 Inputs, 3 Phase Currents, or 4 Inputs, 3 Phase Currents and 1 Neutral Current
Inputs (S1C) –	Nominal	5Aac
External, Split Core	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	Not applicable
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		Input Signals (S10, S11, S12, S1C)
	Frequency	15-70Hz
VT (PT) AC	Configuration	8 Inputs, Measures 2 Buses, 3 or 4 Wire.
Voltage Inputs	Nominal	120Vac
(S10, S11, S12) Terminals 9 to 16	•	Intended for use on nominal system voltages up to 480V rms phase-to-phase (277V rms phase-to-neutral).
9 10 10	Peak Voltage	Reads to 600V peak (425V rms), input-to-case (ground)
	Impedance	>7.5MΩ, input-to-case (ground)
(cont'd)		2.5kV rms 1min, input-to-case (ground) 2kV rms 1min, input-to-input
	Frequency	15-70Hz
AUX	Configuration	2 Inputs: VAX1 & VAX2
Measurement	Nominal	125Vdc / 120Vac
Voltage Inputs (S10, S11,		Intended for use on nominal AC system voltages up to 480V rms phase-to-phase (277V rms phase-to-neutral), and DC system voltages up to 250Vdc.
S12) Terminals 17 & 18	Peak Voltage	Reads to 600V peak (425V rms), input-to-case (ground)
	Impedance	>7.5MΩ, input-to-case (ground)
		2.5kV rms 1min, input-to-case (ground) 2kV rms 1min, input-to-input
	Frequency	DC-70Hz

Input Signals (S13, S14, S15, S16, S17, S2C)			
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents	
Inputs (S13)	Nominal	5Aac	
	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.	
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.	
	Isolation	2500Vac, minimum.	
	Burden	0.04VA @ 5A rms, 60Hz (0.0016Ω @ 60Hz).	
	Frequency	15-70Hz	

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		Input Signals (S13, S14, S15, S16, S17, S2C)			
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents			
Inputs (S14)	Nominal	1Aac/5Aac			
	Peak Current	Linear to 20A symmetrical (28A peak) at all rated temperatures.			
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.			
	Isolation	2500Vac, minimum.			
	Burden	0.0016VA @ 1A rms, 60Hz (0.0016Ω @ 60Hz)/0.04VA @ 5A rms, 60Hz.			
	Frequency	15-70Hz			
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents			
Inputs (S15)	Nominal	1Aac			
	Peak Current	Linear to 4A symmetrical (5.7A peak) at all rated temperatures.			
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.			
	Isolation	2500Vac, minimum.			
	Burden	0.0016VA @ 1Arms, 60Hz (0.0016Ω @ 60Hz).			
	Frequency	15-70Hz			
CT Current	Configuration	6 Inputs. 3 Phase Currents from 2 Lines with different peak current ranges.			
Inputs (S16)	Nominal	5Aac			
M872 with dual peak ranges 20A/100A	Peak Current	Linear to 20A symmetrical (28A peak)/linear to 100A symmetrical (141A peak) at all rated temperatures.			
20A/100A	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.			
	Isolation	2500Vac, minimum.			
	Burden	0.04VA @ 5A rms, 60Hz (0.0016ohms @ 60Hz).			
	Frequency	15-70Hz			
CT Current	Configuration	6 Inputs. 3 Phase Currents from 2 Lines with different peak current ranges.			
Inputs (S17) M872 with dual peak ranges 4A/20A	Nominal	1Aac			
	Peak Current	Linear to 4A symmetrical (5.7A peak)/linear to 20A symmetrical (28A peak at all rated temperatures.			
4/1/20/1	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.			
	Isolation	2500Vac, minimum.			



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		Input Signals (S13, S14, S15, S16, S17, S2C)	
	Burden	0.0016VA @ 1Arms, 60Hz (0.0016ohms @ 60Hz).	
	Configuration	6 Inputs. 3 Phase Currents from 2 Lines with different peak current ranges.	
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents	
Inputs (S2C);	Nominal	5Aac	
External, Split Core	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.	
Corc	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.	
	Isolation	2500Vac, minimum.	
	Burden	Not applicable	
	Frequency	15-70Hz	
VT (PT) AC	Configuration	8 Inputs, Measures 2 Buses, 3 or 4 Wire.	
Voltage Inputs (S13, S14, S15, S16, S17) Terminals 9 to 16	Nominal	120Vac	
	System Voltage	Intended for use on nominal system voltages up to 480V rms phase-to-phase (277V rms phase-to-neutral).	
	Peak Voltage	Reads to 600V peak (425V rms), input-to-case (ground)	
	Impedance	>7.5MΩ, input-to-case (ground)	
	Voltage Withstand	2.5kV rms 1min, input-to-case (ground) 2kV rms 1min, input-to-input	
	Frequency	15-70Hz	

Sampling System			
Sample Rate	128 samples per cycle		
Data Update Rate	Amps, Volts Available every ¼ cycle		
	Watts, VAs, VARs, PF	Available every cycle	
Number of Bits	16		

Accuracy

Accuracies are specified at nominal Frequency and 25C, unless otherwise specified. Temperature Coefficient <25ppm. All values are true RMS and include Harmonics to the 63rd (minimum)

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Voltage	AC: Better than 0.1% of reading (20 to 425V rms, input-to-case). DC (AUX Inputs): +/- 0.2V (24 to 250Vdc, input-to-case)
Current (S10, S13,	Better than 0.1% of reading +/- 500μA (0.5A to 100.0A),
S16 bus 2)	Better than 0.1% of reading +/- 1mA (0.05A to 0.5A).
Current (S11, S14,	Better than 0.1% of reading +/- 100μA (0.5A to 20.0A),
S16 bus 1, S17 bus 2)	Better than 0.1% of reading +/- 250μA (0.05A to 0.5A).
Current (S12, S15,	Better than 0.1% of reading +/- 20µA (0.1A to 4.0A),
S17 bus 1)	Better than 0.1% of reading +/- 50µA (0.01A to 0.1A).
Current (S1C, S2C)	Better than 0.1% of reading +/- 2mA (0.05A to 100.0A, -10C to 70C)
External Split-Core CTs	
Frequency	+/- 0.001 Hertz (accuracy is specified at nominal Frequencies and over operating temperature range)
Phase Angle	+/- 0.2 Deg
Power	Better than 0.2% of reading (>20% of nominal inputs, 1PF to 0.7PF);
Power S1C, S2C	For S1C and S2C split core versions, better than 0.2% of reading +/- 250mVA (>20% of nominal inputs, 1PF to 0.7PF)

Environmental Environmental			
Operating Temperature	-40C to 70C		
Relative Humidity	Humidity 0-95% non-condensing		
Installation Category	IC III (Distribution Level) Refer to definitions below.		
Pollution Degree	ollution Degree Pollution Degree 2 Refer to definitions below.		
Enclosure Protection	IP20 to IEC60529:1989		
Altitude	Up to and including 2000m above sea level		
	Indoor use; Indoor/Outdoor use when mounted in an appropriately rated protective enclosure to NEMA or IP protection classifications, as required for the installation.		



		Physical
Connections (Signal Input Modules)	Current (S10, S11, S12)	Terminal block with 10-32 Studs for current inputs. Use ring lugs sized for #10 stud. Accepts #10-16 AWG (5.3-1.3mm²) wire. Recommended Torque: 16 In-Lbs, 1.81 N-m. Current inputs are connected to the output from the secondary of permanently installed Current Transformers (CTs). Grounding of CT signals per ANSI/IEEE C57.13.3-1983 is required.
		Terminal block with 8-32 Screws for current inputs. Use ring lugs sized for #10 screw thread. Accepts #10-22 AWG (5.3-0.33mm²) wire. Recommended Torque: 16 In-Lbs, 1.81 N-m. Current inputs are connected to the output from the secondary of permanently installed Current Transformers (CTs). Grounding of CT signals per ANSI/IEEE C57.13.3-1983 is required.
	External Split- Core CTs (S1C, S2C)	2 position removable terminal block, accepts 26-14AWG stranded wire. Recommended Torque 7 in-lbs, 0.79N-m.
	Overcurrent protection for Voltage (measurement) input (VT) connections	To maintain the safety features of this product, a 3 Ampere time delay (T) fuse must be connected in series with the ungrounded/non-earthed (hot) side of the supply input connected to the voltage measurement (VT) input of the instrument prior to installation. The fuse must carry a voltage rating appropriate for the power system on which it is to be used. A 3 Ampere slow blow UL Listed fuse in an appropriate fuse holder should be used in order to maintain any UL product approval.
	Voltage (CE units)	Removable Terminal Block, accepts #22-12 AWG (0.35 to 3.3mm²) wire, or terminal lugs up to 0.250" (6.35mm) wide. Standard 0.200" (5.08mm) header socket accepts other standard terminal types. Precautions must be taken to prevent shorting of lugs at the terminal block. A minimum distance of 1/8" (3mm) is recommended between uninsulated lugs to maintain insulation requirements. Recommended Torque: 10 In-Lbs, 1.13 N-m
	Voltage (non-CE)	Removable Terminal Block, accepts #22-12 AWG (0.35 to 3.3mm²) wire, or terminal lugs up to 0.325" (8.25mm) wide. Standard 0.200" (5.08mm) header socket accepts other standard terminal types. Precautions must be taken to prevent shorting of lugs at the terminal block. A minimum distance of 1/8" (3mm) is recommended between uninsulated lugs to maintain insulation requirements. Recommended Torque: 10 In-Lbs, 1.13 N-m Class I equipment to IEC61140: 1997



-P40 Transducer Input Module			
Inputs	8 bi-directional, jumper selectable for voltage or current range.		
0 – 10V Voltage Range	Overload Range:		-12.5 V to +12.5 Vdc
	Resolution:		0.381 mV
	Input Resistance:		10ΚΩ
0 – 1mA Current Range	Overload Range:		-2.5 mA to +2.5 mA
	Resolution:		0.0763 μA
	Input Resistance:		500Ω
4 – 20mA Current Range	Overload Range:		0 mA to +25 mA
	Resolution:		0.381 μΑ
	Input Resistance:		50Ω
Common Mode Input Range	+/- 9V, Input to Ch	nassis	
Common Mode Error	Vcm DC	0.3% of FS @ 9Vp Common Mode	
	Vcm 50/60Hz AC	0.1% of FS @ 9Vp Common Mode	
Accuracy	0.25% of Full Sca	le Input	
Protection	•		szorb clamp and 90V spark gap protection.
Data Update Rate (Poll Rate)	100ms minimum ((single P40 mod	dule); 500ms minimum (multiple P40 modules)
Input / Output Capacitance, any Terminal to Case	470pF		
Power Supply Requirements	3.3Vdc, 5Vdc, +/-12Vdc (supplied		d from backplane)
Hot Swap	Complies with Hot Swap specification PICMG 2.1 R1.0 for Basic Hot Swap (requires Host Processor re-boot)		
Connections	Removable Terminal Blocks, accepts #16-28AWG (1,4-0,09mm) wire. Recommended Torque Rating is 2.2 In-Lbs, 0.25 N-m. Standard 0.150" (3,81mm) header socket accepts other standard terminal types. Solid core wire is recommended, or stranded wire with the use of "bootlace ferrules," where these are available.		
Package	CompactPCI™ (3U, 4HP) removable module		

(Refer to Section 10 on -P40 Tranducer input Module)



Definitions:

Installation Category (Overvoltage Category) III: Distribution Level, fixed installation, with smaller transient overvoltages than those at the primary supply level, overhead lines, cable systems, etc.

Pollution: Any degree of foreign matter, solid, liquid, or gaseous that can result in a reduction of electric strength or surface resistivity of the insulation.

Pollution Degree 2: Only non-conductive pollution occurs except that occasionally a temporary conductivity caused by condensation is to be expected.

1.4 Standards and Certifications



1.4.1 Revenue Accuracy

The M87x exceeds the accuracy requirements of ANSI C12.20 and IEC 60687. The accuracy class of the instrument to each standard is determined by the selected Signal Input Module.

Module	Nominal Current	Certification
S10, S13, S1C, S16 bus 2	5A	ANSI C12.20, 0.5CA IEC 62053-22, 0,5S
0.0000		IEC 62053-23, 3S (Reactive)
		(IEC 62053 superseded IEC 60687)
S11, S14, S16	5A	ANSI C12.20, 0.2CA
bus 1, S17 bus 2		IEC 62053-22, 0,2S
		IEC 62053-23, 2S (Reactive)
		(IEC 62053 superseded IEC 60687)
	1A	ANSI C12.20 0.5CA
		IEC 62053-22, 0,5S
		IEC 62053-23, 3S (Reactive)
		(IEC 62053 superseded IEC 60687)
S12, S15, S17	1A	ANSI C12.20, 0.2CA
bus 1		IEC 62053-22, 0,2S
		IEC 62053-23, 2S (Reactive)
		(IEC 62053 superseded IEC 60687)

The M87x was tested for compliance with the accuracy portions of the standards only. The form factor of the M87x differs from the physical construction of revenue meters specified by the ANSI/IEC standards and no attempt has been made to comply with the standards in whole. Contact customer service for more information.

1.4.2 Environment

UL/CSA Recognized, File Number E164178 (does not apply for S1C and S2C options or for units with the P33 digital output option):

UL 61010-1, Edition 3, Issue Date 2012/05/11,

SAFÉTY REQUIREMENTS FOR ELECTRICAL EQUIPMENT FOR MEASUREMENT, CONTROL, AND LABORATORY USE - PART 1: GENERAL REQUIREMENTS.

UL 61010-2-030, Edition 1 - Issue Date 2012/05/11,

SAFETY REQUIREMENTS FOR ELECTRICAL EQUIPMENT FOR MEASUREMENT, CONTROL, AND LABORATORY USE - PART 2-030: PARTICULAR REQUIREMENTS FOR TESTING AND MEASURING CIRCUITS.

CSA C22.2 NO. 61010-1-12-CAN/CSA, Edition 3, Issue Date 2012/05/01, CAN/CSA SAFETY REQUIREMENTS FOR ELECTRICAL EQUIPMENT FOR MEASUREMENT, CONTROL, AND LABORATORY USE - PART 1: GENERAL REQUIREMENTS.



CSA C22.2 NO. 61010-2-030-12-CAN/CSA, Edition 1, Issue Date 2012/05/01, SAFETY REQUIREMENTS FOR ELECTRICAL EQUIPMENT FOR MEASUREMENT, CONTROL, AND LABORATORY USE - PART 2-030: PARTICULAR REQUIREMENTS FOR TESTING AND MEASURING CIRCUITS.

If applicable, the CE mark must be prominently marked on the case label.

- Units manufactured with the following options are not CE marked:
 S1C and S2C options, P33 digital output option.
- Ethernet modules P10, P11, P12 and Host module H11 are not RoHS compliant. These modules are no longer offered in newly manufactured CE marked units but may be available for purposes of repair and replacement.



European Community Directive on EMC (EMCD) 2014/30/EU, superseding Directive 2004/108/EC (which replaced former directive 89/336/EEC amended by 92/31/EEC, 93/68/EEC, 98/13/EC) and Directive 91/263/EC [TTE/SES]). European Community Directive on Low Voltage (LVD) 2014/35/EU, superseding 2006/95/EC, (which replaced former Directive 73/23/EEC). European Community Directive on the restriction of the use of hazardous

substances in electrical and electronic equipment (RoHS "recast"), 2011/65/EU.

The object of the declaration described above is in conformity with the relevant Union harmonisation legislation: **2014/30/EU** - EMCD Directive (from April 20th, 2016), superceding 2004/108/EC (withdrawn April 19th, 2016), **2014/35/EU** - LVD Directive (from April 20th, 2016), superceding 2006/95/EC (withdrawn April 19th, 2016), **2011/65/EU** - RoHS ("recast") Directive of the European Parliament and of the Council of 8 June 2011.

Product and Generic Standards

The following product and generic standards were used to establish conformity:

Low Voltage (Product Safety):

IEC/EN 61010-1, Edition 3, Issue Date 2010

Safety Requirements for Electrical Equipment for Measurement, Control, and Laboratory Use – Part 1: General Requirements

IEC/EN 61010-2-30, Edition 1 – Issue Date 2010

Safety Requirements for Electrical Equipment for Measurement, Control, and Laboratory Use – Part 2-030: Particular Requirements for Testing and Measuring Circuits

EMC:

EN 61326-1: 2013 (supersedes EN 61326-1: 2006),

IEC/EN 60255-26: 2013 + AC: 2013 (product standard used in part – reliance on basic EMC standards) (supercedes IEC 60255-25: 2000 and IEC 60255-26: 2008, which superceded EN 60255-26: 2006, which superceded EN50263: 2000) EN 61000-6-2: 2005 + AC: 2005 (supercedes EN 61000-6-2: 2005, which superceded EN 50082-2: 1995), EN 61000-6-4: 2007 + A1: 2011 (IEC date 2010), (which superceded EN 50081-2: 1993).

Radiated Emissions Electric Field Strength

Basic EMC emissions standard (radiated emissions):

EN 55011: 2016, EN 55011: 2009 + A1: 2010, (which superceded EN 55011: 2007 + A2: 2007, which superceded EN 55011: 1998 + A1:1998 + A2:2002)

Group 1, Class A

Frequency: 30 - 1000 MHz



EN 55011 is applicable for the following EMC product and generic standards: IEC/EN 60255-26: 2013 + AC: 2013 (supercedes IEC/EN 60255-25: 2000,

EN 61000-6-4: 2007 + A1:2011 (IEC date 2010)

AC Powerline Conducted Emissions

(Applicable on VT inputs - Bus1/ Bus 2 and AUX PWR (Universal Hi Range AC/DC Power supply)

Basic EMC emissions standard (AC powerline conducted emissions):

EN 55011: 2016, EN 55011: 2009 + A1: 2010, (which superceded EN 55011: 2007 +

A2:2007, which superceded EN 55011: 1998 + A1: 1998 + A2: 2002)

Group 1, Class A

Frequency: 150 kHz – 30 MHz

EN 55011 is applicable for the following EMC product and generic standards: IEC/EN 60255-26: 2013 + AC: 2013 (supercedes IEC/EN 60255-25: 2000,

EN 61000-6-4: 2007 + A1:2011 (IEC date 2010),

Conducted Emissions, Telecommunication ports (Ethernet port)

EN 55032: 2015 + AC: 2016-07, EN 55032: 2012 + AC: 2013, EN 55022: 2010 + AC: 2011,

Group 1, Class A

Frequency: 150 kHz - 30 MHz

1 MHz Burst Disturbance Test

IEC60255-22-1: 1988

Class III

Amplitude: 2.5 kV

Electrostatic Discharge (ESD)

EN61000-4-2: 2009 (supersedes EN 61000-4-2: 1995 / A1:1998 / A2: 2001)

Discharge voltage: ± 8 KV Air; ± 4 KV Contact (Additionally meets ± 6kv Contact)

Immunity to Radiated Electromagnetic Energy (Radio-Frequency)

EN61000-4-3: 2006 + A1:2008 + A2:2010, Class III (supersedes EN61000-4-3: 2002 + A1:2002, which superceded IEC 61000-4.3: 1995; and ENV 50204: 1996, on Immunity to Radiated Electromagnetic Energy -Digital Radio Telephones 900 MHz & 1890 MHz).

Frequency: 80 – 1000 MHz Amplitude: 10.0 V/m Modulation: 80% AM @ 1kHz Frequency: 1400-2000 MHz Amplitude: 3.0 V/m Modulation: 80% AM @ 1kHz Frequency: 2000-2700 MHz Amplitude: 1.0 V/m Modulation: 80% AM @ 1kHz

Digital Radio Telephones

Frequency: 900 MHz/1890 MHz Amplitude: 10.0/3.0 V/m Modulation: 80% AM @ 1kHz



Electrical Fast Transient / Burst Immunity

EN 61000-4-4: 2012 (supersedes EN 61000-4-4: 2004 + A1:2010, which superceded

IEC61000-4-4: 1995) Burst Frequency: 5 kHz

Amplitude, Input AC Power Ports: Severity Level 4; Amplitude ± 4 kV

Amplitude, Signal Ports: Severity Level 3; Amplitude ± 2 kV

Amplitude, Telecom Ports (Ethernet): ± 1 kV

Current/Voltage Surge Immunity

EN 61000-4-5: 2014 (supersedes EN 61000-4-5: 2006, which superceded EN610000-4-5:

1995 + A1:2001 and IEC 61000-4-5 : 1995)

Installation Class: 3

Open Circuit Voltage: 1.2 / 50 μs Short Circuit Current: 8 /20 μs

Amplitude: 2 kV common mode, 1 kV differential mode

Immunity to Conducted Disturbances Induced by Radio Frequency Fields

EN 61000-4-6: 2014 (supercedes EN 61000-4-6: 2009, which superceded EN 61000-4-6:

2007, which superseded EN 61000-4-6: 1996 + A1:2001 and IEC61000-4-6: 1996)

Level: 3

Frequency: 150 kHz – 80 MHz

Amplitude: 10 V_{RMS}

Modulation: 80% AM @ 1kHz

Power Frequency Magnetic Fields

EN61000-4-8:2010 Amplitude: 30 A/m

Frequency: 50 and 60 Hz

AC Supply Voltage Dips and Short Interruptions

EN 61000-4-11: 2004 (supersedes IEC61000-4-11: 1994)

Duration: 10ms on auxiliary power supply, under normal operating conditions, without de-

energizing.

Surge Withstand Capability Test For Protective Relays and Relay Systems

ANSI/IEEE C37.90.1: 1989 (2.5 kV oscillatory wave)

Vibration

IEC60255-21-1: 1988 Endurance Class: 1

Shock and Bump

IEC60255-21-2: 1988 Bump Class: 1

RoHS "recast" (ROHS2:) Restriction of the use of certain hazardous substances in electrical and electronic equipment(*)

EN 50581: 2012 Technical documentation for the assessment of electrical and electronic products with respect to the restriction of hazardous substances.

The objects declared as RoHS compliant have a maximum concentration of 0.1% by weight in homogeneous materials for lead, hexavalent chromium, mercury, polybrominated



biphenyls (PBB), polybrominated diphenyl ethers (PBDE), and 0.01% for cadmium, or qualify for an exemption to the limits as defined in Annex III or Annex IV of the RoHS Directive. Bitronics LLC certifies that the object(s) of declaration meet(s) the material requirements of the RoHS Directive 2011/65/EU, except where an exemption is allowed by the Directive. ROHS compliant means that the substances restricted by the RoHS Directive and the subsequent amendments of the European Parliament are not contained in the finished product above the Maximum Concentration Limits, as stated below (in the table), unless the restrictive substance is subject to an exemption contained in Annex III or Annex IV of the RoHS Directive and subsequent amendments.

RoHS part compliance information has been determined based upon reasonable inquiries of our suppliers and represents our current actual knowledge based on the information provided.

Restricted Substance for EU RoHS	Maximum Concentration Limit	
	(Allowable limit at homogeneous material level*)	
Lead (Pb)	0.1% by weight (1000 ppm)	
Mercury (Hg)	0.1% by weight (1000 ppm)	
Cadmium (Cd)	0.01% by weight (100 ppm)	
Hexavalent chromium (Cr)	0.1% by weight (1000 ppm)	
Polybrominated biphenyls (PBB)	0.1% by weight (1000 ppm)	
Polybrominated diphenyl ethers (PBDE)	0.1% by weight (1000 ppm)	
Bis(2-ethylhexyl) phthalate (DEHP)	0.1% by weight (1000 ppm), effective from 22 July 2021	
Butyl benzyl phthalate (BBP)	0.1% by weight (1000 ppm), effective from 22 July 2021	
Dibutyl phthalate (DBP)	0.1% by weight (1000 ppm), effective from 22 July 2021	
Diisobutyl phthalate (DIBP)	0.1% by weight (1000 ppm), effective from 22 July 2021	

 ^{&#}x27;homogeneous material' means one material of uniform composition throughout or a material, consisting of a
combination of materials, that cannot be disjointed or separated into different materials by mechanical actions
such as unscrewing, cutting, crushing, grinding and abrasive processes;

RoHS Exemptions:

Parts that exceed the maximum concentration limits at the homogeneous material level rely exclusively on the following exemption(s):

- **1. Exemptions allowed in Annex III**, entitled Applications exempted from the restrictions in Article 4(1):
 - 6(c): Copper alloy containing up to 4% lead by weight.
- 7(a): Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead).
- 7(c)-1: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.
- **2. Exemptions allowed in Annex IV**, entitled Applications exempted from the restriction in Article 4(1) specific to medical devices and monitoring and control instruments, as amended by Directive 2014/74/EU:
- 36. Lead used in other than C-press compliant pin connector systems for industrial monitoring and control instruments. Expires on 31 December 2020. May be used after that date in spare parts for industrial monitoring and control instruments placed on the market before 1 January 2021.









The M87x chassis is a modular-by-board design, with a rugged aluminum housing specifically designed to meet the harsh conditions found in utility and industrial applications. The chassis features a passive backplane, an embedded and fully compatible CompactPCITM (cPCI) bus section and proprietary signal input and analog (DSP) processor sections. All active circuitry is located on removable modules. There are four types of modules: Power Supply, Signal Input, the Host/Analog-Digital Signal Processor, and cPCI expansion modules. See Figure 1 (below) for the locations of the module bays in the standard chassis.

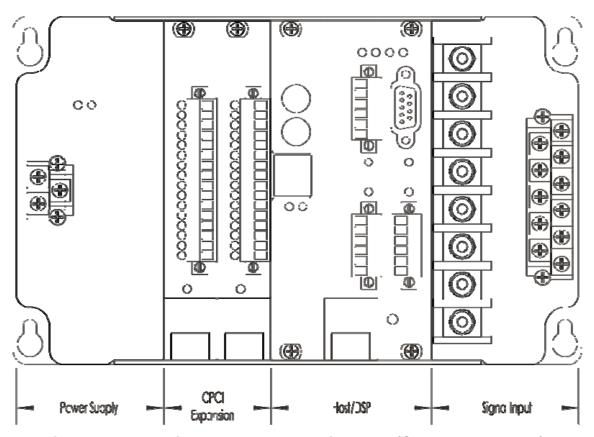
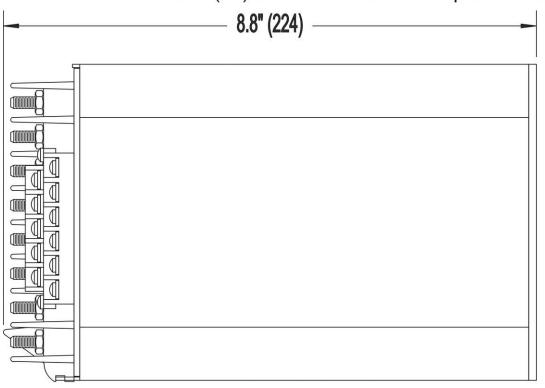


Figure 1 - Front View and Module Assignment (C07A5, M871 Only)

The power supply bay utilizes a standard cPCI power connector. The signal input bay uses a self-aligning 24-pin header. The Analog-Digital Signal Processor board interfaces to the PCI Bus with a standard cPCI connector, and uses a 24-pin header to connect to the analog signals from the Signal Input Board. The Host Processor and the cPCI expansion bays have standard cPCI connectors. The expansion bays are fully compatible, both electrically and mechanically with cPCI standards. The Backplane board is an eight-layer circuit board, and contains a 5V, 33MHz cPCI bus. The standard bay assignment for the standard chassis (C07A5) used for the M871 is shown above. The M871 and M872 are also available in an intermediate chassis (C10A7) that adds two additional cPCI expansion bays, and an extended chassis, (C12A8) that adds three additional cPCI expansion bays. The H12 host processor with either of the combined Ethernet options (E1 or E3) uses a wider front plate incorporating the first of the expansion slots to the left of the host/analog/Ethernet module.



Maintain 1-3/4" (44) minimum clearance top and bottom



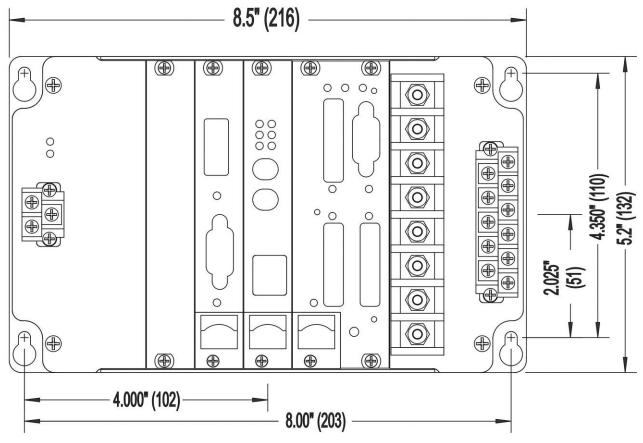


Figure 2 - Mounting and Overall Dimensions (C07A5)



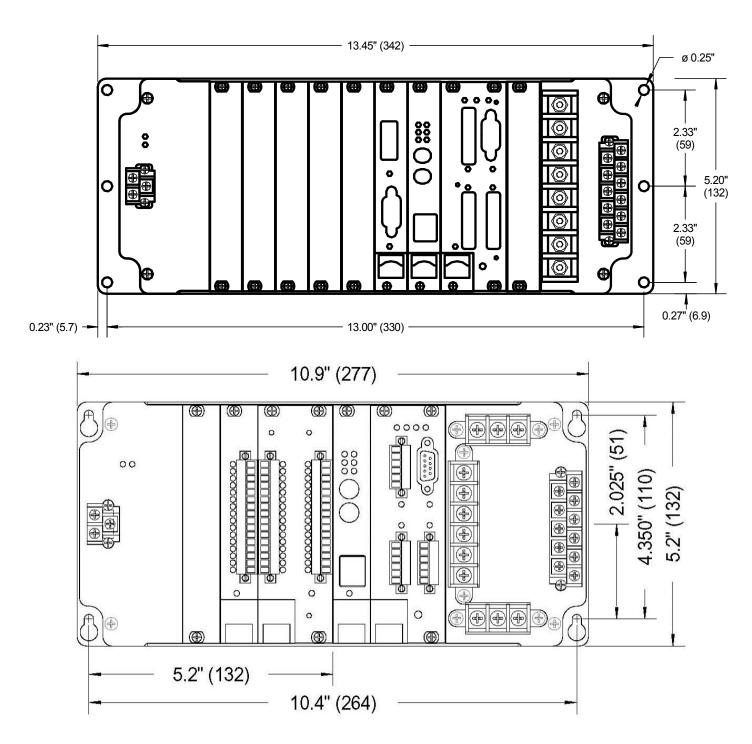


Figure 3 - Mounting and Overall Dimensions (C12A8 and C10A7)





2.1 Installation

WARNING - INSTALLATION AND MAINTENANCE SHOULD ONLY BE PERFORMED BY PROPERLY TRAINED OR QUALIFIED PERSONNEL.

2.2 Initial Inspection

Bitronics instruments are carefully checked and "burned in" at the factory before shipment. Damage can occur however, so please check the instrument for shipping damage as it is unpacked. Notify Bitronics LLC immediately if any damage has occurred, and save any damaged shipping containers.

2.3 Protective Ground/Earth Connections

There are two chassis ground points that MUST be connected to Earth Ground (refer to Figure 8, pg. 78). The first is the Protective Ground (Earth) terminal (terminal 2) on the Power Supply input. The minimum Protective Ground (Earth) wire size is 2.5 mm² (#12 AWG). The second is the mounting flange. Bitronics LLC recommends that all grounding be performed in accordance with ANSI/IEEE C57.13.3-1983.



2.4 Instrument Mounting

The unit should be mounted with four #10-32 (M4) screws. *Make sure that any paint or other coatings on the panel do not prevent electrical contact.* The device is intended to be connected to earth ground at the mounting plate. See Section 2.3.



2.5 Surge Protection

Surge protection devices are incorporated into the power supply. See Section 2.3 for grounding/earthed recommendations. If the unit is to be powered from a VT, it is recommended that one side of the VT be grounded at the instrument following ANSI/IEEE C57.13.3-1983. See Section 6.5 for fuse recommendations.

2.6 Cleaning

Cleaning the exterior of the instrument shall be limited to the wiping of the instrument using a soft damp cloth applicator with cleaning agents that are not alcohol based, and are nonflammable and non-explosive.

2.7 Removal and Installation of Modules





All active circuitry is located on removable modules. Hot Swap modules may be installed and removed under power. Refer to the appropriate section or manual to determine if the particular module is Hot Swap compatible. For all other modules, remove all power from the unit before installing or removing any module.



All Hazardous Voltages MUST be removed from the M87x before removing or installing the Power Supply Module or the Signal Input Module. The Signal Input Module and the Power Supply may be withdrawn from the housing after removal of the front panel screws.



All connections to a module must be removed before removing the module. Do not attempt to install a module with signals connected. To remove a cPCI module, use the following procedure:

- 1. Remove power from the unit (except Hot Swap modules).
- 2. Unscrew the M2.5 Phillips front panel screws (note that these are captive screws). The screw in the handle has been left out intentionally.
- 3. Pull the red sliding release tab up and outward until handle is unlocked.
- 4. Push the handle downward (when viewed from the front) to lever out the module.
- 5. Once the module is disengaged from the backplane connector, carefully withdraw the module.
- 6. Be extremely careful when handling the module, especially the backplane connector.

To insert a cPCI module, use the following procedure:

- 1. Make sure the red sliding release tab is fully extended from the handle, and that the handle is in the downward position (when viewed from the front).
- Line up the module with the card guides in the appropriate position (the Host/Analog-Digital Signal Processor Module MUST be inserted in the right most double width bay).
- 3. Use the handle to lever the module into the housing.
- 4. When the module is fully engaged, tighten the M2.5 Phillips front panel screws. The screw in the handle has been left out intentionally.



3.0 HOST / ANALOG-DIGITAL SIGNAL PROCESSOR MODULE H11/H12 AND A10

The Host/Analog-Digital Signal Processor Module is an assembly consisting of two sections: the Host board and the Analog-Digital Signal Processor board.

3.1 Host board

The Host CPU module consists of a 486-class microprocessor, four communications ports and a CompactPCITM master bridge. The H11 host module offers non-volatile memory expansion via an optional Compact Flash card. The H12 host module utilizes a Compact Flash card, available in optional sizes, and offers optional Ethernet interfaces (E1 and E3).

3.1.1 Serial Port/Front Panel Board

The Serial Port/Front Panel Board consists of the four serial driver connectors, four status LED's, four bi-color serial port LED's, and a reset button. Port P1 is a PC-AT style 9-pin D connector for the dedicated RS-232 port, and ports P2, P3, and P4 are universal 150-mil, 6-pin removable connectors for the RS-232/RS-485 serial ports. P2, P3, and P4 are software (user) configurable for RS-232 or RS-485 mode. The RS-232 drivers support full and half duplex modes. See Figures 3-6 (pg. 22 -26) for signal assignments.

3.1.1a Service Port (P1)

When connecting to the Service port DB9M (P1) from a PC, a null modem cable is required. The Service Port can be used with a PC running a terminal emulation program. Upon startup, the M87x default configuration sets P1 for 9600 baud, 8 data bits, no parity, 1 stop bit and no flow control handshaking. These parameters are user-configurable. A small number of messages are sent to P1 and the M87x then outputs system messages. Enter the command mode by pressing the ENTER key until the system outputs a prompting message. Allowable commands are:

Service Port\Zmodem Commands			
c:	dir	receive	time
cd	exit	reset	type
chp1	getlog	router	trigger dr1
chp2	Goose*	send	trigger dr2
d:	ip	serial	trigger wv1
date	mac	setlog	trigger wv2
del	nsap	subnet	ver
dio point	password	software	whoami
display on	pulse	receive	vio point
display off	reboot	status	

Note: * This command is for UCA Goose only and is now referred to as GSSE.

Type "help <command>" to find out more about a particular command. The more commonly used commands are:



ip - Set Internet Protocol (IP) address information in "dotted decimal" format. The IP address defaults to "192.168.0.254".

subnet - Set the Subnet mask. The Subnet mask defaults to "255.255.255.0".

router - Set the Gateway (Router) address. The Gateway (Router) address defaults to "192.168.0.1".

nsap - Set the OSI network address (NSAP) in "space delimited octet string" format. The default address is "49 00 01 42 49 09 01 01" which is a local address not attached to the global OSI network.

The correct value for your network should be obtained from the network administrator. The default values are valid for a device that is attached to a local intranet with optional access via a router (such as a device within a substation).

time - Set the time as 24-hour UTC time. Time is entered as HH:MM:SS. The factory default is set to GMT.

date – Set the date. Date is entered as MM/DD/YYYY.

serial - Display M87x serial number

exit - Exit command line mode and return to logging mode. If no commands are received for five minutes the device will revert to logging mode.

3.1.1b Standard Serial Ports (P2, P3, P4)

These ports can be set to RS-232 or RS-485, and support baud rates up to 115200. Setup of the Serial Ports can be accomplished by using the 70 Series Configurator. The default configuration for the serial ports is:

	Serial Port Default Settings						
Port Protocol Parity Baud IED Address Physical M							
P1	Zmodem/Display/Log	None	9600		RS-232		
P2	DNP 3.0	None	9600	1	RS-232		
P3	Modbus	Even	9600	1	RS-232		
P4	Zmodem/Display/Log	None	9600		RS-232		

The configuration of these ports is stored internally in the "COMM.INI" file (Section 5.2). If, for any reason, the configuration of the serial ports is erroneously set, the factory default settings can be restored by using FTP. The file "COMM.INI" can be deleted, which will return all ports to the factory default setting. The settings can then be changed by using the 70 Series Configurator.



ML0021

Host cable requirements for CE compliance:

On ports P2, P3, and P4, as well as a port that utilizes the externally mounted M87x Modulated IRIG-B Converter, install snap-on ferrite (Fair-Rite #0461164181 or equivalent) onto each cable by wrapping the cable through the ferrite opening two times before



snapping the ferrite closed. Tie RS-485 cable shields (pin 5) to earth ground at one point in system.

The recommended torque rating for the terminal block wire fasteners on ports P2-P4 is 2.2 In-Lbs, 0.25 N-m.

3.1.1c Diagnostic Status LED's (S1, S2, S3, S4)

There are four LED's on the front panel: S1, S2, S3, and S4. They perform the following functions:

LED	Description
S1	On while flash memory is being written to, otherwise off.
S2	Flashes every 5 power-line cycles, indicates DSP operating properly.
S3	On while CPU is busy. Intensity indicates CPU utilization level.
S4	On during internal self-diagnostics after boot-up.

3.1.1d RS485 Connections

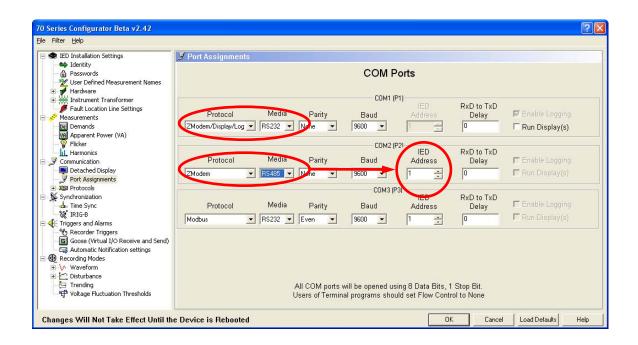
Note that various protocols and services have different port connection requirements. When making connections to serial ports for Modbus or DNP3 over RS485, 2-wire half duplex is required. This is because it is necessary to maintain a minimum time period (3 1/3 characters) from the time the transmitter shuts off to the next message on the bus in order to guarantee reliable communications. However, when using Zmodem or connecting to the remote display, asynchronous 2 way communications are required, and therefore a 4-wire full duplex (technically RS422) connection is needed. See figures 4 and 6 below for RS485 cable wiring and signal assignment diagrams showing both 2 and 4 wire.

There are special considerations for multi-drop Zmodem connections. Zmodem protocol was developed for RS232 point-to-point connections so it does not support any standard convention for addressing. Therefore, it does not facilitate multi-drop communications buses. In order to make it possible to use one modem to establish remote communications with multiple 70 Series devices when the Ethernet option (preferred) is not fitted, the following proprietary convention is employed.

When using HyperTerminal or a dial-up modem with RS485, the port on the IED must be configured for "Zmodem" protocol, *not for "Zmodem/Display/Log"*. This is done with the pull-down menu in the Configurator program, see illustration below. Selecting Zmodem also enables an address to be set for the selected COM port. When daisy-chaining multiple devices on RS485, each device must have a unique address.

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Type the command "connect 01" (use the *actual* address assigned) to establish communications with the device in Zmodem protocol using RS485. *This command will not be echoed back as you type it.* After striking the enter key, the device will return a command prompt (for example c:\>, e:\data>, c:\config>, etc.) Once communications are established, you can now use the command-line interface, exactly as you would with a direct RS232 connection, to control the device (services supported by Zmodem protocol include: download recording files, control digital outputs, reset demands, set time and date, etc.). In order to disconnect from one device and connect to another on the same bus, type the command "exit" to end the session then type "connect 02" (or whatever address you want to connect to).



M87x RS-232 & IRIG-B Cable Connections

RS-232C M87x to PC DB9F

M870 HOST DB9 FEMALE SERIAL PORTS connected to PC P2, P3, P4 **RXD** TXD 2 RXD 2 TXD 3 RTS 3 GND 5 **CTS** 4 DTR 4 SHLD 5 DSR 6 GND 6 DCD 1 **RTS** 7

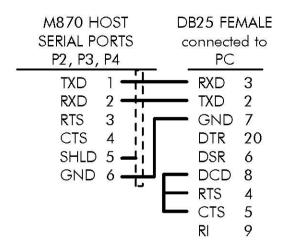
CTS

RI

8

9

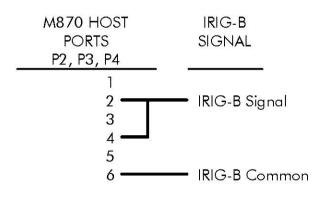
RS-232C M87x to PC DB25F



RS-232C M87x to Modem DB25M

M870 HOST DB25 MALE SERIAL PORTS connected to P2, P3, P4 Modem TXD RXD 3 RXD 2 TXD 2 RTS 3 GND 7 CTS 20 4 DTR SHLD 5 DSR 6 GND 6 DCD 8 RTS 4 5 CTS RI 9

M87x to IRIG-B



The cable should be Belden 9842 or equivalent. The maximum cable length for RS-232 is 50 ft. (15m)

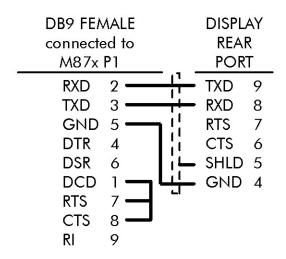
Figure 3 - Typical RS-232 & IRIG-B Cable Wiring

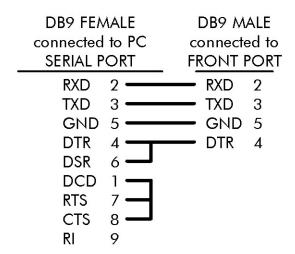
M870Display RS-232 Cable Connections



Display Rear Port to M87x DB9M

Display DB9F Front Port to PC DB9M





Display Rear Port to M87x Ports

Display DB9F Front Port to PC DB25M

<u></u>	M87x HOST SERIAL PORTS P2, P3, P4			DISPL REAF POR	?	
	RXD TXD RTS CTS SHLD GND	2 — 1 — 3 4 5 6 —			TXD RXD RTS CTS SHLD GND	9 8 7 6 5 4

DB25 FEMALE			[DB9 M	ALE
connecte	d to	PC	CC	nnect	ed to
SERIAL	POI	RT	FR	CONT	<u>POR</u> T
RXD	3		_	RXD	2
TXD	2		_	TXD	3
GND	7		_	GND	5
DTR	20	$\overline{}$	_	DTR	4
DSR	6	_			
DCD	8	\neg			
RTS	4	\dashv			
CTS	5	_			
RI	9				

The rear port of the M870D Display and the Host port of the M87x must be set to RS-232, matching Baud rates and parity, and Display protocol.

The cable should be Belden 9842 or equivalent.

The maximum cable length for RS-232 is 50 ft. (15m)

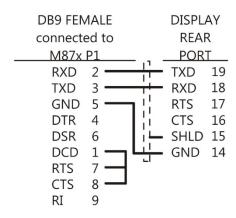
Figure 4 – M870D RS-232 Cable Wiring

Please note that the M870D detached display has been replaced by the D650 display

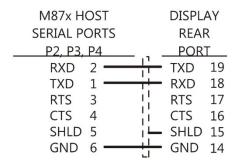


D650 RS-232 Cable Connections to M87x

D650 Rear Port to M87x DB9M



D650 Rear Port to M87x Ports



The rear port of the D650 Display and the Host port of the M87x must be set to RS-232, matching Baud rates and parity, and Display protocol.

The cable should be Belden 9842 or equivalent. The maximum cable length for RS-232 is 50 ft (15m).

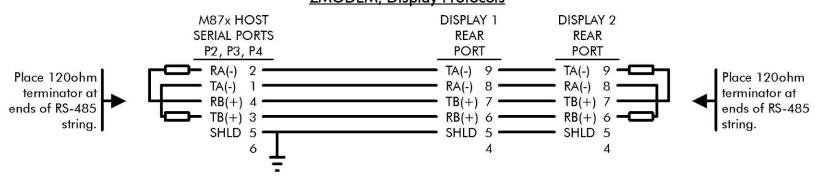
RDSCables-232_D650_M87x_R1.cdr, 1/7/16

Figure 4B - Typical RS-232 Wiring for D650 Display



M87x RS-485 Cable Connections

M87x Ports to M870D Display Rear Port (4-Wire, Full Duplex) ZMODEM, Display Protocols



The rear port of the M870D Display and the Host port of the M87x must be set to RS-485, matching Baud rates and parity, and Display protocol.

The cable should be Belden 9842 or equivalent. The maximum cable length for RS-485 is 4000 ft. (1200m)

M87x Ports to Generic RS485 Device (2-Wire, Half Duplex) Modbus, DNP3 Protocols M87x HOST RS485 RS485 SERIAL PORTS **DEVICE 1 DEVICE 2** P2, P3, P4 **PORT PORT** TA(-) RA(-) TA(-) Place 120ohm Place 120ohm TA(-) **RA(-) RA(-)** terminator at terminator at RB(+) 4 TB(+)TB(+)ends of RS-485 ends of RS-485 RB(+)TB(+) 3 · RB(+)string. string. SHLD SHLD SHLD 5

The rear port of the M870D Display and the Host port of the M87x must be set to RS-485, matching Baud rates and parity, and Display protocol.

The cable should be Belden 9841 or equivalent. The maximum cable length for RS-485 is 4000 ft. (1200m)

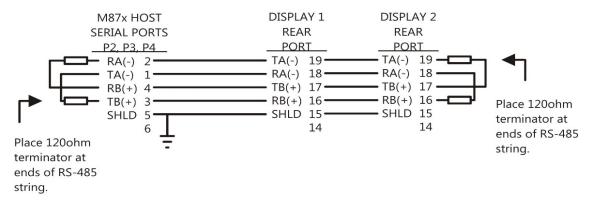
Figure 5 - Typical RS-485 Cable Wiring

Please note that the M870D detached display has been replaced by the D650 display



M87x RS-485 Cable Connections to D650

M87x Ports to D650 Display's Rear Port (4-Wire, Full Duplex) Zmodem, Display Protocols



The rear port of the D650 and the Host port of the M87x must be set to RS-485, matching Baud rates and parity, and Display protocol.

The cable should be Belden 9842 or equivalent. The maximum cable length for RS-485 is 4000 ft (1200m).

RDSCables-485_D650_M87x_R1.cdr, 1/7/16

M87x RS-485 Cable Connections

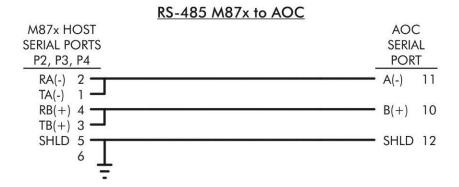


Figure 5B - Typical RS-485 Cable Wiring D650 Display and AOC





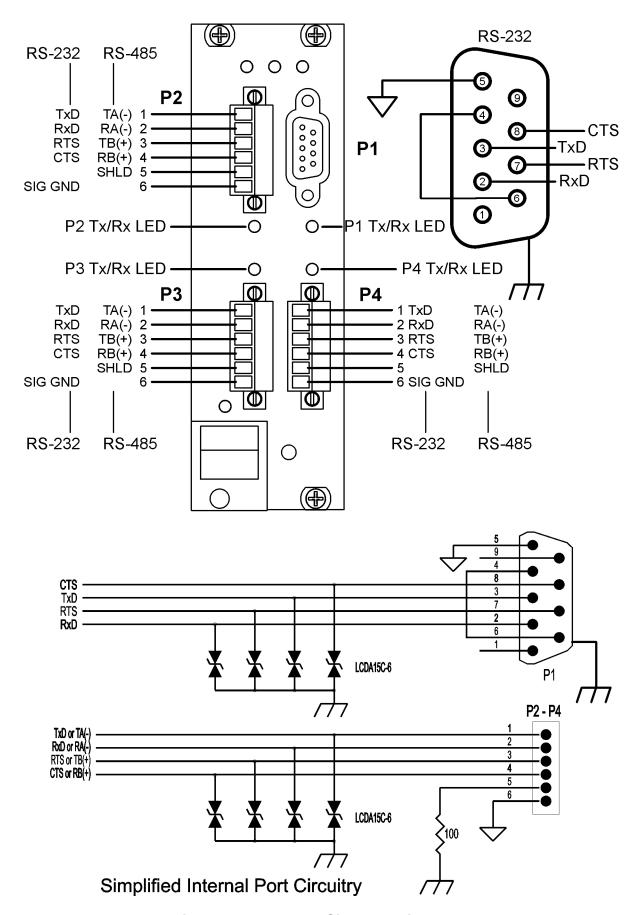


Figure 6 - Host Port Signal Assignment

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3.1.2 Self-Test Modes

The M87x has several self-tests built in to assure that the instrument is performing accurately. Refer to the appropriate protocol manual for details on how to retrieve the self-test information. The following table lists possible faults that would be detected by the self-tests, how the fault is indicated, the effects of the fault and any necessary corrective actions.

	Self-Test Bits						
Bit #	Description	Hardware	Effect	Default Value			
0(LSB)	Factory gain calibration of Analog-Digital Signal Processor Module checksum error.	A10 EEProm	Unit will continue to function using default values, at reduced accuracy.	A/D Gain = 1			
1	Factory offset calibration of Analog-Digital Signal Processor Module checksum error.	A10 EEProm	Unit will continue to function using default values, at reduced accuracy.	A/D Offset = 0			
2	Factory gain calibration of Signal Input Module checksum error.	S1x EEProm	Unit will continue to function using default values, at reduced accuracy.	CT/VT Gain = 1			
3	Factory offset calibration of Signal Input Module checksum error.	S1x EEProm	Unit will continue to function using default values, at reduced accuracy.	CT/VT Offset = 0			
4	Factory phase calibration of Signal Input Module checksum error.	S1x EEProm	Unit will continue to function using default values, at reduced accuracy.	CT/VT Phase = 0			
5	Factory defined internal ratios of Signal Input Module checksum error. (Type of Signal Input Module)	S1x EEProm	Unit will continue to function. Assumes -S10 Signal Input Module	Volts Ratio = 60 :1 Amps Ratio = 14.136 :1			
6	User defined external transformer ratio checksum error.	S1x EEProm	Unit will continue to function using default values (i.e. w/o user ratios).	User CT = 5:5, VT = 1:1			
7	User gain correction values checksum error.	S1x EEProm	Unit will continue to function using default values (i.e. w/o user gain).	User Gain = 1			
8	User phase correction values checksum error.	S1x EEProm	Unit will continue to function using default values (i.e. w/o user phase).	User Phase = 0			
9	Factory defined board ID for Analog-Digital Signal Processor Module checksum error.	A10 EEProm	Assumes default Analog-Digital Signal Processor Module.	Module A10			
10	Factory defined board ID for Signal Input Module checksum error.	S1x EEProm	Assumes default Signal Input Module.	Module -S10			
11	User defined denominators for TDD measurement checksum error.	S1x EEProm	Assumes default TDD Denominator.	TDD Denom = 5A Secondary			
12	DSP program integrity checksum error.	A1x DSP Ram	Host trips watchdog, unit reboots.				
13	DSP stack overflow.	A1x DSP Ram	Host trips watchdog, unit reboots.				
14	Invalid or missing Amp and/or Voltage Scale Factor.	H1x Flash File	Protocol will use default Scale Factor	Scale Factor = 1:1			
15	Protocol configuration invalid.	H1x Flash File	M87x uses default protocol configuration	M87x register set			



3.1.3 System Clock

The M87x has an internal System Clock with a capacitor backed RAM (typical data retention of 7 days at room temperature) when no power is applied to the unit. The clock is located on the Host board. The time settings may be changed via the Serial Port (P1) or various communication protocols. Refer to Section 3.1.1a and the appropriate protocol manuals for details.

3.2 A10 Analog-Digital Signal Processor Board

The Analog/DSP board is part of the modular M87x system. This board contains amplifiers, track and hold circuits, multiplexers, an analog to digital converter, a digital signal processor (DSP), and a PCI bridge. Analog signals from the CT/VT board are routed through the backplane to the Analog/DSP board. Once on the board each signal is connected to the track and hold circuitry. The track and hold circuitry is designed to hold the channel's present value during the time required for the analog to digital converter to sample all of the channels. This effectively allows the M87x to simultaneously sample all of its input channels, eliminating any channel-to-channel skew. A single 16-bit analog to digital converter is used for all measurements. The DSP uses the samples to calculate all of the measured parameters. Each sample is corrected for offset and gain using factory calibration values stored in non-volatile memory on the board. Additionally, a continuous DC removal is performed on all inputs, except the AUX Voltages. An adaptive sampling system is used to maintain 128 samples per cycle over the input frequency range of 15 to 70 Hz. See Section 3.2.2.

3.2.1 Calibration

Routine re-calibration is not recommended or required. A field calibration check every few years is a good assurance of proper operation.

3.2.2 Instantaneous Measurement Principles

The M87x measures all signals at 128 samples/cycle, accommodating fundamental signal frequencies from 15 to 70 Hz. Samples of all bus signals are taken at the same instant in time, using a 16-Bit A/D converter, effectively creating 128 "snapshots" of the system voltage and current per cycle.

3.2.2a Sampling Rate and System Frequency

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The sampling rate is synchronized to the frequency of any of the bus voltage or current inputs, prioritized as follows: $V1_{A-N}$, $V1_{B-N}$, $V1_{C-N}$, $V2_{A-N}$, $V2_{B-N}$, $V2_{C-N}$, IA, IB, IC. This is the frequency reported as the "System Frequency". The AUX voltage inputs and Neutrals are not used to synchronize the sampling. The sampling rate is the same for all channels.

The default system frequency may be set in the Configurator to either 50 or 60 Hz. This will have no effect on the frequency that is reported, or the sample rate when signals are present. It is used to set the default sample rate when the unit cannot detect any applied signal.

4.0 MEASUREMENTS



Basic measurement quantities are calculated and updated every 1/4 cycle. These quantities include RMS Amperes and RMS Volts. Watts, VARs, VAs, Power Factor, all harmonic-based measurements (such as fundamental-only quantities), Energy, Frequency, and Phase Angle are updated every cycle.

Note: For all of the following measurements, it is important to keep in mind that the specific protocol used to access the data may affect the data that is available, or the format of that data. No attempt is made here to describe the method of accessing measurements - always check the appropriate protocol manual for details.

4.1 Current (1/4-Cycle Update)

The current signals are transformer coupled, providing a true differential current signal. Additionally, a continuous DC removal is performed on all current inputs. Instrument transformer ratios can be entered for each current input, as described in the Signal Input Module section (Section 7). This can be accomplished via a network and protocol (refer to the specific protocol manual for details) or by using the 70 Series Configurator.

When used on 2-element systems, if there are only 2 currents available to measure, a "0" can be written to the CT Ratio for the missing phase current. This will cause the M87x to fabricate the missing phase current from the sum of the other 2 phase currents. This feature is not recommended for WYE connected systems.

The average of the 3 current phases ((Ia + Ib + Ic)/3) is also available. The Average 3-phase Amps for bus 1 and bus 2 (M872) are calculated and made available on a per cycle basis.

4.1.1 Neutral and Residual Current (1/4-Cycle Update)

M871 Signal Input Modules have a separate input for neutral current. This channel is measured just like any of the other current channels, and the result presented as Neutral Current. Additionally, all M87x units calculate the vector sum of the three phase currents, which is known as the Residual Current. The Residual Current is equivalent to routing the common current return wire through the neutral current input on systems without separate current returns for each phase, with the exception that individual Harmonics are not measured on Residual Current.

On systems without a Neutral CT, the Residual Current measurement can be used as a substitute for Neutral Current. This allows the Neutral Current input on the M871 to be used to measure any extra currents in the system.

4.2 Voltage Channels (1/4-Cycle Update)

The M87x uses a unique voltage connection method, which is combined with simultaneous sampling to provide an extremely flexible voltage measurement system. All voltage inputs are measured relative to a common reference level (essentially panel ground). See Figure 9 (pg. 89-96) and Section 7 for input connection information. Because all phase signals



are sampled simultaneously (including currents), these signals can be easily combined to form true Phase-to-Phase and Phase-to-Neutral differential measurements with extremely low amplitude and phase errors. It also allows accurate calculation of Bus-to-Bus differential voltages and angles. Each sample is corrected for offset and gain using factory calibration values stored in non-volatile memory on the board. Additionally, a continuous DC removal is performed on all inputs, except the AUX Voltages.

The M87x calculates voltages in PRIMARY units, based on the VT Ratios entered. There are separate VT Ratios for each input. Ratios can be entered via a network and protocol (refer to the specific protocol manual for details) or by running the M87x Configurator.

The advantages of this method of voltage measurement are apparent when the M87x is used on the common 2, 2-1/2, and 3 element systems (refer to Section 4.4). The M87x is always calculating Line-to-Neutral, Line-to-Line, and Bus-to-Bus voltages with equal accuracy. On 2 element connections, any phase can serve as the reference phase. Further, the M87x can accommodate WYE connections on one Bus, and DELTA connections on the other Bus.

On 2-1/2 element systems, one of the phase-to-neutral voltages is missing, and the M87x must create it from the vector sum of the other two phase-to-neutral voltages. In order to configure the M87x for 2-1/2 element mode and which phase voltage is missing, a "0" is written to the phase-to-neutral VT Ratio for the missing phase voltage.

The AUX Voltage input measurements (M871 only) are similar to the phase voltages except they do not have continuous DC removal. Both input-to-ground and input-to-input differential voltages are measured. Because they do not have continuous DC removal, they can be used to measure either AC or DC signals, making these measurements useful for Substation battery monitoring, generator field voltages, local bus voltage measurements, etc.

The average of the 3 voltage phases ((Va + Vb + Vc)/3) is also available. The Average 3-phase Volts for bus 1 and bus 2 are calculated and made available on a per cycle basis.

4.3 Power Factor (1-Cycle Update)

The per-phase Power Factor measurement is calculated using the "Power Triangle," or the per-phase WATTS divided by the per-phase VAs. The Total PF is similar, but uses the Total WATTS and Total VAs instead. The sign convention for Power Factor is shown in Figure 7 (pg. 33). Note that the Total PF calculation depends on the Total VA calculation type chosen (Section 4.4).

4.4 Watts / Volt-Amperes (VAs) / VARs (1-Cycle Update)

On any power connection type (2, 2-1/2, and 3 element), the M87x calculates per-element Watts by multiplying the voltage and current samples of that element together. This represents the dot product of the voltage and current vectors, or the true Watts. The per-element VAs are calculated from the product of the per-element Volts and Amps. The per-element VARs are calculated from fundamental VARs.



In any connection type, the Total Watts and Total VARs is the arithmetic sum of the perelement Watts and VARs. The sign conventions are shown in Figure 7 (pg. 33).

When used on 2-element systems, the reference phase voltage (typically phase B) input, is connected to the Neutral voltage input, and effectively causes one of the elements to be zero. See Figure 9 (pg. 89-96) and Section 7 for input connection information. It is not required to use any particular voltage phase as the reference on 2-element systems. When used on 2-element systems the per-element Watts, VARs, and VAs have no direct physical meaning, as they would on 2-1/2 and 3 element systems where they represent the per-phase Watts, VARs, and VAs.

When used on 2-1/2 element systems, one of the phase-to-neutral voltages is fabricated, as described in Section 4.2. In all other respects, the 2-1/2 element connection is identical to the 3 element connection.

The M87x may be configured to calculate Total VAs in one of several different ways. The calculation method may be selected either by sending a command to the M87x via a network and protocol (refer to the specific protocol manual for details) or by using the 70 Series Configurator. The three methods, Arithmetic, Geometric, and Equivalent (both for WYE and DELTA), all yield the same results when used on balanced systems with no harmonics present. The differences are illustrated below:

4.4.1 Geometric VA Calculations

$$GEOMETRIC\ VA_{TOTAL} = \sqrt{Watts_{TOTAL}^{2} + VARs_{TOTAL}^{2}}$$

This is the traditional definition of Total VAs for WYE or DELTA systems, and is the default method for Total VAs calculation. The value of Total VAs calculated using this method does not change on systems with amplitude imbalance, relative to a balanced system.

There is also a relationship to the Total Power Factor which is described in Section 4.3. Total Power Factor calculations using the Geometric VA method will still indicate a "1" on a system with phase amplitude imbalance, or canceling leading and lagging loads.

For example, on a system with a lagging load on one phase and an equal leading load on another phase, the Geometric VA result will be reduced relative to a balanced system but the Total Power Factor will still be "1".

4.4.2 Arithmetic VA Calculations

$$ARITHMETIC\ VA_{TOTAL} = (V_{A-N} \times I_A) + (V_{B-N} \times I_B) + (V_{C-N} \times I_C)$$

The Arithmetic VA calculation is not applicable to DELTA connected systems. The value of Total VAs calculated using this method also does not change on systems with amplitude imbalance, relative to a balanced system. The value of Arithmetic VAs will not change on a system with canceling leading and lagging loads.



There is also a relationship to the Total Power Factor, which is described in Section 4.3. Total Power Factor calculations using the Arithmetic VA method will still indicate a "1" on a system with phase amplitude imbalance, but not with canceling leading and lagging loads.

For example, on a system with a lagging load on one phase and an equal leading load on another phase, the value of the Arithmetic VAs will not change relative to a balanced system, but the Total Power Factor will be less than "1". The Total Power Factor calculated with Arithmetic VAs will "see" the reactive elements in this system, while the Total Power Factor calculated with Geometric VAs will not.

4.4.3 Equivalent VA Calculations

$$EQUIVALENT \ WYE \ VA_{TOTAL} = \sqrt{V_{A-N}^2 + V_{B-N}^2 + V_{C-N}^2} \times \sqrt{I_A^2 + I_B^2 + I_C^2}$$

$$EQUIVALENT\ DELTA\ VA_{TOTAL} = \frac{\sqrt{V_{A-B}^2 + V_{B-C}^2 + V_{C-A}^2} \times \sqrt{I_A^2 + I_B^2 + I_C^2}}{\sqrt{3}}$$

The Equivalent VA calculation has not been as commonly used as other approaches, but has been discussed extensively in technical papers. It is also referred to as "System Apparent Power". This approach to the VA calculation may yield results which are surprising to those used to more traditional methods. A system with amplitude imbalance will yield a greater value of Equivalent VAs than a balanced system.

There is also a relationship to the Total Power Factor, which is described in Section 4.3. Essentially, Total Power Factor calculations using the Equivalent VA method will not indicate a "1" on any system unless the loads are purely resistive, and the amplitudes are balanced. Further, the Equivalent VA method may yield better results in the presence of harmonics, where Total Power Factor will also be reduced from "1". Refer to industry standards for more information.

4.5 Energy (1-Cycle Update)

Separate values are maintained for both positive and negative Watt-hours, positive and negative VAR-hours, and VA-hours, (for each feeder in the M872). These energy quantities are calculated every cycle from the Total Watts, Total VARs, and Total VAs, and the values are stored into non-volatile memory every 15 seconds.

Energy values may be reset. All values are reset simultaneously. Refer to the appropriate protocol manual for details.



4.6 Frequency (1-Cycle Update)

Frequency is calculated every cycle for every input but the Auxiliary Voltages. The M87x monitors the change in Phase Angle per unit time using the Phase Angle measurement for the fundamental generated by the FFT. The System Frequency is the frequency of the input used for synchronizing the sampling rate (Section 3.2.2).

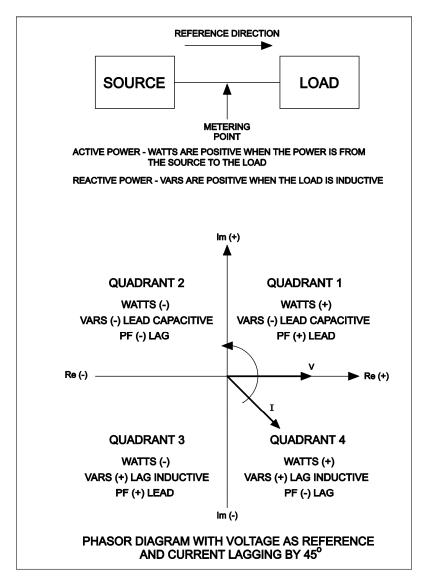


Figure 7 - Sign Conventions for Power Measurements

4.7 Demand Measurements (1-Second Update)

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The traditional thermal demand meter displays a value that represents the logarithmic response of a heating element in the instrument driven by the applied signal. The most positive value since the last instrument reset is known as the maximum demand (or peak demand) and the lowest value since the last instrument reset is known as the minimum demand. Since thermal demand is a heating and cooling phenomenon, the demand value has a response time T, defined as the time for the demand function to change 90% of the difference between the applied signal and the initial demand value. For utility applications,



the traditional value of T is 15 minutes, although the M87x can accommodate other demand intervals (Section 4.7.7).

The M87x generates a demand value using modern microprocessor technology in place of heating and cooling circuits, it is therefore much more accurate and repeatable over a wide range of input values. In operation, the M87x continuously samples the basic measured quantities, and digitally integrates the samples with a time constant T to obtain the demand value. The calculated demand value is continuously checked against the previous maximum and minimum demand values. This process continues indefinitely, until the demand is reset or until the meter is reset (or power removed and reapplied). The demand reset and power-up algorithms are different for each measurement. These routines are further described in following paragraphs. The maximum and minimum demand values are stored in non-volatile memory on the Host Processor module.

NOTE: Changing VT or CT ratios does NOT reset demand measurements to zero.

Demand Quantity	Phase Reference	Function
Amperes (1 & 2)	Phase, Neutral, Residual	Present, Max
Fundamental Amperes	Phase, Neutral, Residual	Present, Max
Volts (Bus 1 & 2)	Phase - Neutral, Phase - Phase	Present, Max, Min
Total Watts (1 & 2)		Present, Max, Min
Total VARs (1 & 2)		Present, Max, Min
Total VAs (1 & 2)		Present, Max, Min
THD Volts (Bus 1 & 2)	Phase - Neutral, Phase - Phase	Present, Max
TDD Amperes (1 & 2)	Phase, Neutral, Residual	Present, Max

4.7.1 Ampere and Fundamental Ampere Demand

Present Ampere Demands are calculated via the instantaneous measurement data used to calculate the per-phase Amperes.

Upon power-up, all Present Ampere Demands are reset to zero. Maximum Ampere Demands are initialized to the maximum values recalled from non-volatile memory. Upon Ampere Demand Reset, all per-phase Present and Maximum Ampere Demands are set to zero. When Ampere Demands are reset, Fundamental Current Demands are also reset.

4.7.2 Volt Demand

Present Volt Demands are calculated via the instantaneous measurement data used to calculate the per-phase Volts. Upon power-up all Present Volt Demands are reset to zero. The Maximum Volt Demands and Minimum Volt Demands are initialized to the minimum and maximum values recalled from non-volatile memory. In order to prevent the recording of false minimums a new Minimum Volt Demand will not be stored unless two criteria are met. First, the instantaneous voltage for that particular phase must be greater than 20V_{rms} (secondary). Second, the Present Demand for that particular phase must have dipped (Present Demand value must be less then previous Present Demand value). Upon Voltage Demand Reset, all per-phase Maximum Voltage Demands are set to zero. Minimum Voltage Demands are set to full-scale.



4.7.3 Power Demands (Total Watts, VARs, and VAs)

Present Total Watt, VAR, and VA Demands are calculated via the instantaneous measurement data. The Total VA Demand calculation type is based on the instantaneous Total VA calculation type (Section 4.4)

Upon power-up, all Present Total Watt, VAR, and VA Demands are reset to the average of the stored Maximum and Minimum values. The Maximum and Minimum Demands are initialized to the minimum and maximum values recalled from non-volatile memory. Upon a demand reset, the Maximum and Minimum Demands are set equal to the Present Total Watt, VAR, and VA Demand values. A demand reset does not change the value of the Present Total Watt, VAR, and VA Demands.

4.7.4 Voltage THD Demand

Present Voltage THD Demands are calculated via the instantaneous measurement data used to calculate the per-phase and phase-to-phase Voltage THDs (Section 4.8.1). Voltage THDs are calculated for both Bus 1 and Bus 2. By applying a thermal demand to the THD measurement, the M87x provides a more effective method of determining the severity of a harmonic problem.

Upon power-up, all Present Voltage THD Demands are reset to zero. Maximum Voltage THD Demands are initialized to the maximum values recalled from non-volatile memory. Upon Harmonic Demand Reset, all per-phase Present and Maximum Voltage THD demands are set to zero.

4.7.5 Current TDD Demand

Present Current TDD Demands are calculated via the instantaneous measurement data. By applying a thermal demand to the TDD measurement, the M87x provides a more effective method of determining the severity of a harmonic problem.

Upon power-up, all Present Current TDD Demands are reset to zero. Maximum Current TDD Demands are initialized to the maximum values recalled from non-volatile memory. Upon Harmonic Demand Reset, all per-phase Present and Maximum Current TDD demands are set to zero.

4.7.6 Demand Resets

The demand values are reset in four groups: current, voltage, power, and harmonics. This can be accomplished via a network and protocol (refer to the specific protocol manual for details).

4.7.7 Demand Interval

The M87x uses 15 minutes as the default demand interval, however it can be changed. Four separate, independent demand intervals may be set for current, voltage, power, and harmonics. The range of demand intervals is 5 to 3600 seconds (1hr). This can be accomplished via a network and protocol (refer to the specific protocol manual for details) or by using the 70 Series Configurator. While the Demand Interval is stored internally as a



32-bit number, some protocols may place further restrictions on the Demand Interval due to limitations on numerical format. Please refer to the appropriate protocol manual for details.

4.8 Harmonic Measurements (1-Cycle Update)

M87x instruments continually sample all inputs at 128 samples per cycle, and compute a 128-point Fast Fourier Transform (FFT) every cycle for each input. When combined with high dynamic-range input of up to 140APEAK and 600VPEAK, this allows the M87x to make extremely accurate measurements of harmonics, regardless of crest factor. All harmonic and harmonic-based values are calculated every cycle. Both magnitude and phase of each harmonic are provided. In the following sections, Harmonic 0 indicates DC, Harmonic 1 indicates the fundamental, and Harmonic N is the nth multiple of the fundamental.

4.8.1 Voltage Distortion (THD) (1-Cycle Update)

Voltage Harmonic Distortion is measured by phase in several different ways. The equation for Total Harmonic Distortion (THD) is given in Equation 1. For Odd Harmonic Distortion, the summation only uses harmonics where h is odd. For Even Harmonic Distortion, the summation only uses harmonics where h is even. Note the denominator is the fundamental magnitude. For Individual Harmonic Distortion there is no summation, only one component is used in the numerator.

$$\%THD = \frac{\sqrt{\sum_{h=2}^{63} V_h^2}}{V_1} \times 100\%$$

Equation 1- Voltage THD

4.8.2 Current Distortion (THD and TDD) (1-Cycle Update)

Current Harmonic Distortion is measured by phase in several different ways. The first method is Total Harmonic Distortion (THD). The equation for THD is given in Equation 2. For Odd Harmonic Distortion, the summation only uses harmonics where h is odd. For Even Harmonic Distortion, the summation only

$$\%THD = \frac{\sqrt{\sum_{h=2}^{63} I_h^2}}{I_1} \times 100\%$$

uses harmonics where h is even. Note the denominator is the fundamental magnitude.

Equation 2 - Current

Alternatively, Current Harmonic Distortion can be measured as Demand Distortion, as defined by IEEE-519/519A. Demand Distortion differs from traditional Harmonic Distortion in that the denominator of the distortion equation is a fixed value. This fixed denominator value is defined as the average monthly peak demand. By creating a measurement that is based on a fixed value, TDD is a "better" measure of distortion problems. Traditional THD is determined on the ratio of

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$$\%TDD = \frac{\sqrt{\sum_{h=2}^{63} I_h^2}}{I_L} \times 100\%$$

Equation 3 - Current

harmonics to the fundamental. While this is acceptable for voltage measurements, where the fundamental only varies slightly, it is ineffective for current measurements since the fundamental varies over a wide range. Using traditional THD, 30% THD may mean a 1 Amp load with 30% Distortion, or a 100 Amp load with 30% Distortion. By using TDD, these same two loads would exhibit 0.3% TDD for the 1 Amp load and 30% TDD for the



100 Amp load (if the Denominator was set at 100 Amps). In the M87x, Current Demand Distortion is implemented using Equation 3. The TDD equation is similar to Harmonic Distortion (Equation 2), except that the denominator in the equation is a user-defined number. This number, I_L , is meant to represent the average load on the system. The denominator I_L is different for each phase and neutral, and is set by changing the four denominator values within the M87x. Refer to the appropriate protocol manual for specific information.

Note that in Equation 3, if I_L equals the fundamental, this Equation becomes Equation 2 - Harmonic Distortion. In the instrument this can be achieved by setting the denominator to zero amps, in which case the instrument will substitute the fundamental, and calculate Current THD. For Odd Harmonic Distortion, the summation only uses harmonics where h is odd. For Even Harmonic Distortion, the summation only uses harmonics where h is even. For Individual Harmonic Distortions there is no summation, only one component is used in the numerator.

Note that there is a separate, writeable denominator for each current input channel. The TDD Denominator Registers are set by the factory to 5 Amps (primary), which is the nominal full load of the CT input with a 1:1 CT. These writeable denominators can be used in conjunction with the distortion measurements to obtain the magnitudes of harmonics, in other words, convert from percent to amps. This is simply done by multiplying the percent TDD by the TDD Denominator for that phase, and the result will be the actual RMS magnitude of the selected harmonic(s). This technique can also be used if the THD mode (denominator set to zero) is used, by multiplying the percent THD by the Fundamental Amps for that phase.

4.8.3 Fundamental Current (1-Cycle Update)

Fundamental Amps are the nominal component (50/60 Hz) of the waveform. The M87x measures the magnitude of the fundamental amps for each phase and neutral. These measurements can be used in conjunction with the distortion measurements to obtain the magnitudes of harmonics, in other words, convert from percent to amps. As was mentioned previously, this is simply done by multiplying the percent THD by the Fundamental Amps for that phase (which is the denominator), and the result will be the actual RMS magnitude of the selected harmonic.

4.8.4 Fundamental Neutral Current (M871 Only) (1-Cycle Update)

The M871 measures the magnitude of the Fundamental Neutral Current, which is typically the magnitude of the nominal component (50/60 Hz) of neutral current. The measurement is in Amperes, and it is a measure of the load imbalance in a three-phase system.

4.8.5 Fundamental Voltage (1-Cycle Update)

Fundamental Volts are the nominal component (50/60 Hz) of the waveform. The M87x measures the magnitude of the fundamental phase-to-neutral and phase-to-phase volts. These measurements can be used in conjunction with the distortion measurements to obtain the magnitudes of harmonics, in other words, convert from percent to volts. This is simply done by multiplying the percent THD by the Fundamental Volts for that phase



(which is the denominator), and the result will be the actual RMS magnitude of the selected harmonic.

Fundamental Volts and Amps can be used in conjunction to obtain Fundamental VAs, and when used with Displacement Power Factor can vield Fundamental Watts and Fundamental VARs.

4.8.6 Fundamental Watts / Volt-Amperes (VAs) / VARs (1-Cycle Update)

Fundamental Watt, VAR, and VA Demands are calculated analogous to the True Watts / Volt-Amperes (VAs) / VARs of Section 4.4, but contain only information about the fundamental. The Fundamental Total VA calculation type is the same as the True Total VA calculation type (Section 4.4)

4.8.7 K-Factor (1-Cycle Update)

K-Factor is a measure of the heating effects on transformers, and it is defined in ANSI/IEEE C57.110-1986. Equation 4 is used by the M87x to determine K-Factor, where "h" is the harmonic number and "I_h" is the $\frac{\sum_{h=1}^{63} I_h^2 \times h^2}{\sum_{h=1}^{63} I_h^2} \times 100\%$ K-Factor is a measure of the heating effects on magnitude of the hth harmonic. K-Factor is measured on each of the three phases of amps, however there is no "Total" K-Factor. K-Factor, like THD and PF, does not indicate the actual load on a device, since all three of these

$$K - Factor = \frac{\sum_{h=1}^{63} I_h^2 \times h^2}{\sum_{h=1}^{63} I_h^2} \times 100\%$$

Equation 4 - K-Factor

measurements are ratios. Given the same harmonic ratio, the calculated K-Factor for a lightly loaded transformer will be the same as the calculated K-Factor for a heavily loaded transformer, although the actual heating on the transformer will be significantly different.

4.8.8 Displacement Power Factor (1-Cycle Update)

Displacement Power Factor is defined as the cosine of the angle (phi) between the Fundamental Voltage Vector and the Fundamental Current Vector. The sign convention for Displacement Power Factor is the same as for Power Factor, shown in Figure 7 (pg. 33).

The Total Displacement Power Factor measurement is calculated using the "Power Triangle," or the three-phase Fundamental WATTS divided by the three-phase Fundamental VAs. The per-phase Fundamental VA measurement is calculated from the product of the per-phase Fundamental Amp and Fundamental Volts values. The threephase Fundamental VA measurement is the sum of the per-phase Fundamental VA values (Arithmetic VAs).

4.8.9 Phase Angle (1-Cycle Update)

The Phase Angle is calculated for the Bus 1 to Bus 2 per-phase Fundamental Voltages and Fundamental Voltage to Fundamental Current. It is the Bus 1 Fundamental Voltage angle minus either the Bus 1 Fundamental Current or Bus 2 Fundamental Voltage angle for a given phase. Values are from -180 to +180 Degrees.



4.8.10 Resistance, Reactance, Impedance (1-Cycle Update)

These measurements are calculated for each phase from the fundamental values of voltage and current. The Impedance value, combined with the voltage-to-current phase angle, gives the polar form of the impedance. The Resistance and Reactance represent the rectangular form of the Impedance.

4.8.11 Slip Frequency (1-Cycle Update)

The Slip Frequency is the difference in the Frequency of a phase of Bus 1 Voltage to Bus 2 Voltage. Values are + when Bus 1 Frequency is greater.

4.8.12 Individual Phase Harmonic Magnitudes and Phase Angles (1-Cycle Update)

The M87x measures individual Harmonic Magnitudes and Harmonic Phase Angles for all Currents, Line-to-Neutral Voltages, and Line-to-Line Voltages. The magnitudes are reported in units of Amperes or Volts, not in percent. The Harmonic Phase Angles are in degrees, and all are referenced to the Bus 1 V_{A-N} Voltage, which places all Harmonic Phase Angles in a common reference system. Values are from -180 to +180 Degrees.

4.9 Temperature (1-Second Update)

The M87x measures the internal temperature of the unit using a sensor located on the A10 Analog-Digital Signal processor Board. Values are reported in increments of 0.5C.

4.10 Symmetrical Components (1-Cycle Update)

For each three phase input, Voltage and Current, the M87x generates the positive-sequence, negative-sequence, and zero-sequence vectors relative to phase A. These vectors represent the symmetrical components of their respective busses. The sequence component vectors are calculated by applying the vector operator a to the fundamental vectors of each phase according to the following set of well-known equations:

```
Zero-sequence component (vector) E0 = (Ea + Eb + Ec)/3
Positive-sequence component (vector) E1 = (Ea + a * Eb + a * a * Ec)/3
Negative-sequence component (vector) E2 = (Ea + a * a * Eb + A * Ec)/3
```

Where $a = \cos(120^{\circ}) + j * \sin(120^{\circ})$ and *Ea*, *Eb*, and *Ec* are the fundamental vectors of a given bus.

The configuration parameter **phase rotation**, swaps the positive and negative sequence components to accommodate installations with "CBA" phase rotation.

4.11 Supply Voltage and Current Unbalance (1-Cycle Update)

The supply voltage unbalance is evaluated from the symmetrical components, according to EN61000-4-30:2003. In addition to the positive sequence component under unbalance conditions, there also exists at least one of the following components: negative sequence component u2 and/or zero sequence component u0.

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The current unbalance is calculated similarly using the current components.

$$Uu(\%) = \frac{U_2}{U_1} x 100\%$$

4.12 Flicker

Flicker measurements are measured and evaluated according to IEC61000-4-15. Specific settings for Flicker are found on the "Flicker" page (previously named "Power Quality" tab) of the Configurator. The Nominal System Frequency should be selected appropriately for the system in the "Instrument Transformer Ratio" page (previously the "Advanced" tab) of the Configurator.

4.13 Fault Analysis

Fault location and fault type are determined using a single-ended impedance calculation that is based upon an algorithm using measured values. Following below are the required line parameters needed to be entered as well as the outputs obtained in the SOE log and for protocols. Information on triggering and recording for fault location can be found in section 5.3.7.

4.13.1 Line Parameters

Line parameters for Bus 1 and Bus 2 may be entered independently in the Fault Location Line Settings area of the 70 Series Configurator (version 2.43 and later). The magnitude and phase angle of the direct line impedance, Z_d (positive sequence), and the residual compensation factor, k_{Z0} , are required, where Z_d is measured in ohms and $k_{Z0} = (Z_0 - Z_d) / 3Z_d$. The zero sequence impedance, Z_0 , is needed when doing the calculation. In addition, the user may specify the line length and their preferred units of measure, in place of per unit values (p.u.), for reporting distance in the SOE log.

4.13.2 Peak Current

When the Fault Analysis module is triggered, it will scan for the maximum fundamental current values in the 10 cycles before and 20 cycles after the trigger point. The maximums for each of Phase A, Phase B, Phase C, and Residual current are saved. The results are made available in the SOE log and protocol registers as noted below. Additionally, the maximum of the three phase (A, B, C) maximums is saved separately and made available via protocol.

4.13.3 Status Indication and Reset

The availability of measurement points indicating status and which ones can be reset are indicated as follows:



Fault Type: One point representing the fault type is available on Mx71 (Two points on Mx72 models). The user is able to select Fault Type if it is of interest when creating a user-configurable point list. The index number will be determined by where the point falls within the point list. The Fault Type point value represents a set of packed bits. Bit0 represents A-Phase Involved, Bit1 represents B-Phase Involved, Bit2 represents Phase-C Involved. All other bits (Bit3 – Bit15) always equal Zero. In that way:

- (1) A-G fault is indicated by binary value of 1 (0001)
- (2) B-G is binary 2 (0010)
- (3) A-B is binary 3 (0011)
- (4) C-G is binary 4 (0100)
- (5) A-C is binary 5 (0101)
- (6) B-C is binary 6 (0110)
- (7) ABC is binary 7 (0111)

Targets: Four points representing targets are available on Mx71 (Eight points on Mx72 models). The user will be able to select any of the points that are of interest when creating a user-configurable point list. Index numbers will be determined by where the points fall within the point list. Target Points: Fault Completed is set when the module has completed analysis. Fault Target A, Fault Target B, and Fault Target C are set when their associated phases are involved in the fault. Target points are single bit binaries. Possible values are 0 and 1.

Fault Counter: One point (Two points on Mx72 models) is available representing the number of times the fault location algorithm has been triggered. The user will be able to select Fault Count if it is of interest when creating a user-configurable point list. The index number will be determined by where the point falls within the point list. The Fault Count point may be read as a counter change object. This is intended to facilitate notification (via event polling) that the value of the peak fault current has been freshly updated. The Fault Count Point simply increments until it rolls over; it cannot be reset.

Target Resets: The above-mentioned Fault Completed point is available to permit the user to reset targets once all data associated with a fault has been read. The user will be able to select Reset Targets when creating a user-configurable point. The index number will be determined by where the point falls within the point list. When the point is reset by writing a zero to it, the Fault Type point and the Fault Target A,B,C points will be automatically set to zero as well.

Related points for Bus1, Mx72 model Bus2 points are similar:

4.13.4 SOELOG Output

The soelog will report the fault type and fault distance. Distance will be shown as "per unit," and in terms of the users preferred length units. For example, if the line length is defined as 100km the soelog entry might look like this:

24 30-Jul-2007 01:10:51.300206 Fault AB1 at 0.4949 of line or 49.49 km

4.13.5 Protocol Output

Configurable registers in Modbus and DNP may be used to view the results of the fault



analysis calculations and the peak fault current. The following measurements have been added:

Measurement	Modbus	DNP3
Fault Type Bus 1	Modbus register	DNP Analog Input
Fault Distance XAN1	Modbus register	DNP Analog Input
Fault Distance XBN1	Modbus register	DNP Analog Input
Fault Distance XCN1	Modbus register	DNP Analog Input
Fault Distance XAB1	Modbus register	DNP Analog Input
Fault Distance XBC1	Modbus register	DNP Analog Input
Fault Distance XCA1	Modbus register	DNP Analog Input
Fault Type Bus 2	Modbus register	DNP Analog Input
Fault Distance XAN2	Modbus register	DNP Analog Input
Fault Distance XBN2	Modbus register	DNP Analog Input
Fault Distance XCN2	Modbus register	DNP Analog Input
Fault Distance XAB2	Modbus register	DNP Analog Input
Fault Distance XBC2	Modbus register	DNP Analog Input
Fault Distance XCA2	Modbus register	DNP Analog Input
Peak Fault Current IA1	Modbus register	DNP Analog Input
Peak Fault Current IB1	Modbus register	DNP Analog Input
Peak Fault Current IC1	Modbus register	DNP Analog Input
Peak Fault Current IR1	Modbus register	DNP Analog Input
Peak Fault Current Bus1	Modbus register	DNP Analog Input
Peak Fault Current IA2	Modbus register	DNP Analog Input
Peak Fault Current IB2	Modbus register	DNP Analog Input
Peak Fault Current IC2	Modbus register	DNP Analog Input
Peak Fault Current IR1	Modbus register	DNP Analog Input
Peak Fault Current Bus2	Modbus register	DNP Analog Input
Fault Target Al		DNP Binary Output
Fault Target B1		DNP Binary Output
Fault Target C1		DNP Binary Output
Fault Completed Bus1	Modbus register	DNP Binary Output
Fault Count Bus1	Modbus register	DNP Analog Input
Fault Target A2		DNP Binary Output
Fault Target B2		DNP Binary Output
Fault Target C2		DNP Binary Output
Fault Completed Bus2	Modbus register	DNP Binary Output
Fault Count Bus2	Modbus register	DNP Analog Input

The 'fault type' registers are a bit-field representation of which phases were driven by the event system, and are the same information used to generate the faulted phase strings in the soelog. Bit0 is A, Bit1 is B, Bit2 is C. The 'fault distance' registers are integer representations of the per-unit distance, in DIV1000 or DIV100 format pending exact configuration implementation.



4.14 List of Available Measurements

Please note that not all measurements are available in every M87x model (i.e. neutral current in M871 only, second set of current measurements and corresponding power, energy, etc. only in M872)

Available Measurements				
Accrued Digital IO Module #0-6, Input 1-16	K-factor Amps B (1 and 2)			
Accrued Digital IO Module #0-6, Output 1-8	K-factor Amps C (1 and 2)			
Accrued DR1/DR2 Active, Completed, Started	K-factor Amps N			
Accrued Pulse KWH, KVARH Positive (Bus 1 and 2)	K-factor Amps Residual (1 and 2)			
Accrued Pulse KWH, KVARH Negative (Bus 1 and 2)	Log Interval			
Accrued Virtual IO, Inputs 1-32, Outputs 1-32	Meter Type			
Accrued WR1/WR2 Active, Completed, Started	Misc. Packed Bits			
Amps A, B, C, N, Residual (Feeder 1 and 2)	Network Time Sync			
Any Recorder Active	Peak Fault Current Amps A, B, C, Residual, Bus (1 and 2)			
Any Recorder Memory Full	Phase Angle Amps A Harmonic (163 for 1 and 2)			
Any Recorder Stored	Phase Angle Amps B Harmonic (163 for 1 and 2)			
Any Recorder Triggered	Phase Angle Amps C Harmonic (163 for 1 and 2)			
Avg. 3-phase Amps (1 and 2)	Phase Angle Amps N Harmonic (163)			
Avg. 3-phase Volts (1 and 2)	Phase Angle Volts A Bus1-Bus2			
Best Clock	Phase Angle Volts A Harmonic (163)			
Class 0 Response Setup	Phase Angle Volts AB Harmonic (163)			
CT Scale Factor	Phase Angle Volts B Bus1-Bus2			
CT Scale Factor Divisor	Phase Angle Volts B Harmonic (163)			
Demand (Max.) Amps A, B, C, N, Residual (1 and 2)	Phase Angle Volts BC Harmonic (163)			
Demand (Max.) Fund. Amps A, B, C, N, Resid. (1 and 2)	Phase Angle Volts C Bus1-Bus2			
Demand (Max.) TDD Amps A, B, C, N, Resid. (1 and 2)	Phase Angle Volts C Harmonic (163)			
Demand (Max.) THD Volts Bus1 AN, BN, CN, AB, BC, CA	Phase Angle Volts CA Harmonic (163)			
Demand (Max.) THD Volts Bus2 AN, BN, CN, AB, BC, CA	Phase Angle Volts to Amps A (1 and 2)			
Demand (Max.) VARs A, B, C, Total (1 and 2)	Phase Angle Volts to Amps B (1 and 2)			
Demand (Max.) VAs A, B, C, Total (1 and 2)	Phase Angle Volts to Amps C (1 and 2)			
Demand (Max.) Volts Bus1 AN, BN, CN, NG, AB, BC, CA	Power Factor A, B, C, Total (Bus 1 and 2)			
Demand (Max.) Volts Bus2 AN, BN, CN, NG, AB, BC, CA	Power Factor Total Arithmetic (Bus 1 and 2)			
Demand (Max.) Watts A, B, C, Total (1and 2)	Power Factor Total Equivalent L-L (Bus 1 and 2)			
Demand (Min.) THD Volts Bus1 AN, BN, CN, AB, BC, CA	Power Factor Total Equivalent L-N (Bus 1 and 2)			
Demand (Min.) THD Volts Bus2 AN, BN, CN, AB, BC, CA	Power Factor Total Geometric (Bus 1 and 2)			
Demand (Min.) VARs A, B, C, Total (1 and 2)	Protocol Version			
Demand (Min.) VAs A, B, C, Total (1 and 2)	PT Scale Factor			
Demand (Min.) Volts Bus1, AN, BN, CN, NG, AB, BC, CA	PT Scale Factor Divisor			
Demand (Min.) Volts Bus2, AN, BN, CN, NG, AB, BC, CA	Pulse Status- Negative VArHrs (1 and 2)			
Demand (Min.) Watts A, B, C, Total (1 and 2)	Pulse Status- Negative WHrs (1 and 2)			
Demand Amps A, B, C, N, Residual	Pulse Status- Positive VarHrs (1 and 2)			
Demand Fundamental Amps A, B, C, N, Residual	Pulse Status-Positive WHrs (1 and 2)			
Demand TDD Amps A, B, C, N, Residual	Pulse VAR-Hrs Normal (1 and 2)			
Demand THD Volts Bus1 AN, BN, CN, AB, BC, CA	Pulse VAR-Hrs Reverse (1 and 2)			
Demand THD Volts Bus2 AN, BN, CN, AB, BC, CA	Pulse Watt-Hrs Normal (1 and 2)			
Demand VARs A, B, C, Total	Pulse Watt-Hrs Reverse (1 and 2)			
Demand VAs A, B, C, Total	Reactance A, B, C (1 and 2)			
Demand Volts Bus1 AN, BN, CN, NG, AB, BC, CA	Resistance A, B, C, (1 and 2)			

Available Measurements				
	<u>,</u>			
Demand Volts Bus2 AN, BN, CN, AB, BC, CA	Slip Freq. Volts A Bus1-Bus2			
Demand Watts A, B, C, Total	Slip Freq. Volts B Bus1-Bus2			
Digital IO Module #0-6 Debounce Time	Slip Freq. Volts C Bus1-Bus2			
Digital IO Module #0-6 Input Point 1-16	SNTP Time Sync			
Digital IO Module #0-6 Output Point 1-8	Symmetrical comp. of Bus 1 voltage (mag. and angle)			
Digital IO Module #0-6 Status Output Point 1-8	Symmetrical comp. of Bus 2 voltage (mag. and angle)			
Displacement Power Factor A, B, C (1 and 2)	Symmetrical comp. of current (mag. and angle, 1 & 2)			
Displacement Power Factor Total (1 and 2)	System Frequency			
Displacement Power Factor Total Arithmetic (1 and 2)	Tag Register			
Displacement Power Factor Total Equivalent L-L (1 & 2)	TDD Amps A, B, C, N, Residual (1 and 2)			
Displacement Power Factor Total Equivalent L-N (1 & 2)	TDD Denominator A, B, C, N (1 and 2)			
Displacement Power Factor Total Geometric (1 & 2)	TDD, Even, Amps A, B, C, Residual (1 and 2)			
DNP Time Sync	TDD, Odd, Amps A, B, C, Residual (1 and 2)			
DR 1 Active	Temperature			
DR1 Memory Full	THD Volts Bus1 AN, BN, CN, AB, BC, CA			
DR1 Record Count	THD Volts Bus2 AN, BN, CN, AB, BC, CA			
DR1 Stored	THD, Even, Volts Bus1 AN, BN, CN, AB, BC, CA			
DR1 Triggered	THD, Even, Volts Bus2 AN, BN, CN, AB, BC, CA			
DR2 Active	THD, Odd, Volts Bus1 AN, BN, CN, AB, BC, CA			
DR2 Memory Full	THD, Odd, Volts Bus2 AN, BN, CN, AB, BC, CA			
DR2 Record Count	Time Sync Error (µsec, msec, sec)			
DR2 Stored	Transducer Input Module # 1-7, Input Point 1-8			
DR2 Triggered	Trigger Derivative 1-120			
DSP Version	Unbalance Volts (1 and 2)			
Factory Version Hardware	Unbalance Amps (1 and 2)			
Factory Version Software	User Gain Amps A, B, C, N, Residual (1 and 2)			
Fault Completed (Bus 1, Bus 2)	User Gain Volts Bus1 A, B, C, N			
Fault Count (Bus 1, Bus 2)	User Gain Volts Bus2 A, B, C, N			
Fault Distance AN, BN, CN, AB, BC, CA (Bus 1, Bus 2)	User Gain Volts Bus2 Aux1-Gnd, Aux2-Gnd, Aux1-			
, , , , , , , , , , , , , , , , , , , ,	Aux2			
Fault Target (A, B, C, Bus 1 and Bus 2)	User Phase Correction Amps A, B, C, N, Residual (1 and 2)			
Fault Type (Bus 1, Bus 2)	User Phase Correction Volts Bus1 AN, BN, CN, NG, AB, BC, CA			
Flicker Short (PST VAN, VBN, VCN Bus 1 and 2)	User Phase Correction Volts Bus2 AN, BN, CN, NG, AB, BC, CA			
Flicker Long (PLT VAN, VBN, VCN Bus 1 and 2)	User Phase Correction Volts Bus2 Aux1-Gnd, Aux2-Gnd, Aux1-Aux2			
Frequency Amps A, B, C, Residual (1 and 2)	VA/PF Calc. Type (1 and 2)			
Frequency Volts Bus1 A, B, C	VA-Hrs (1 and 2)			
Frequency Volts Bus2 A, B, C	VAR-Hrs Lag (1 and 2)			
Fund. Amps A, B, C, N, Residual (1 and 2)	VAR-Hrs Lead (1 and 2)			
Fund. VAs Tot. Arith (1 and 2).	VARs A, B, C, Total (1 and 2)			
Fund. VAs Tot. Equiv. L-L (1 and 2)	VAs A, B, C, Total (1 and 2)			
Fund. VAs Tot. Equiv. L-N (1 and 2)	VAs Tot. Arith. (1 and 2)			
Fund. VAs Tot. Geom. (1 and 2)	VAs Tot. Equiv. L-L (1 and 2)			
Fund. VAs Total (1 and 2)	VAs Tot. Equiv. L-N (1 and 2)			
Fund. Volts Bus1 AN, BN, CN, AB, BC, CA	VAs Tot. Geom. (1 and 2)			
Fund. Volts Bus2 AN, BN, CN, AB, BC, CA	Virtual Input Point 1-32			
Harmonic, Individual, Amps A, B, C, N (163 for 1 & 2)	Virtual Output Point 1-32			
	virtual Output I Ollit I-02			

Available Measurements					
Harmonic, Individual, Bus1, Volts A (163)	Volts Aux1-Gnd, Aux2-Gnd, Aux1-Aux2				
Harmonic, Individual, Bus1, Volts AB (163)	Volts Bus1 AN, BN, CN, NG, AB, BC, CA				
Harmonic, Individual, Bus1, Volts B (163)	Volts Bus2 AN, BN, CN, NG, AB, BC, CA				
Harmonic, Individual, Bus1, Volts BC (163)	Watt-Hrs Normal (1 and 2)				
Harmonic, Individual, Bus1, Volts C (163)	Watt-Hrs Reverse (1 and 2)				
Harmonic, Individual, Bus1, Volts CA (163)	Watts A, B, C, Total (1 and 2)				
Harmonic, Individual, Bus2, Volts A (163)	Waveform Status				
Harmonic, Individual, Bus2, Volts AB (163)	WV1/WV2 Active				
Harmonic, Individual, Bus2, Volts B (163)	WV1/WV2 Memory Full				
Harmonic, Individual, Bus2, Volts BC (163)	WV1/WV2 Record Count				
Harmonic, Individual, Bus2, Volts C (163)	WV1/WV2 Stored				
Harmonic, Individual, Bus2, Volts CA (163)	WV1/WV2 Triggered				
Health	Xfmr Ratio Amps A, B, C, N, Residual (1 and 2)				
Heartbeat	Xfmr Ratio Future Use				
Impedance A, B, C (1 and 2)	Xfmr Ratio Volts Bus1 A, B, C, N				
IrigB Time Sync	Xfmr Ratio Volts Bus2 A, B, C, N				
K-factor Amps A (1 and 2)	Xfmr Ratio Volts Bus2 Aux1-Gnd, Aux2-Gnd, Aux1-Aux2				

August 15, 2018

5.0 FUNCTIONAL DESCRIPTION



5.1 Passwords

The M87x has implemented the standard Bitronics password scheme. There are three different access levels:

Level 0: This access level provides read-only access to all settings and data, thus preventing modification of information that affects system security. The factory default password for level 0 is "AAAA"; this is the same as entering no password.

Level 1: This access level includes the read access of level 0. In addition, the user is permitted to delete recorder files, and reset energy and demand values. The factory default password for level 1 is "AAAA"; this is the same as entering no password.

Level 2: This access level includes all lower level functionality. The user is also granted full read/write/delete access on all files in the M87x, including the configuration files. The factory default password for level 2 is "AAAA"; this is the same as entering no password.

NOTE: The factory default is to allow level 2 access with no password. For the password scheme to take effect, the user must change the passwords with the 70 Series Configurator.

5.2 Configuration

Setup of the M87x is most easily performed using the 70 Series Configurator. This software runs on a PC and allows the PC to communicate to the M87x using a serial port or Ethernet connection. The M87x configuration is stored internally by means of several configuration files, located in the directory shown in the following table. Most of these are ASCII text files, and may be saved, copied, and deleted by any of the various methods of file manipulation, such as FTP, Zmodem, and the 70 Series Configurator.

If using IEC61850 protocol, the configuration of the IP and SNTP addresses will be determined based upon a selection the user makes by way of the radio button selections found on the 70 Series Configurator Identity page. The radio buttons provide the user with the flexibility to decide which software tool will control the IP and SNTP address configuration settings. Configuration settings are loaded upon reboot from either the Initialization (INI) files or the Micom Configuration Language (MCL) files, depending upon the radio button selected during configuration. The IP and SNTP addresses will be loaded either from the respective address settings stored in the INI file by the 70 Series Configurator or from the address settings stored in the MCL file by the IEC61850 IED Configurator. Addresses written into the MCL file will be written back into the INI file when the unit reboots. It is only possible to synchronize the addresses by reading the address information written into the MCL file back into the INI file upon reboot. (The IP and SNTP Addresses are rewritten to the INI file though the 70Series Configurator upon reboot since the IEC61850 IED Configurator does not have the ability to rewrite information once the configuration is written to the MCL file). There is a mechanism to automatically sychronize these addresses upon rebooting the M87x, so that the current IP address for the M87x will be updated on the 70 Series Configurator Identity page. For the case when the radio button is selected as "IEC61850 IED Configurator (MCL file)" the IP networking information



will appear in grey indicating the IEC61850 IED Configurator is the active tool. Only the 70 Series Configurator allows the user to select which configurator tool loads the IP and SNTP addresses.

The configuration files are stored in the M87x directory c:\Config. The 70 Series Configurator will generate the IED Capability Description (ICD) file and automatically store it on the M87x in directory c:\Config. If using IEC61850 protocol 2 additional files, an MCL file and an MC2 file, will be generated by the IEC61850 IED Configurator and will be stored on the M87x in the c:\Config directory. The MCL files are the Micom Configuration Language files and contain the information pertaining to the IEC61850 Configuration. The MCL file is stored as the active bank and contains the IEC61850 configuration and the MC2 file becomes the inactive bank, containing the previous IEC61850 configuration.

Filename	Directory	Description		
COMM.INI	c:\CONFIG\	Contains serial port information.		
DEMANDS.INI	c:\CONFIG\	Contains demand intervals.		
DIO.INI	c:\CONFIG\	Contains Digital I/O data, i.e. the Digital I/O debounce time.		
DISPLAY.BIN	c:\CONFIG\	Contains setup information for communicating with a remote display		
DNP.BIN	c:\CONFIG\	Contains DNP configurable register information		
DR1.INI	c:\CONFIG\	Contains setup information for Disturbance Recorder 1		
DR2.INI	c:\CONFIG\	Contains setup information for Disturbance Recorder 2		
DSP.INI	c:\CONFIG\	Contains CT/VT ratios, user gains and phase, harmonic denominators, and VA calculation types.		
IDENTITY.INI	c:\CONFIG\	Contains Identity info, i.e. device name of M87x, IP address, NSAP address.		
MODBUS.BIN	c:\CONFIG\	Contains Modbus configurable register information		
PROTOCOL.INI	c:\CONFIG\	Contains Modbus, Modbus Plus, and DNP protocol setup information.		
SBO.INI	c:\CONFIG\	Contains UCA2.0 Select Before Operate parameters		
SCALEFAC.INI	c:\CONFIG\	Contains integer-to-floating point scale factor info for UCA.		
TR1.INI	c:\CONFIG\	Contains setup information for TR1 recorder.		
VIO.INI	c:\CONFIG\	Contains Virtual Input/Output setting information.		
WR1.INI	c:\CONFIG\	Contains Waveform Recorder 1 Configurator parameters		
WR2.INI	c:\CONFIG\	Contains Waveform Recorder 2 Configurator parameters		
TRIGGER.INI	c:\CONFIG\	Contains all trigger configuration info		
MEASUSER.INI	c:\CONFIG\	Contains user defined measurement names		
VFT.INI	c:\CONFIG\	Contains Voltage Fluctuation Table configuration		
HARDWARE.INI	c:\CONFIG\	Contains configured hardware info		
SYS_CNFG.INI	c:\PERSIST\	Contains hardware found by unit		

There are also several ".BIN" files in the "c:\CONFIG\" directory which contain information on the protocol register configuration for Modbus, Modbus Plus and DNP. These files are written by the 70 Series Configurator and are not editable by the user.



AFTER WRITING THE CONFIGURATION FILES, THE M87X MUST BE RESET (REBOOTED) BEFORE THE NEW CONFIGURATION WILL TAKE EFFECT.





Triggers can be configured in the 70 Series to initiate several different actions:

Waveform Recorders
Disturbance Recorders
Digital Outputs
Virtual Outputs
SOE Entries
Resetting of various measurements (Demands, Energy, etc.)

Up to 120 triggers can be specified, of the following types:

5.3.1 Threshold Trigger

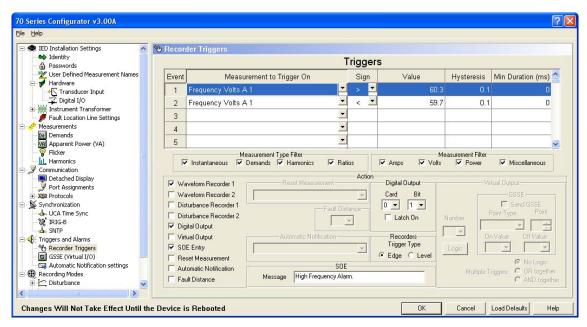
Any measurement can be used to trigger a Waveform Recorder or Disturbance Recorder, or create an entry in the SOE log. Configuring multiple triggers will cause a logical "OR" to be applied to the list of triggers. The trigger thresholds are defined by the 70 Series Configurator. The user specifies the measurement to use, the threshold value, the arithmetic function of the trigger, and the hysteresis value.

If the measurement is an analog value (such as volts or amperes), the user may choose to trigger on values greater than or less than the threshold. Additionally, the user may choose a rate-of-change trigger greater than, less than, or equal to the threshold value. Rate-of-change intervals are calculated over the interval since the measurement was last updated.

5.3.1a Trigger Hysteresis

Hysteresis is used to prevent chattering of contacts or unintended repeat-triggering of recorders when a measurement fluctuates near the value where the action is intended to occur. Refer to the Hysteresis column on the *Recorder Triggers* page of the *70 Series Configurator* program (below). The hysteresis setting is used to make the trigger occur and re-initialized at different values. In the example below, since 60.3 Hz - 0.1 = 60.2 Hz, the action takes place when frequency exceeds 60.3 Hz and re-initializes below 60.2 Hz. When hysteresis is set to zero (default) the action triggers and resets at the same value.





Configuration of Hysteresis Settings

For example: Suppose an alarm contact is intended to close when the frequency exceeds 60.3 Hz. Frequency is generally regulated very tightly about 60 Hz, so except for the significant transients that the setting is intended to capture, it would not be unusual for the frequency to dwell for a prolonged time near 60.3 Hz, fluctuating by only an insignificant amount but crossing the threshold many times (see illustration below, on the right half of the trace). To eliminate this chatter, the user might configure the hysteresis to be 0.1 Hz, as shown above. Then if the frequency were to rise from normal to the high frequency alarm range as illustrated below, the contact will close exactly as it passes 60.3 and it will remain closed until the frequency decreases below 60.2, when the contact opens.

The hysteresis function operates symmetrically when used with measurements that trigger below a threshold. So for Event 2 shown in the 70 Series Configurator screen above, a trigger would occur when the frequency drops below 59.7 Hz, and reset above 59.8 Hz.

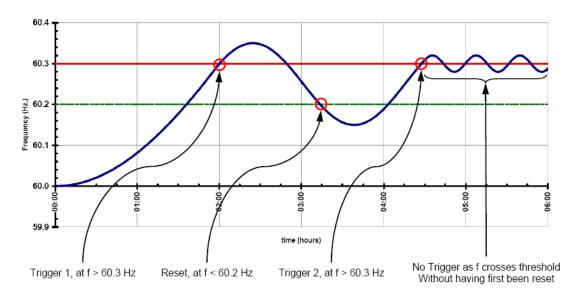


Illustration of Trigger and Reset (or Operate and Release) when using Hysteresis



Hysteresis may be used to constrain chatter in any of the Actions listed on the *Recorder Triggers* page (i.e. recorders, contacts, GOOSE messages, SOE Log entries, etc.) It may also be combined with a setting in the "Min Duration (ms)" column to prevent triggering on short-duration transients when a trigger might only be desired in connection with steady-state events; tap-changing for voltage control for example.

5.3.2 Digital Input Trigger

A waveform or disturbance record or an SOE log entry can be triggered by using any of the digital inputs on the Digital Input/Output Module (Section 9). Any or all of the digital inputs can be used to trigger a record. Each input can be independently set to trigger on a state transition. Assigning the digital inputs to initiate a record MUST be performed by using the 70 Series Configurator.

An event triggered from the digital inputs will be subject to the debounce time setting for the digital input. Digital input traces in the Waveform Recorder files are the instantaneous status of the inputs, and do not reflect any debounce time settings. If a long debounce time is set, it is possible to see an event on the digital input that does not cause a trigger.

5.3.3 Edge and Level Triggers

The user can select between Edge and Level Triggers.

An Edge trigger exists for only an instant in time. The time before the trigger is defined the Pre-trigger period, and the time after the trigger is the Post-trigger period.

A Level trigger has duration in time. The trigger is valid as long as the trigger condition is met. The time before the trigger is still defined the Pre-trigger period, but the Post-trigger period does not begin until after the trigger condition is no longer valid.



5.3.4 Manual Trigger

Refer to the appropriate protocol manual for information. Manual Triggers may also be activated through BiView using Telnet, Zmodem, or under Modbus or DNP3 protocols (depending on what register set/ point list is chosen). When a manual trigger is initiated, it bypasses the standard trigger setup, and directly initiates the action specified by that command.

5.3.5 Logical Combinations of Triggers

Triggers can be logically combined in groups to perform actions. Each trigger is assigned to the same Virtual Output in the Configurator, and the type of logic function (AND or OR) is selected. That Virtual Output is then configured as a new trigger, with the appropriate action assigned. If "No Logic" is selected, then only one trigger can be assigned to a particular Virtual Output.

5.3.6 Cross Triggering Multiple 70 Series Units (Inter-triggering)

Under certain circumstances, it is advantageous that a 70 Series device that captures a record, also functions in a capacity to send out a pre-determined trigger condition. That trigger condition, which is based on values measured by the instrument, can be used for the purpose of cross triggering (also referred to as inter-triggering) other 70 Series devices. Cross triggering is an essential requirement for synchronizing the equipment in a substation, where it is necessary that multiple instruments sense the occurrence of particular conditions

There are a number of ways to accomplish cross triggering across 70 Series devices. The cross triggering mechanism can be accomplished by way of a physical interconnection using Digital I/O, or by way of virtual messaging, which is communicated over an Ethernet network connection. Refer to Appendix A for examples of setting up cross triggering through either Digital I/O connections, GSSE messaging [through UCA], or GOOSE messaging [through IEC61850].

A P30 or P31 module is necessary to set up cross triggering using a Digital I/O interconnection method. An Ethernet option module is necessary in order to set up either GSSE messaging [through UCA] or GOOSE messaging [through IEC61850].

Units may both send and receive cross triggers from and to multiple other units.

5.3.7 Fault Distance Triggers

Fault distance calculations are initiated as an action from the configurable Triggers. For a chosen trigger, select the Fault Distance checkbox, and then the associated phase from the dropdown box. A simple limit trigger such as RMS Amps A 1 > 2000 can be set to calculate an A1 fault. Similarly, the Digital Inputs can be used to drive the calculations when connected to the outputs of a protection device. More complex conditions can be specified with the use of logic functions. For example:

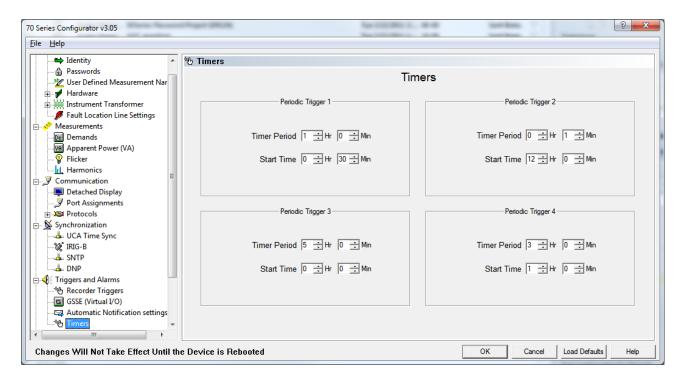


	Triggers						
Event	Event Measurement to Trigger On Sign Value Hysteresis Min Duration (ms					Min Duration (ms) 📤	
1	RMS Volts B 1	<	•	260,000	0	0	
2	RMS Amps B 1	>	•	2,000	0	0	
3	Phase Angle Volts to Amps B 1	dt :	> _	10	0	0	
4	Virtual Output 2		=	1	N/A	0	
_	_						

Here, the first three conditions are logically "anded" together to drive Virtual Output 2. VO2, in turn, is configured to initiate a fault distance calculation on B1. Line to line fault distances are calculated when more than one of the A1, B1, C1 events are triggered.

5.3.8 Periodic Triggers

Four independent periodic triggers are available that can be used to initiate all of the actions listed in section 5.3 above. The timers for these triggers are configured to individually set the period and start time for each trigger on the Timers page of the 70 Series Configurator as shown below:



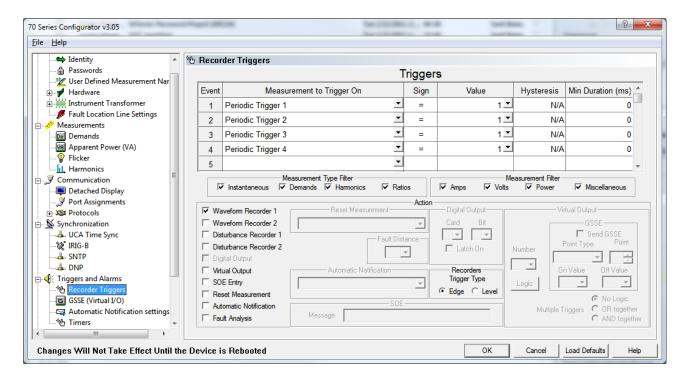
The period can be set in increments of minutes up to a maximum of 24 hours. Likewise, the time of day for the timer to start can be specified in increments of one minute.

Note that if the number of minutes in a day is not evenly divisible by the configured period, then the start time has little impact except at boot up. For example, if the period is configured for 7hrs and the start time is 0430hrs then the first day after the device starts the timer will activate at 0430hrs, 1130hrs, 1930hrs. And then on the second day, it will activate at 0230hrs, 0930hrs, 1630hrs, 2330hrs., etc.

The activation status of the timers is available as a binary point in the list of 'Measurements to Trigger On' in the Recorder Triggers page (see screen below). The



point will transition from 0 to 1 at the timers scheduled activation. It will hold at 1 briefly and then return to 0. These 'Periodic Trigger' points can then be used to trigger any of the actions selected.



5.4 Recording

The M87x has five different methods of recording data. High-speed samples of the input signal are captured and stored by the two Waveform Recorders, slower-speed measurement data is stored by the two Disturbance Recorders, long-term load-profile data is stored by the Trend Recorder, and a voltage fluctuation table (VFT) and a sequence of event (SOE) log can be created as well.

The Waveform Recorders save the actual samples from the input channels, as well as from the Digital I/O modules. The two Disturbance Recorders log values at a user configurable rate of 1-3600 cycles. The Trend Recorder logs values at a user configurable rate of 1 minute -12 hours. The VFT file records voltage values when pre-selected thresholds are passed, and the SOE file creates a summary of events in the order they occur.

The Waveform and Disturbance records and the VFT and SOE files are created based on event conditions. Unlike these other recorders, the trend recorder is not based on triggered conditions but instead runs constantly when selected to record.

5.4.1 Waveform Recorder

A waveform record can be triggered by a measurement exceeding an upper or lower threshold, by a manual protocol command, or by a digital or virtual input channel changing state. When a trigger condition is met, a record is created that contains samples from the input channels. The waveform record normally contains 20 cycles of pre-trigger and 40 cycles of post-trigger information. The pre- and post- trigger times are configurable by the



user. If additional triggers occur within the post-trigger period, the waveform record will be extended for the selected number of post-trigger cycles. Optionally, the user can choose to disable re-triggering.

There is a limit of 2000 cycles (approximately 33.3 seconds at 60Hz) for each waveform record. (Prior to The M87x will continue to record waveforms until the memory allocated for the Waveform Recorder is full. Regardless of the number of records stored, if sufficient memory exists for the designated number of pre-trigger cycles the M87x will create a new record, although it may not be full-length.

When selecting the COMTRADE File Type for the Configuration settings in the Waveform Recorder, the user should be aware that certain processing limitations may be encountered that can result in data loss for a waveform record.

If the host processor encounters large amounts of data due to creating long length waveform records and is otherwise overloaded with performing other tasks, the data in the queue may be overwritten before it could be written onto the Flash drive. This is a possibility that may be encountered when attempting to handle an excessive volume of data, which may not be handled adequately by the host processor. To reduce the possibility of this occurring especially during the processing of large amounts of data, it is a good practice to tailor the selection of the COMTRADE File Type based on the desired length of the file to be recorded. As a guideline when configuring the waveform recorder, the following are useful recommendations: a Binary COMTRADE File Type used along with a lower sample rate is better for recording longer length waveform files; an ASCII COMTRADE File Type is better suited for recording short length waveform files. Binary format will generate smaller data files then ASCII format. A higher sample rate can be more useful when recording short files. Use the lowest sample rates possible when capturing long waveform records.

If the post trigger times appear to be truncated in the COMTRADE file, that would suggest that the user adjust the waveform recorder's configuration settings, accordingly. This will usually alleviate the issues associated with recording long length waveform files.

The Waveform Recorders share storage space with the Disturbance Recorders and the Trend Recorder. The 70 Series Configurator allows the user to select the maximum available memory for each recorder function. Note that if the user wishes to change the allocation of memory among the recorders after recordings have already been made, it is necessary to first remove the existing files from memory before making any change.

Waveform records are presented in industry standard (IEEE C37.111-1999) Comtrade files which are stored as compressed .zip files. Waveform records may be retrieved and deleted from the instrument using the available communications protocols. Please refer to the specific protocol manual or section 5.5 (Zmodem and FTP) for details. A file cannot be deleted while being read by another device.

The following table shows the signals that are included in the waveform record. The user can select a sampling rate of 32, 64 or 128 samples per cycle for all signals on all Mx7x models. An additional, higher sampling rate of 256 samples per cycle is available when using the M571 or the M871 models (excludes M572 and M872). Please note, however,



that selecting the 256 sample per cycle sampling rate disables all measurements associated with bus 2 voltages (Volts A2, B2, and C2) and auxiliary voltages (Volts Aux1-Gnd, Aux2-Gnd, and AuxDiff). Because the sampling rate is synchronized with the system frequency, the sample rate (in samples per second) will vary with frequency. Note that for M87x units, when a Digital Input from any module is selected, a total of 16 digital inputs will be added to the Waveform file.

Comtrade Trace	WYE Definition	DELTA Definition (shown with Phase B	
Volts 1 A	Voltage Bus 1 Phase A to Neutral	Voltage Bus 1 Phase A to B ¹	
Volts 1 B	Voltage Bus 1 Phase B to Neutral	Always = 01	
Volts 1 C	Voltage Bus 1 Phase C to Neutral	Voltage Bus 1 Phase C to B ¹	
Amps 1 A	Amps 1 Phase A Current	Amps 1 Phase A Current	
Amps 1 B	Amps 1 Phase B Current	Amps 1 Phase B Current	
Amps 1 C	Amps 1 Phase C Current	Amps 1 Phase C Current	
Amps N	Phase N Current	Phase N Current	
Volts 2 A	Voltage Bus 2 Phase A to Neutral	Voltage Bus 2 Phase A to B ¹	
Volts 2 B	Voltage Bus 2 Phase B to Neutral	Always = 0 ¹	
Volts 2 C	Voltage Bus 2 Phase C to Neutral	Voltage Bus 2 Phase C to B1	
Amps 2 A	Amps 2 Phase A Current	Amps 2 Phase A Current	
Amps 2 B	Amps 2 Phase B Current	Amps 2 Phase B Current	
Amps 2 C	Amps 2 Phase C Current Amps 2 Phase C Current		
Aux In 1	Voltage Aux 1 to Ground Voltage Aux 1 to Ground		
Aux In 2	Voltage Aux 2 to Ground	Voltage Aux 2 to Ground	
Dig In 0 1 - X	Digital Input Module 0 input 1 - X	Digital Input Module 0 input 1 - X	
Dig In 1 1 - X	Digital Input Module 1 input 1 - X	Digital Input Module 1 input 1 - X	
Dig In 2 1 - X	Digital Input Module 2 input 1 - X	Digital Input Module 2 input 1 - X	
Dig In 3 1 - X	Digital Input Module 3 input 1 - X	Digital Input Module 3 input 1 - X	
Dig In 4 1 - X	Digital Input Module 4 input 1 - X	Digital Input Module 4 input 1 - X	
Dig In 5 1 - X	Digital Input Module 5 input 1 - X	Digital Input Module 5 input 1 - X	

¹When the M87x is used on a DELTA (2-element system), one of the Phase Voltage inputs will be connected to the Neutral Voltage input, and that Phase-to-Neutral voltage will then be zero. The remaining two Phase-to-Neutral voltages then become Phase-to-Phase voltages. The reference phase does not have to be Phase B.

5.4.1a Default Frequency Setting for Waveform Recorder

The Nominal System Frequency should be selected appropriately for the system in the "Instrument Transformer Ratio" page (previously the "Advanced" tab) of the Configurator. Normally the unit will modify the sample rate to track the frequency of any CT or VT signal present. However, if there are no signals available for frequency tracking, the unit will default to the Nominal System Frequency setting.

5.4.1b Indicating Waveform Records with Digital Outputs

Any of the outputs on the Digital Input / Output Module can be configured to indicate the status of the recorder. Recorder status includes: Recorder Started, Recorder Completed, Recorder Memory Low, and Recorder Active. When a waveform record is created, the assigned output relay will be energized. When an output relay is assigned to indicate the presence of a waveform record, it can no longer be controlled via protocol commands. *If*



power is removed from the M87x, the relay will revert to the default state. Assigning the digital outputs to indicate that a waveform record has been created must be performed by using the 70 Series Configurator. See Section 9 for information concerning output "Normally Open" and "Normally Closed" settings.

The indication of the status of a waveform record will persist until cleared, except for Recorder Active, which will reset when the recording is finished. Refer to the appropriate protocol manual for instructions.

5.4.1c Retrieving and Deleting Waveform Recorder Files

Waveform records may be retrieved and deleted from the instrument using the available communications protocols. Please refer to the specific protocol manual or section 5.5 (Zmodem and FTP) for details. A file cannot be deleted while being read by another device.

5.4.2 Disturbance Recorders

The M87x includes two individually configurable Disturbance Recorders. The most common method of triggering a disturbance event is by using the 70 Series Configurator to set an upper or lower threshold on one of the measurements. A disturbance record can also be initiated by a digital input or by a protocol-specific manual command. (See protocol manual for details on available commands.)

The Disturbance Recorder will archive samples of up to 64 user-selected measurements. Any measurement made by the device may be selected, allowing the user a great deal of flexibility in configuring the system. Additionally, the user may configure the Disturbance Recorder to calculate the min/max/avg of the selected measurements over the interval, or store only the present value at the end of the interval.

The number of disturbance records that can be stored is dependent on the number of measurements to record, the measurement type, and the number of pre- and post-trigger samples selected.



Please note how the convention for determining time resolution in oscillography records (WR1, WR2) in samples per cycle is not relevant to long-time disturbance records (DR2, DR2), where RMS values are plotted using a sample rate measured in an integer number of cycles for each sample.

If the number of cycles/sample is set to 1, each entry in the Disturbance Record will reflect data collected over one cycle. The factory default setting provides 20 samples of pre-trigger recording and 40 samples post-trigger. The pre- and post- trigger times are configurable by the user, as is the number of cycles per sample. The maximum pre-trigger time is 1800 samples, while the maximum post-trigger time is 300,000 samples. If additional triggers occur within the post-trigger period, the disturbance record will be extended by the selected number of post-trigger samples. Optionally, the user can choose to disable re-triggering. The default cycles/sample setting is 0, which disables the recorder.

The Disturbance Recorders shares storage space with the Waveform Recorder and the Trend Recorder. The 70 Series Configurator allows the user to select the maximum available memory for each recorder function, but any record files already made should be removed before reallocating the memory as mentioned above in the Waveform Recorder section.

Disturbance records are presented in industry standard (IEEE C37.111-1999) Comtrade files stored as compressed .zip files. Disturbance records may be retrieved and deleted from the instrument via a network and protocol (refer to the specific protocol manual for details), or by using the Host Module serial ports and Zmodem (Section 5.5.2).

5.4.2a Indicating Disturbance Records with Digital Outputs

Any of the outputs on the Digital Input / Output Module can be configured to indicate the status of the recorder. Recorder status includes: Recorder Started, Recorder Completed, Recorder Memory Low, and Recorder Active. When a waveform record is created, the assigned output relay will be energized. When an output relay is assigned to indicate the presence of a disturbance record, it can no longer be controlled via protocol commands. *If power is removed from the M87x, the relay will revert to the default state.* Assigning the digital outputs to indicate that a disturbance record has been created must be performed by using the 70 Series Configurator. See Section 9 for information concerning output "Normally Open" and "Normally Closed" settings.

The indication of the status of a waveform record will persist until cleared, except for Recorder Active, which will reset when the recording is finished. Refer to the appropriate protocol manual for instructions.

5.4.2b Retrieving and Deleting Disturbance Recorder Files

Disturbance records may be retrieved and deleted from the instrument using the available communications protocols. Please refer to the specific protocol manual or section 5.5 (Zmodem and FTP) for details. A file cannot be deleted while being read by another device.

5.4.3 Trend Recorder



The M87x stores the values of a user-configurable set of up to 230 parameters every log interval. The default setting of this interval is 0 minutes, which disables the Trend Recorder. This interval can be changed from 1 to 720 minutes (12 hrs.) in 1-minute increments. Once the log file has reached its maximum length, it will wrap around to the beginning and overwrite the oldest entries in the file. The log file is stored in non-volatile memory, allowing for retrieval of a complete log file even after power has been cycled to the instrument.

The user may select between recording the instantaneous values only, or storing the minimum, maximum, and average values recorded during the previous interval. The recorded values are based on measurements that are updated every cycle.

Trend Recording is always started at the closest time that is an integral multiple of the log interval.

Example:

If the trend interval is set to 15 minutes and the M87x system clock time is 9:18, the first entry will occur at 9:30. Subsequent entries will be made at 15-minute intervals. If the trend interval is changed to 5 minutes at 9:37, the next entry will occur at 9:40. Subsequent entries will occur at 5-minute intervals.

For intervals less than 60 minutes, it is recommended that the trend interval be set to a number that will evenly divide 60 minutes. If the interval is greater than 60 minutes, it should evenly divide 24 hours.

Recommended intervals:

1, 2, 3, 4, 5, 6, 10, 12, 15, 20, 30 minutes

1, 2, 3, 4, 6, 8, 12 hours

NOTE: If the System Clock setting (Section 3.1.3) is to be changed backwards, it is recommended that all trend recorder files be retrieved, the time changed, and the trend recorder file be deleted. If this is not done, the file will effectively contain a section that shows time going backwards! This will cause problems with the Comtrade file format.

5.4.3a Retrieving Trend Records

The trend file is stored on the unit in a proprietary data format. BiView or the Retriever program (supplied on the Utilities CD) is required to download & convert the raw trend file stored on the unit into an industry standard Comtrade file. When downloading the raw file via BiView or Retriever, the trend file on the unit will automatically be deleted; however both programs will preserve a copy of the raw trend file on the PC and append the new data every time the trend file is downloaded.

5.4.4 Comtrade Format

Waveform and Disturbance Records are available in Comtrade file format (C37.111-1999) and Trend Records can be converted into this format when retrieved using BiView or



Retriever software programs. These are user-selectable binary or ASCII format files. The files are stored as compressed .zip files to increase storage and decrease user download times. These files may be retrieved and deleted from the instrument using the available communications protocols. Please refer to the specific protocol manual or section 5.5 (Zmodem and FTP) for details. A file cannot be deleted while being read by another device.

The Waveform Recorder file "WR1_nnnn.CFG" or "WR2_nnnn.CFG" will contain the event parameters including the names of the channels, time of start of file, time of trigger, and sampling frequency for each cycle. The file "WR1_nnnn.DAT" or "WR2_nnnn.DAT" contains the time of each sample and the data. The data values are integers and can be scaled back to primary units using the scale factors in the .CFG file. The file name format, "WR1_nnnn.CFG" and "WR1_nnnn.DAT," indexes automatically from "WR1_0001.xxx" to "WR1_9999.xxx". Similarly, Waveform Recorder 2 files will be stored as "WR2_nnnn.CFG" and "WR2_nnnn.DAT".

Upon power-up (or re-boot), the M87x notes the highest index number in memory, and will increment by one for the next file. If there are no waveform records, the next one will be WR1_0001. If there is a WR1_0034 in memory upon re-boot, the next file will be WR1_0035. Note that if the stored files are deleted, but the M87x is not re-booted, it will continue to index in sequence as if the files were still there.

The Disturbance Recorder stores files in the same manner as the Waveform Recorder. Files from Disturbance Recorder 1 will be saved as "DR1_nnnn.CFG" and "DR1_nnnn.DAT," with the same indexing sequence as the waveform files. Similarly, Disturbance Recorder 2 files will be stored as "DR2_nnnn.CFG" and "DR2_nnnn.DAT".

The Trending file "TR1.CFG" will contain the event parameters, including the names of the channels, time of start of file, and trend interval for each measurement. The file "TR1.DAT" contains the time of each sample and the data. The data values are integers and can be scaled back to primary units using the scale factors in the .CFG file.

5.4.4a Comtrade ZIP Files

The .CFG and .DAT files are combined into a single .ZIP file, which is placed in the c:\DATA\ or e:\DATA directory (see section 5.5). This file may be retrieved using FTP, Zmodem, or protocol specific file transfer methods. Note that the .ZIP file may take up to 1 minute to appear in the c:\DATA\ directory after the records are created.

5.4.5 IEEE Long File Naming Convention

The 70 Series IEDs are capable of creating record files that meet the IEEE C37.232-2007 standard for file names. The long filename feature is enabled and configured on the Identity Page of the 70 Series Configurator. The Identity Page is shown below with factory default values. Settings relevant to long filename configuration are highlighted in green.



ntity	1.1.				
Identity					
Thes	se values may be unique for each	n installation and must be set correctly.			
Devic	e Identity	UCA			
Station Name	DI Name	Circuit ID Bus 1			
Device Description	DI Description	Circuit Phase A & B & C ▼			
Company Name / Owner	DI Owner	Domain Name UCADevice			
Location	DI Location	File PDU Size 1024 ÷			
☐ Enable	e C37.232-2007 file names				
Language	English (US)	TCP/IP Networking			
System Type	Dual Voltage ▼	IP 192 . 168 . 0 . 254			
Firmware Version	09.17.8	Subnet 255 . 255 . 255 . 0			
Hardware Version	M871 64MB 01.01.0	Router 192 . 168 . 0 . 1			
Serial Number	??????				
MAC Address	??-??-??-??				
OSI Networking					
NSAP 49 00 01 42 49 09 01 01					

When the long filename feature is enabled, the Disturbance Recorder and Waveform Recorder functions of the IED will create IEEE C37.232-2007 compatible names for all generated Comtrade files. Note, that in all cases the IED compresses and stores Comtrade files within a Zip file. Generation of Comtrade files for the Trend Recorder function is handled by the BiView software application. BiView retrieves the Trend Recorder data and the Identity configuration from the IED and then converts to a Comtrade file. BiView will use the long filename configuration obtained from the IED. IEEE C37.232-2007 defines the following disallowed characters: ? " / \< > * | : ; [] \$ % { } (i.e., question mark, quotation mark, forward slash, backward slash, less than, greater than, asterisk, pipe, colon, semi-colon, brackets, dollar sign, percent, and braces). The 70 Series Configurator permits the use of these characters on the Identity Page, but they will be replaced with an underscore (_) in the resulting long filename. Note, the use of periods (.) and commas (,) while permitted by IEEE C37.232-2007 and properly handled by the 70 Series Configurator, may produce unexpected results when interpreted by a third party software application.

IEEE C37.232- 2007 Field	Source	Notes
Start Date	Comtrade 'Start Time'	from CFG file
Start Time	Comtrade 'Start Date'	from CFG file
Time Code	Always zero	No time zone offset
Station ID	Identity page 'Station Name'	Limited to 32 characters
Device ID	Identity page 'Device Description'	Limited to 32 characters
Company Name	Identity page 'Company Name / Owner'	Limited to 32 characters

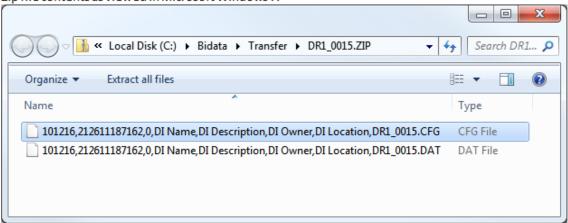


User 1	Identity page 'Location'	Limited to 64 characters
User 2	Original Zip file name	Such as DR1_0010 or WR2_0003
Extension	CFG or DAT	

Example long filename from Disturbance Recorder 1 using default configuration for fields:

101216,212611187162,0,DI Name,DI Description,DI Owner,DI Location,DR1_0015.CFG 101216,212611187162,0,DI Name,DI Description,DI Owner,DI Location,DR1 0015.DAT

Zip file contents as viewed in Microsoft Windows 7:



5.4.6 Voltage Fluctuation Table (VFT) File

The 70 Series IEDs are capable of creating a VFT file, which is used in conjunction with an external software package for monitoring Sags and Swells.

The raw data for each voltage channel is derived from 1 cycle RMS values that are updated each quarter cycle.

Each table contains one bus of voltages, phases A, B, & C

For units that have two buses of volts, two separate tables will be created. This currently includes M871, M571, M872 Breaker & a Half, and M572 Breaker & a Half.

Reference voltages will not be recorded in the table; therefore the M872 Dual Feeder & M572 Dual Feeder will only have 1 table.

The 70 series will maintain the minimum and maximum value for each voltage channel. When the voltage for a channel crosses a user configured threshold an entry will be made in the table. The user can configure up to 30 thresholds but a minimum of 3 thresholds must be configured. The default configuration for the thresholds are:

- 110% of Nominal
- 90% of Nominal
- 1% of Nominal

A fixed value of 1% of nominal will be used for the hysteresis. For Dips & Interruptions, the threshold is passed going down on the value the user



specifies. On the way up, the threshold is passed at the value \pm 1% nominal. For Swells, the threshold is passed going up on the value the user specifies. On the way down, the threshold is passed at the value \pm 1% nominal.

The Voltage Fluctuation Table consists of 2 files:.

- VFTn.DAT
- VFTn.INI

Where n is the number of the bus. Currently n may be 1 or 2.

The DAT file is a text file with one entry per line. Each data value is separated by a semicolon. The order of the data values is

- Entry Number
- Time Tag seconds
- Time Tag milliseconds
- Phase Code
- Minimum Value
- Maximum Value
- Current value, that has passed threshold
- Voltage Ratio
- Ratio Offset

An example of 1 line 1803;351009204;335;20001002;55.734;55.734;79.932;1.0;0.0

The DAT file will be allowed to grow to 100K. This will result in proximally 1700 entries.

Due to flash drive limitations, the M87x can only have a finite number of entries. To prevent the file from growing too large, and ensure the newest data is always available, the M87x overwrites the oldest entry as needed.

Because the DAT file will be circular it will have a virtual end of file marker, thus making it easy to see where the oldest entry is. The end of file marker will be "**** End of File ****" with out the quotes, and it will be on a line by itself.

A new "Voltage Fluctuation Thresholds" page in the 70 Series Configurator was created that allows the user to configure the Voltage Fluctuation Table. The user has the following options for each bus.

Enable/Disable the Voltage Fluctuation Table
Set the nominal voltage in primary units
Set the thresholds (can have 3-30 thresholds) entered in % of nominal

The files for the Voltage Fluctuation Table are available to download via Ethernet or Serial ports using BiView, Retriever, Internet Explorer, and HyperTerminal, Zmodem, FTP. The files are not available via Modbus File Transfer.

5.4.7 Sequence of Events (SOE) File



The M87x creates a record, in chronological order, of all events that occur, including:

Triggers
Health Check status errors
Change of state of status inputs and outputs
Creation of files
Change of configuration
Setting of clock
Record of Boot up

The SOE.LOG file is an ASCII text format file, and typically can be up to 5000 lines.

5.4.8 Sequence of Events Recorder (SER) File

In addition to the SOE file mentioned above, the M87x creates a SER log in .csv format for compliance with one portion of the NERC PRC-002-2 standard. Following is a summary of what is included:

- A. File Name: SERLOG.CSV
- B. File Type: comma separated variable (ASCII)
- C. The following single input types are automatically logged to the SERLOG.CSV file if the "Soe Entry" field is selected on the Recorder Triggers page:
 - 1. Digital Inputs
 - 2. Virtual Inputs
 - 3. GOOSE Inputs
- D. One log entry per line where each line is comprised of the following fields:
 - 1. line number
 - 2. date
 - 3. time (rounded to the nearest millisecond)
 - 4. local time code (currently unimplemented, always reads as zero)
 - 5. Substation name (populated with "Station Name" field on Identity page)
 - 6. Device name (populated with "User Defined Measurement Name" on the User Defined Measurement Names page. The Default Measurement Name will be used if no User defined name exists)
 - 7. State (populated with "SOE Message field" from the Triggers page associated with the specific trigger point. If no SOE Message is specified then the field will be populated with "0" for trigger with "value" field set to 0, and "1" for triggers with "value" field set to 1)

The following is an example of the contents of the SERLOG.CSV file:

```
1, 02/08/17, 09:54:13.166, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), 0
2, 02/08/17, 09:55:39.811, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), 1
3, 02/08/17, 09:55:42.638, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), 0
4, 02/08/17, 09:55:45.642, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), 1
5, 02/08/17, 09:55:46.402, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), 0
6, 02/08/17, 10:01:02.342, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), Close
7, 02/08/17, 10:19:50.882, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), ___Open___
8, 02/08/17, 10:19:53.798, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), Close
```



```
9, 02/08/17, 10:37:26.855, 0, Hinkson_Creek_substation, DIO#0 Input 1, Close
10, 02/08/17, 10:37:26.859, 0, Hinkson Creek substation, DIO#0 Input 2, 0
11, 02/08/17, 10:37:26.863, 0, Hinkson Creek substation, DIO#0 Input 3, 0
12, 02/08/17, 10:37:26.863, 0, Hinkson Creek substation, DIO#0 Input 4, 0
13, 02/08/17, 10:37:26.863, 0, Hinkson Creek substation, Breaker 5 (DIO 0 Input5), 0
14, 02/08/17, 10:37:26.876, 0, Hinkson_Creek_substation, Breaker 6 (DIO_0 Input6), 0
15, 02/08/17, 10:37:26.880, 0, Hinkson_Creek_substation, Breaker 7 (DIO_0 Input7), _OPEN_
16, 02/08/17, 10:37:26.880, 0, Hinkson_Creek_substation, Breaker 8 (DIO_0 Input8), 0
17, 02/08/17, 10:38:09.217, 0, Hinkson Creek substation, Breaker 6 (DIO 0 Input6), 1
18, 02/08/17, 10:38:09.256, 0, Hinkson Creek substation, Breaker 6 (DIO 0 Input6), 0
19, 02/08/17, 10:38:09.443, 0, Hinkson Creek substation, Breaker 6 (DIO 0 Input6), 1
20, 02/08/17, 10:38:09.577, 0, Hinkson_Creek_substation, Breaker 6 (DIO_0 Input6), 0
21, 02/08/17, 10:38:18.439, 0, Hinkson Creek substation, Breaker 5 (DIO 0 Input5), 1
22, 02/08/17, 10:38:18.523, 0, Hinkson_Creek_substation, Breaker 5 (DIO_0 Input5), 0
23, 02/08/17, 10:38:18.585, 0, Hinkson Creek substation, Breaker 5 (DIO 0 Input5), 1
24, 02/08/17, 10:38:18.586, 0, Hinkson_Creek_substation, Breaker 5 (DIO_0 Input5), 0
25, 02/08/17, 10:38:18.588, 0, Hinkson_Creek_substation, Breaker 5 (DIO_0 Input5), 1
26, 02/08/17, 10:38:18.590, 0, Hinkson_Creek_substation, Breaker 5 (DIO_0 Input5), 0
27, 02/08/17, 10:38:19.455, 0, Hinkson Creek substation, DIO#0 Input 2, 1
28, 02/08/17, 10:38:19.615, 0, Hinkson Creek substation, DIO#0 Input 2, 0
29, 02/08/17, 10:38:21.369, 0, Hinkson Creek substation, DIO#0 Input 2, 1
30, 02/08/17, 10:38:21.540, 0, Hinkson Creek substation, DIO#0 Input 2, 0
31, 02/08/17, 10:38:23.979, 0, Hinkson Creek substation, Breaker 7 (DIO 0 Input7), CLOSED
**** End of File ****
```

5.5 M87x File System

Files are stored in the M87x on internal drives labeled "c:" and "d:". In addition the host module contains optional compact flash memory which is accessible as drive "e:". Both FTP and Zmodem may be used to access any drive. Trend Recorder files are stored on the d: drive on the host module. All other user accessible files will be stored on the c: drive unless the unit is equipped with optional compact flash memory. In this case these files are stored on the e: drive. The following directories are relevant to the user.

Directory	Function
c:\config	Location of Configuration files
c:\upload	Location of restart.now file
c:\data or e:\data	Location of recorder compressed ZIP files
d:\data	Location of trend recorder files

5.5.1 FTP Server

The M87x incorporates an internet-compatible FTP (File Transfer Protocol) data server. This allows user access to any program or data file that exists on the M87x. It has the following primary uses:

- 1. Allows remote software updates to be written to the M87x.
- 2. Allows determination of the time of last software update.
- 3. Allows configuration ".INI" files to be written, copied, and deleted from the M87x.
- 4. Allows Comtrade files to be read and deleted from the M87x.

The M87x can support up to 50 simultaneous FTP connections.

5.5.1a Introduction to FTP



FTP protocol is a standard component of the Internet protocol suite and is used to transfer files between computer systems. Every Windows/Unix/Linux operating system contains an FTP Client program that allows simple access to FTP Servers such as the M87x. FTP is accessed from the command prompt (sometimes referred to as the DOS prompt). A (simplified) sample session appears on the screen as:

C:\windows> FTP 192.168.0.254

M87x server, enter user name: anonymous

Enter password: BITRONICS (Any password will work)

FTP> binary

Some Operating Systems default to ASCII mode for FTP. Entering "binary" ensures that the FTP connection will be in the binary mode necessary for communicating with the M87x.

As shown above, the user specifies the IP address of the server, enters a username and password, and then is presented with the FTP prompt awaiting commands. The following commands are useful for communicating with the M87x.

Command	Function
BINARY	Changes FTP to binary mode
CD	Change current directory to parent directory
CD directoryname	Change current directory to directyname
DELETE filename.ext	Delete file from Server
DIR filename.ext	List directory contents
GET source file destination file	Read file from M87x
PUT source file destination file	Write file to M87x
QUIT	Exit FTP server and return to command prompt

Refer to your local operating system documentation for more details.

5.5.1b M87x FTP Implementation

The M87x FTP server has three privilege levels that determine the allowed FTP operations.

Description	Username	Password
Read files within the C:\DATA directory	"anonymous" or "guest"	Any
Read files on any drive or directory	Drive\directory	Level 0
Read, Write, or Delete files on any drive or directory	Drive\directory	Level 2

Access to Levels 1 and 2 require the user to enter the starting (root) directory as the "User Name". For this purpose, the drive name is treated as a directory. The entire "c" drive would be accessed by entering a User Name of "c" and the appropriate password. Access to a subdirectory, for example the configuration files, is obtained by entering a User Name



of "c:config" and the password. Note that the FTP protocol does not allow access above the root directory.

The M87x will remotely restart if the file "c:\upload\restart.now" is written. Restart begins about 12 seconds after the file has been created.

It is recommended that FTP be operated in passive mode. The port numbers used are 20 and 21 (TCP).

Please consult customer service for information on using FTP for updating the M87x firmware or BIOS.

5.5.2 Zmodem, TELNET, and Command Line Interface

M87x files may be written, read, and deleted by use of Zmodem and the Host module front panel serial ports (Section 3.1.1). Using the 70 Series Configurator, make sure the serial port you wish to use is set to Zmodem. By default, ports P1 and P4 are set to Zmodem @ 9600 Baud (Section 3.1.1b). Connect a terminal, or the serial port of a PC running a terminal emulator program (such as HyperTerminalTM), to the serial port of the M87x configured for Zmodem. Make sure the terminal emulator is set-up to connect directly to the serial port of the PC, and that the baud rate matches that of the M87x port. Allowable commands are:



Service Port/Zmodem Commands			
c:	display off	receive	type
cd	exit	reset	trigger dr1
chp1	getlog	router	trigger dr2
chp2	Goose*	send	trigger wv1
d:	ip	serial	trigger wv2
date	mac	setlog	ver
del	nsap	software	vio point
dio point	password	status	whoami
dir	pulse	subnet	
display on	reboot	time	

Note: * This command is for UCA Goose only and is now referred to as GSSE.

- When connected to the M87x with a terminal emulator program, remember that the commands you type are operating on the M87x, not the PC. The terms "RECEIVE" and "SEND" are therefore from the perspective of the M87x.
- **NOTE 2:** The location of files to be sent to the M87x from the PC must be set in the terminal emulator program.
- **NOTE 3:** The RECEIVE command must be used before telling the terminal emulator program to transfer a file to the M87x.
- **NOTE 4:** Some terminal emulator programs cannot transfer more than one file using the "RECEIVE" command.
- **NOTE 5:** For a complete list of commands, type "help" at the command prompt. For help with a specific command, type "help" followed by the command (i.e. "help send").

5.6 Assigning Pulse Outputs to Energy Values

Any relay on the Digital Input/Output Module (Section 9) can be setup to operate as a pulse output, and assigned to any of the four energy values of Section 4.5. Assigning the digital outputs to perform a pulse-output function MUST be done by using the M87x Configurator program. See Section 9 for information concerning output "Normally Open" and "Normally Closed" settings. Additionally, Digital Outputs assigned to operate as a pulse output can be set for Energy per Pulse (in KWh/KVARh per pulse).

5.7 IRIG-B

5.7.1 Overview

There is a great need in many power measurement and power quality applications for synchronizing numerous instruments from various manufacturers to within fractions of a second. These applications include failure analysis, sequence of event recording, distributed fault recording, and other synchronized data analysis. One means of synchronizing various instruments to the same clock source is to connect them to a master time device that generates a standard time code. This scheme can be expanded upon



such that two devices half a world apart could be synchronized to within fractions of a second if each is connected to an accurate local time master.

There are several vendors who manufacturer these master time devices and there are many standardized time synchronization protocols. IRIG-B is one of the more commonly supported standard time code formats.

5.7.2 Introduction to IRIG Standards

IRIG (InteRange Instrumentation Group) standards consist of a family of serial pulse time clock standards. These standards were initially developed for use by the U.S. Government for ballistic missile testing. There are several Time Code Formats within the family such as A, B, E, G, and H. Each Time Code Format has its own unique bit rate.

There are sub-variations within each Time Code Format that specify the Format Designation, the Carrier/Resolution, and the Coded Expression formats. All standard IRIG serial time standards use the IRIG B000 configuration.

The first letter following IRIG specifies the Time Code Format and Rate Designation. The first number following the letter specifies the Format Designation, the second number specifies the Carrier/Resolution, and the third number specifies the Coded Expressions.

The M87x's IRIG interface recognizes and decodes the following standard IRIG formats: IRIG B000, IRIG B002, and IRIG B003. Additionally, IRIG B120 and IRIG123 formats are recognized when using the M87x Modulated IRIG-B Converter, part number M870-MODIRIGBCV, connected to one of the Host module serial ports, P2, P3 or P4.

5.7.2a Time Code Format (Rate Generation)

There are six different IRIG Time Code Formats. The M87x supports Time Code Format B. Time Code Format B specifies a 100-bit frame and a 1 second time frame (10 milliseconds per bit). The 100 bits consist of:

- 1 time reference bit,
- 7 BCD bits of seconds information,
- 7 BCD bits of minutes information,
- 6 BCD bits of hours information.
- 10 BCD bits of days information,
- 27 optional control bits.
- 17 straight binary bits representing seconds of day information
- 15 index bits
- 10 position identifier bits

5.7.2b Format Designation

There are two IRIG Format Designations:

- 0 Pulse Width Coded
- 1 Sine Wave, Amplitude Modulated.

The Pulse Width Coded format is essentially the envelope of the Amplitude Modulated format. The M87x supports the Pulse Width Coded format. The M87x Modulated IRIG-B



Converter, part number M870-MODIRIGBCV, is necessary when connecting an IRIG-B signal of Amplitude Modulated format to one of the serial ports, P2, P3, or P4, on the M87x.

5.7.2c Carrier/Resolution

There are six IRIG Carrier/Resolutions:

- 0 No Carrier/Index Count Interval
- 1 100 Hz/10 ms
- 2 1 kHz/1 ms
- 3 10 kHz/0.1 ms
- 4 100 kHz/10 us
- 5 1 MHz/1 μs

Since the M87x does not support the Sine Wave Amplitude Modulated Format Designation, only the No Carrier/Index Count IRIG Carrier/Resolution is applicable, when connected to an IRIG-B master using Pulse Width Coded Format. The M87x Modulated IRIG-B Converter serves as the signal demodulator, essentially converting from sine wave modulated into pulse width coded format.

5.7.2d Coded Expressions

There are four IRIG Coded Expressions:

- 0 BCD, CF, SBS
- 1 BCD, CF
- 2 BCD
- 3 BCD, SBS

The M87x only uses the BCD portion of the expression and as a result can accept any of the standard IRIG Coded Expressions.

5.7.3 M87x IRIG-B Implementation

The M87x receives the IRIG-B serial pulse code via the serial ports on the Host CPU module (Section 3.1.1). The IRIG-B signal is decoded by the Host CPU module, and the resulting IRIG time is compared to the M87x's time. The M87x processes the time errors and corrects its local time to coincide with the IRIG time.

5.7.3a M87x IRIG-B Receiver

As previously mentioned, the M87x receives the IRIG-B signal via the standard serial ports located on the Host CPU's front panel (Section 3.1.1). Port P2, P3, or P4 can be configured to accept IRIG-B. The ports can be configured via the 70 Series Configurator software utility.

5.7.3b M87x IRIG-B Decoder

The M87x IRIG Decoder parses the bit stream from the IRIG Receiver into registers that represent the number of days, minutes, and seconds since the beginning of the present



year. The control bits and straight binary seconds portion of the IRIG pulse stream are ignored. The M87x transducer compares its present time to the IRIG time and stores the delta time error. These errors are calculated every IRIG frame (every second) and are accumulated into a sample buffer until the sample buffer is full. Once the buffer is full, the buffer is passed to the IRIG Time Qualifier.

5.7.3c M87x IRIG-B Time Qualifier

The M87x IRIG-B Time Qualifier processes the sample buffer of time errors from the IRIG-B Decoder. If the IRIG-B Time Qualifier detects several sequential time errors greater than 3 seconds, the IRIG-B Time Qualifier forces the M87x to immediately "jam" its clock to the present IRIG-B time.

If the time errors are less than 3 seconds, the IRIG-B Time Qualifier examines all the errors in the sample buffer. The error data is subjected to various proprietary criteria to determine an accurate time offset. If the sample buffer does not meet the qualifying criteria the sample buffer is discarded and no clock correction is performed. The IRIG-B Time Qualifier continues to examine and discard sample buffers from the IRIG-B Decoder until it finds one that meets the accuracy qualifications.

Once a sample buffer is qualified, the IRIG-B Time Qualifier calculates a clock correction value and slews the M87x's clock to match the IRIG-B time. The slew time depends on the magnitude of the clock correction. The time required to slew the M87x's clock to match the IRIG time is approximately 30 times the clock correction value.

Slewing the clock ensures that time always moves forward. The clock may speed up or slow down to attain proper synchronization, but it never moves backward. This ensures that the ordering of events is always preserved while changing the clock. Ordering of events cannot be guaranteed when the clock is jammed.

The IRIG-B Decoder does not sample the IRIG bit stream and build a sample buffer while the M87x clock is slewing. All IRIG frames received during the M87x's clock slew are ignored until the slew has completed.

5.7.4 Determining the Correct Year

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The IRIG-B standard provides days of year, minutes of day, and seconds of minute information. The IRIG standard does not provide any year information. IEEE-1344 specifies a bit pattern that is encoded into the IRIG control bit steam that specifies year information. The M87x IRIG driver is capable of decoding the IEEE-1344 year information from the control bits when connected to an IEEE-1344 compatible IRIG master. If the IRIG master that is connected to the M87x is not IEEE-1344 compatible, the IEEE-1344 compatibility configuration switch in the M87x COM port configuration should be turned off. This will prevent the M87x from incorrectly interpreting the control bits as year information.

If the IRIG master is not IEEE-1344 compatible, the M87x assumes that the year stored in its non-volatile capacitor backed-up clock is correct. If the M87x back-up clock fails or the M87x's year is incorrectly set, the IRIG-B Driver will assume that the year is the year reported by the M87x's clock.



If the M87x is connected to an IRIG master that is not IEEE-1344 compatible and the year reported by the M87x's clock is incorrect, the IRIG Driver may also set the M87x's day incorrectly (due to leap year) when it tries to synchronize the device time to the IRIG time. The time, however, will still synchronize correctly. As a result, if the M87x's backup fails (or the year was not set correctly), any data time-stamped by the M87x or any waveform captures stored may have the wrong year and day but will have the correct time accurate to several microseconds. This data can still be synchronized to other events from other devices by simply adding the correct day and year offsets to the time.

5.7.5 Methods of Automatic Clock Adjustments

The automated clock adjustments controlled by the IRIG interface include "jamming" the clock and "slewing" the clock. Depending on the magnitude of the M87x's absolute clock error the clock adjustment algorithms will either jam the clock by directly writing a new value into the clock registers or slew the clock smoothly by adding or subtracting small adjustments to the clock registers over a period of time.

5.7.6 Types of M87x Clock Synchronization

There are various degrees (or states) of time synchronization. Upon power up, the device relies on the value stored in the capacitor backed-up clock to set the correct time, and the crystal frequency correction constant stored in non-volatile memory to correct the crystal's frequency. The M87x will keep time starting from the values read from the clock. There will be an accumulated time error based upon the frequency error of the Real Time Clock crystal. The crystal frequency correction constant provides a means for correcting for this error. If the M87x was never synchronized to an external source (i.e. IRIG-B or network synchronization protocol), the M87x will not have a value for the crystal frequency correction constant and the crystal error will be the M87x's clock error.

5.7.6a Frequency Adjustments and Free Wheeling

The M87x has the capability to add a correction factor to compensate for the crystal's effective frequency error rate. This frequency adjustment is accomplished by first determining the crystal's error rate and then correcting the clock to reflect that error. The IRIG-B interface serves as an external accurate time source to determine the crystal's typical error rate. The frequency error is calculated and stored in non-volatile memory on the M87x's Host CPU board.

When an M87x is connected to an IRIG-B source, it will automatically calculate and store the crystal's error in non-volatile memory on the Host CPU board. M87x transducers utilize this constant to maintain a more accurate clock. If the IRIG-B source is removed the M87x will no longer receive time corrections from the IRIG-B source, but the device clock will keep much better time due to the frequency correction constant. This mode of operation is referred to as "Free Wheeling."

Although "Free Wheeling" with constant frequency compensation provides a more accurate M87x clock, it will still drift and is less accurate than having a constant IRIG-B source connected to the M87x. The frequency error of the crystal will change with time and temperature. Having a permanent real time IRIG-B clock source allows for constant minute adjustments to the M87x clock.

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5.7.6b Permanent IRIG-B Source Connection

Having a permanently connected IRIG-B source provides the most accurate M87x clock. In addition to correcting the frequency for the crystal error, the M87x will constantly receive corrections to compensate for any drift that may still occur. This provides for a typical clock error of less than 10 microseconds.

5.7.7 Stages of IRIG-B Synchronization and Accuracy

There are four basic stages of synchronization with an IRIG-B source: power-up, time lock, frequency lock, and final lock.

5.7.7a Power-Up Stage

Upon Power-up, the M87x obtains the time from its non-volatile capacitor backed-up clock. This clocks resolution is limited to seconds. Therefore, even if the clock was error free when it was turned off, the M87x could have an error of up to one second when it is powered-up. The typical crystal error rate is about 20 microseconds per second (20ppm). Therefore, if we assume that the M87x clock was keeping perfect time before it was reset (or powered down), it would typically be in error by:

(20 microseconds) x (number of seconds off) + 0.5 seconds after power is restored.

The M87x would start with this error and continue to drift by the frequency offset error. If the M87x were never connected to an IRIG-B source (or other clock synchronizing source), the drift would be equal to the crystal's frequency error. If the M87x previously stored a frequency correction constant in non-volatile memory, the device will include the compensation and drift by a smaller amount equal to the true crystal frequency error minus the correction constant.

5.7.7b Time Lock Stage

Once the M87x begins to receive IRIG-B frames, validates a sample buffer, and calculates a clock correction value, it will enter the Time Lock Stage of synchronization. If the clock correction value exceeds 120 seconds, the clock is jammed with the present IRIG-B time. Otherwise, the M87x clock is slewed to match the IRIG-B time.

The accuracy of this initial slew depends on whether a frequency correction constant was previously stored in non-volatile memory, and if so how accurate the constant is. The M87x will use this constant in the slew calculation to approximate the rate to change the clock to adjust to the specified IRIG-B correction error.

The M87x will remain in the Time Lock Stage for approximately five minutes plus the time required to perform the initial clock slew. The clock slew requires approximately 30 times the clock correction value. For example, if the initial clock correction error was 1.5 seconds, the Time Lock Stage would require approximately 6 minutes (5 minutes plus 45 seconds to slew).



The M87x enters the Frequency Lock Mode after completing the first IRIG-B clock correction. The M87x's clock is typically synchronized to within 1 millisecond of the true IRIG-B time after the Time Lock Stage is completed.

5.7.7c Frequency Lock Stage

The M87x enters the Frequency Lock Stage of synchronization when it receives the third valid clock correction value from the IRIG-B interface. At this time the M87x calculates a crystal frequency correction constant based on the clock correction value. The crystal frequency correction constant is stored in non-volatile memory to provide improved clock accuracy during "Free Wheeling". The crystal frequency correction constant along with the clock correction value is used to slew the clock to synchronize to the IRIG-B source.

The Frequency Lock Stage requires approximately five minutes. Once the M87x slews its clock with the correct crystal frequency correction constant, the M87x's clock is typically synchronized to within 50 microseconds of the IRIG-B time source. The M87x then enters the Final Lock Stage of synchronization.

5.7.7d Final Lock Stage

In the Final Lock Stage of synchronization, the M87x typically receives clock correction values from the IRIG-B interface every five minutes. The M87x continues to make slight adjustments to its crystal frequency correction constant to accommodate for small frequency drifts due to age and temperature. At this point, the M87x clock is typically synchronized to within less than 10 microseconds of the IRIG-B source.

5.7.8 Notes On Operation

- 1. A new crystal frequency correction constant will be written to non-volatile memory every four hours while a valid IRIG-B connection exists.
- 2. The capacitor backed-up clock will be corrected every hour while a valid IRIG-B connection exists.
- 3. Network Time Synchronization requests are refused while a valid IRIG-B connection exists.

5.7.9 IRIG-B Electrical Specifications

Absolute Maximum Input Voltage: -25 Volts to +25 Volts

Receiver Input Threshold Low: 0.8 Volts (min) Receiver Input Threshold High: 2.4 Volts (max) Receiver Input Hysteresis: 0.6 Volts (typical) Receiver Input Resistance: $5 k\Omega$ (typical)

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5.7.10 IRIG-B Port Wiring Instructions (Pulse Width Coded, IRIG-B master, Demodulated)

The IRIG-B master can be connected to Ports P2, P3, or P4 of the M87x's Host CPU module when IRIG-B signals of format IRIG B000, IRIG B001, or IRIG B003 are used. The



selected Port must be configured for IRIG-B via the 70 Series Configurator software utility. To connect the IRIG-B master to a Port (Figure 3, pg. 22):

- Connect the IRIG-B signal to terminals 2 and 4.
- Connect the IRIG-B signal common to terminal 6.
- Terminal 5 provides a connection to earth ground via a 100Ω resistor for shielding.

5.7.11 Modulated IRIG-B

The M87x may be used with Modulated IRIG-B systems, provided that the external Modulated IRIG-B adapter is used (P/N M870-MODIRIGBCV)

5.7.12 Setup Instructions for Use of the M87x Modulated IRIG-B Converter (Sine Wave, Amplitude Modulated, IRIG-B master)

The M87x Modulated IRIG-B Converter is a demodulating adapter used with the M87x Host module for connection from an IRIG-B master that uses an amplitude-modulated sine wave, and meets one of the input formats specified below. The setup required in order to use the M87x Modulated IRIG-B Converter is described by the following information, which includes the Converter specifications:

Input impedance: $>10K\Omega$

Input Format: IRIG-B120, B123,

1kHz modulated sine wave, amplitude 3Vpp – 10Vpp,

modulation ratio 3:1

Power: Supplied by M87x serial port

Time skew: 600 µsec.

Use: Plug Converter into M87x serial port (P2, P3, or P4).

Fasten Converter to the M87x by tightening 2 hold down screws.

The recommended torque rating is 2.2 In-Lbs, 0.25 N-m.

Connect BNC to clock source.

Configuration: On the "Port Assignment" page (previously "serial port" tab) set the

appropriate port to IRIG-B.

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On the IRIG-B page set the Absolute Time Offset to 620 usec. (This

offset value includes the 600 µsec time skew attributed to the

converter). The number used for the Absolute Time Offset may need to be increased, depending on time skew contributed by clock source and cable lengths. The remaining items on the IRIG-B page can initially be left at the default values. If there are problems with acquiring synchronization with the IRIG-B source, turning on the debug messages may help in diagnosing the problem. (Refer to section 3.1.1a; Debug messages are turned on when service port P1 is running in logging mode). Depending on the installation it may be necessary to relax some of the qualifying parameters to achieve

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synchronization. If necessary, first increase the Max Skew setting from 5 μ sec to 8 – 10 μ sec. If this does not help it may be necessary to reduce the Quality Factor from 0.7 to 0.5 or less.

5.8 Time Sync & Setting

The 70 Series IED utilizes an on-board clock to time stamp communications, SOE Log entries, and data samples in the Waveform, Disturbance, and Trend Recorders. A variety of external references may be used to synchronize the on-board clock to either local or Universal Coordinated Time (UTC) with a high degree of accuracy.

5.8.1 Time Sync Status Registers

Pre-defined status registers indicate the current state for each of the various time synchronization methods used in 70 Series IEDs

The following time sync registers will return status values of '0' if a time sync master is inactive and '1' if a time sync master is active:

Status Registers
IrigB Time Sync
Network Time sync (UCA)
SNTP Time Sync
DNP Time Sync

The 70 Series DNP and Modbus manuals define the status register locations within Appendix B for these time sync status points.

5.8.2 Manual time setting by Command-Line instruction

The command-line instruction is the manual method for setting the IED clock through service port P1. The "time" instruction in the command-line interface is used to set time for the IED's internal clock. Refer to section 3.1.1a in order to set the IED clock.

5.8.3 Unsolicited DNP Time set (DNP master sets the IED clock)

DNP Time set is supported by the 70 Series IED. The IED clock simply free-wheels at its characteristic rate between DNP time updates. Each DNP set-time instruction simply "sets" the clock as it is received. Setting the clock via DNP supersedes any other time-sync method that might be in use.

5.8.4 IRIG-B Time sync (time-synchronization via dedicated IED port)

Detailed information on IRIG-B time sync can be found starting in section 5.7. IRIG-B is expected to produce the greatest accuracy relative to other time sync methods currently supported. A status bit, named 'IrigB Time Sync', is set to indicate the IED is being synchronized via IRIG-B as long as the IED continues to receive valid IRIG updates. While this bit is set, time-sync signals received from (*UCA*) Network Time Sync, SNTP,



and Requested DNP are ignored.

It should be noted that the IED host is not able to distinguish between the Modulated and Unmodulated IRIG-B signals applied to the input port. Demodulation is accomplished by a dedicated circuit. The host processor makes no determination as to which type of external IRIG-B signal is applied. Unmodulated IRIG-B would provide a slightly more accurate time signal then Modulated IRIG-B, due to additional time latency that is introduced in the demodulation process.

5.8.5 (UCA) Network Time Synchronization - time synchronization over Ethernet

The M87x real-time clock may be synchronized to a UCA network time-sync master. The network time sync functions as described in IEEE TR-1550 Part 2 Appendix B and is roughly analogous to the IRIG-B described in Section 5.6, in that the M87x continually "trains" it's internal clock to eliminate errors. An algorithm progressively adjusts the onboard clock to improve its accuracy with subsequent time updates received from the master. This allows the M87x to "Free Wheel" accurately in the event the UCA network time-sync master is unavailable.

5.8.6 SNTP (Simple Network Time Protocol) - time synchronization over Ethernet

Time synchronization is supported using SNTP (Simple Network Time Protocol); this protocol is used to synchronize the internal real time clock in substation devices, (i.e., control systems, relays, IEDs). Up to 2 SNTP servers, using optional many-cast (or any-cast) mode of operation, are supported, along with configurable polling times. SNTP servers can be polled for configurable time, but only one at a time.

The SNTP page in 70 the Series Configurator software tool allows the user the option of selecting which tool will be used to load the SNTP (and IP) settings. Radio buttons are provided for that purpose. SNTP (and IP) settings can be loaded from either the 70Series Configurator (INI file) or the IEC61850 IED Configurator (MCL file). When using the 70Series Configurator, the initial default configuration will load SNTP settings from the 70Series Configurator (INI file). If IEC61850 protocol is used, it is possible for the user to change the radio button selected in order to indicate that the IEC61850 IED Configurator (MCL file) be used to load these settings instead. If the settings on the 70Series Configurator SNTP page grey out, it is an indication that the SNTP server addresses may have been set through the other Configurator's software.

Additionally on the SNTP page of the 70 Series Configurator software, the user may specify that an offset from the SNTP server time be applied when synchronizing. A common use for this feature is to allow the 70 Series device to operate in local time when synchronizing with an SNTP server operating in UTC time. To further support local time, the application of Daylight Savings adjustments may also be configured.

5.8.7 DNP Time sync (slave requesting DNP time be set)

A slave may request that DNP time be set in order to have the DNP master set the DNP time.



5.9 Using the M87x with a Bitronics Analog Output Converter

The M87x may be used with any of the Bitronics AOC units (NAO8101, NAO8102, NAO8103, or NAO8104). The AOC may be connected to any of the three Host Serial Ports P2, P3, or P4 (Section 3.1.1). The serial port must be configured for the appropriate protocol and register set for the AOC that will be connected. Setting up the serial ports is accomplished by using the M87x Configurator. AOC units will only function with the M871 configured for the Bitronics Legacy register set. When using AOCs that communicate via Modbus (NAO8101 and NAO8103) the M87x COM port must be set for an RxD to TxD Delay of 10ms for proper operation. A separate AOC may be connected on each serial port. Serial port and connection information is shown in Figures 3 and 4 (pg. 22-24). As stated previously, the AOC address must match the protocol address assigned to the M87x communications port.

Protocol	Baud	Parity	Media
DNP	9600	NONE	RS485
Modbus	9600	EVEN	RS485

5.10 Automatic Event Notification

The 70 Series is capable of sending an Automatic Notification via email, or over a serial port. The action of automatic notification may be selected in response to any of the available triggers, similar to triggering a recording or activating an output contact. The type of notification (email or serial) is selected in the "Automatic Notification settings" page of the Configurator.

5.10.1 Email Notifications

A valid SMTP (email) server IP address must be entered. This server must exist on the local network in order for emails to be sent. Email addresses can then be entered for up to 3 users.

5.10.2 Serial Notifications

The 70 Series can be configured to send text strings out a serial port P2 or P3. These text strings can be used for various purposes, including operating a modem. This could be used to send a page to a numeric pager, for example.

5.10.3 Data Sent

The 70 Series meter will send the user-configured string out the specified COM port. It is the user's responsibility to ensure the string is properly formatted to communicate through any port switches, modem switches, and/or modems. The user is also responsible for ensuring the string specified is meaningful to the user or device that will be receiving it.

If the 70 Series meter is not configured to have a COM port send notifications, then no serial notifications will be sent.

If the 70 Series meter has multiple COM ports configured to send notifications, then the



notifications will be sent out each port configured for notifications.

5.10.4 Error Recovery

There is no provision to confirm that a message has been successfully transmitted to an end user or device. There may be a busy signal, an answering machine may take the call, or another device may be using the phone line.

5.10.5 Example

Here is an example of a string that can be configured to send the numeric message 123 to a pager with the phone # 610-555-1212, and then hang up:

ATDT6105551212,,,,,,,123,,,,ATH<cr>

Note that it is typically important to enter the <cr> (carriage return character) for the string to be properly recognized by the modem. Information on modem control characters is available from your modem manufacturer.

5.10.6 Control Characters

Control characters can be entered in the Configurator by typing "\x" followed by the hexadecimal representation of the ASCII code for the desired character. For example, the control-Z character is represented by a hexadecimal 1A; therefore, "\x1a" should be entered into the serial data string where a control-Z is desired.

If the characters "\x" are desired to appear in the serial data string rather than a control character, then this special sequence can be escaped by entering "\x". The characters "\x" will appear in the serial data string.

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6.0 POWER SUPPLY V10



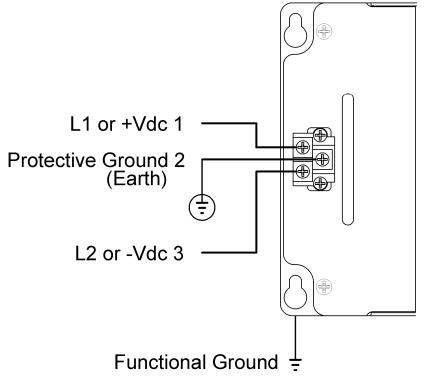


Figure 8 - Power Supply Connections

6.1 Introduction

The V10 power supply can operate from any voltage between 20-300Vdc or 55-275Vac (45-65Hz). It is therefore possible to power the M87x with AC or DC station power or an auxiliary VT, provided the voltage remains above 55Vac or 20Vdc. The power supply creates 3.3V, 5V, and +/-12Vdc outputs and consists of an isolated flyback converter that provides at least 12.5W of output power at 3.3Vdc and/or 5Vdc.

6.2 Features

- □ 25W minimum output power from the combined 5V and 3.3V supplies.
- □ +/-12Vdc capable of delivering up to 500mA.
- Standard cPCI power connector.
- Removable terminal block accepts bare wire or terminal lugs.
- □ 5Vdc and 3.3Vdc power indicator LEDs.

6.3 Specifications

Input (Auxiliary) Voltage

Nominal: 24-250Vdc, 69-240Vac (50/60Hz)

Operating Range: 20-300Vdc, 55-275Vac (45-65Hz)

Output Voltage: 3.3Vdc, 5Vdc, and +/-12Vdc



Maximum Output Power and Current (5V and 3.3V supplies are independent):

Nominal	Max Output Power		Max Output Power Max Output Current		Min Interruption Ride-Through*	
Vin	3.3V	5V	Total	3.3V	5V	ms
24Vdc	12.5W	12.5W	25W	3.75A	2.5A	2.5ms
48Vdc	17.5W	17.5W	35W	5.3A	3.5A	6.5ms
69Vac	17.5W	17.5W	35W	5.3A	3.5A	10ms
125Vdc	17.5W	17.5W	35W	5.3A	3.5A	35ms
120Vac	17.5W	17.5W	35W	5.3A	3.5A	50ms
250Vdc	17.5W	17.5W	35W	5.3A	3.5A	140ms
230Vac	12.5W	12.5W	25W	3.75A	2.5A	220ms
240Vac	12.5W	12.5W	25W	3.75A	2.5A	230ms

^{*} M871 -V10 -S10 -H10 -A10 -P11 -P30 (all relays energized)

The +12Vdc output is derived from the 3.3Vdc output, and the -12Vdc output is derived from the 5Vdc output. The +/- 12Vdc outputs are capable of providing up to 500mA, however, they must be de-rated to avoid exceeding the maximum power limits of the 3.3Vdc and 5Vdc outputs respectively.

6.3.1 Environmental

Operating Temperature: -40C to 70C

Relative Humidity: 0-95% non-condensing

Installation Category: IC III (Distribution Level), Pollution Degree 2. Refer to definition

on page 9.

6.3.2 Physical

Input Connections: Removable terminal block accepts #26-12 AWG (0,15-3,3mm²)

wire, or terminal lugs up to 0.325" (8,25mm) wide. Recommended minimum wire size is #18 AWG (0,5 mm²). Recommended Torque Rating for the terminal block wire fasteners is 10 In-Lbs, 1.13N-m. Precautions must be taken to prevent shorting of lugs at the terminal block. A minimum distance of 0.1" (2.5mm) is recommended between un-insulated lugs to maintain insulation requirements. Standard 0.200" (5,08mm) header socket accepts other standard terminal types.

Backplane Connections: Standard cPCI-specified power connector





6.4 Power Supply and Protective Ground (Earth) Connections

Power and chassis ground is applied to three screws on a barrier strip on the front of the Power Supply input module. **Connection of the chassis ground is required (see Section 2.3)**. There are two chassis ground points that **MUST** be connected to Earth Ground. One is the Protective Ground (Earth) terminal (terminal 2) on the Power Supply input, and the other is the mounting flange. Bitronics LLC recommends that all grounding be performed in accordance with ANSI/IEEE C57.13.3-1983.



6.5 Overcurrent Protection

To maintain the safety features of this product, a 3 Ampere time delay (T) fuse must be connected in series with the ungrounded/non-earthed (hot) side of the supply input prior to installation. The fuse must carry a voltage rating appropriate for the power system on which it is to be used. A 3 Ampere slow blow UL Listed fuse in an appropriate fuse holder should be used in order to maintain any UL product approval.



6.6 Supply/Mains Disconnect

Equipment shall be provided with a Supply/Mains Disconnect that can be actuated by the operator and simultaneously open both sides of the mains input line. The Disconnect should be UL Recognized in order to maintain any UL product approval. **The Disconnect should be acceptable for the application and adequately rated for the equipment.**



7.0 SIGNAL INPUT MODULE S10 - S12, S1C (M871), S13 - S17, S2C (M872)

7.1 Introduction

The Signal Input Module provides the terminal blocks, current transformers, and voltage input dividers for the signals to be measured. Compensation for normal variations in input circuits is achieved by storing calibration constants in non-volatile memory (EEPROM), which resides on the Signal Input Board. These constants are factory-programmed to provide identical signal gain (attenuation) in each of the 14 signal input paths. Checksums are incorporated into the EEPROM, which are read periodically by the microcontroller to check the integrity of the calibration constants.

7.2 Features

- □ Utility-grade current input terminal block with 10-32 studs (M871) or 8-32 screws (M872)
- □ Current shunts are #12 AWG SIS, 600V wire, crimped ring-lugs with brazed seams
- Options for split-core CTs (external)
- □ Voltage measurements to 424V rms line-to-neutral (730V rms line-to-line)
- \Box 7kV, 7.5M Ω input resistors on voltage inputs.
- Removable voltage input terminal block accepts bare wire or terminal lugs.
- Non-volatile memory backup of CT/VT calibration data



7.3 Specifications

		Input Signals (S10, S11, S12, S1C)				
CT Current	Configuration	4 Inputs. 3 Phase Currents and 1 Neutral.				
Inputs (S10)	Nominal	5Aac				
	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.				
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.				
	Isolation	2500Vac, minimum.				
	Burden	0.04VA @ 5A rms, 60Hz (0.0016Ω @ 60Hz).				
	Frequency	15-70Hz				
CT Current	Configuration	4 Inputs. 3 Phase Currents and 1 Neutral.				
Inputs (S11)	Nominal	1Aac/5Aac				
	Peak Current	Linear to 20A symmetrical (28A peak) at all rated temperatures.				
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.				
	Isolation	2500Vac, minimum.				
	Burden	0.0016VA @ 1A rms, 60Hz (0.0016Ω @ 60Hz)/0.04VA @ 5A rms, 60Hz.				
	Frequency	15-70Hz				
CT Current	Configuration	4 Inputs. 3 Phase Currents and 1 Neutral.				
Inputs (S12)	Nominal	1Aac				
	Peak Current	Linear to 4A symmetrical (5.7A peak) at all rated temperatures.				
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.				
	Isolation	2500Vac, minimum.				
	Burden	0.0016VA @ 1Arms, 60Hz (0.0016Ω @ 60Hz).				
	Frequency	15-70Hz				
CT Current	Configuration	3 Inputs, 3 Phase Currents, or 4 Inputs, 3 Phase Currents and 1 Neutral Current				
Inputs (S1C)	Nominal	5Aac				
	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.				
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.				
	Isolation	2500Vac, minimum.				
	Burden	Not applicable				
	Frequency	15-70Hz				



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		Input Signals (S10, S11, S12, S1C)
VT (PT) AC	Configuration	8 Inputs, Measures 2 Buses, 3 or 4 Wire.
Voltage Inputs	Nominal	120Vac
(S10, S11, S12) Terminals 9 to 16	System Voltage	Intended for use on nominal system voltages up to 480V rms phase-to-phase (277V rms phase-to-neutral).
9 10 16	Peak Voltage	Reads to 600V peak (425V rms), input-to-case (ground)
	Impedance	>7.5MΩ, input-to-case (ground)
(cont'd)	Voltage Withstand	2.5kV rms 1min, input-to-case (ground) 2kV rms 1min, input-to-input
	Frequency	15-70Hz
AUX	Configuration	2 Inputs: VAX1 & VAX2
Measurement	Nominal	125Vdc / 120Vac
Voltage Inputs (S10, S11, S12) Terminals 17 & 18		Intended for use on nominal AC system voltages up to 480V rms phase-to-phase (277V rms phase-to-neutral), and DC system voltages up to 250Vdc.
	Peak Voltage	Reads to 600V peak (425V rms), input-to-case (ground)
	Impedance	>7.5MΩ, input-to-case (ground)
		2.5kV rms 1min, input-to-case (ground) 2kV rms 1min, input-to-input
	Frequency	DC-70Hz

Input Signals (S13, S14, S15, S16, S17, S2C)			
CT Current Inputs (S13)	Configuration	6 Inputs. 2 sets of 3 Phase Currents	
	Nominal	5Aac	
	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.	
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.	
	Isolation	2500Vac, minimum.	
	Burden	0.04VA @ 5A rms, 60Hz (0.0016Ω @ 60Hz).	
	Frequency	15-70Hz	
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents	

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		Input Signals (S13, S14, S15, S16, S17, S2C)
Inputs (S14)	Nominal	1Aac/5Aac
	Peak Current	Linear to 20A symmetrical (28A peak) at all rated temperatures.
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.0016VA @ 1A rms, 60Hz (0.0016Ω @ 60Hz)/0.04VA @ 5A rms, 60Hz.
	Frequency	15-70Hz
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents
Inputs (S15)	Nominal	1Aac
	Peak Current	Linear to 4A symmetrical (5.7A peak) at all rated temperatures.
	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.0016VA @ 1Arms, 60Hz (0.0016Ω @ 60Hz).
	Frequency	15-70Hz
CT Current	Configuration	6 Inputs. 3 Phase Currents from 2 Lines with different peak current ranges.
Inputs (S16)	Nominal	5Aac
M872 with dual peak ranges	Peak Current	Linear to 20A symmetrical (28A peak)/linear to 100A symmetrical (141A peak) at all rated temperatures.
20A/100A	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.04VA @ 5A rms, 60Hz (0.0016ohms @ 60Hz).
	Frequency	15-70Hz
CT Current	Configuration	6 Inputs. 3 Phase Currents from 2 Lines with different peak current ranges.
Inputs (S17)	Nominal	1Aac
M872 with dual peak ranges	Peak Current	Linear to 4A symmetrical (5.7A peak)/linear to 20A symmetrical (28A peak at all rated temperatures.
4A/20A	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	0.0016VA @ 1Arms, 60Hz (0.0016ohms @ 60Hz).



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		Input Signals (S13, S14, S15, S16, S17, S2C)
	Configuration	6 Inputs. 3 Phase Currents from 2 Lines with different peak current ranges.
CT Current	Configuration	6 Inputs. 2 sets of 3 Phase Currents
Inputs (S2C);	Nominal	5Aac
External, Split Core	Peak Current	Linear to 100A symmetrical (141A peak) at all rated temperatures.
0010	Overload	30Aac continuous. Withstands 400Aac for 2 seconds.
	Isolation	2500Vac, minimum.
	Burden	Not applicable
	Frequency	15-70Hz
VT (PT) AC	Configuration	8 Inputs, Measures 2 Buses, 3 or 4 Wire.
Voltage Inputs	Nominal	120Vac
(\$13, \$14, \$15, \$16, \$17) Terminals 9 to 16	System Voltage	Intended for use on nominal system voltages up to 480V rms phase-to-phase (277V rms phase-to-neutral).
	Peak Voltage	Reads to 600V peak (425V rms), input-to-case (ground)
	Impedance	>7.5MΩ, input-to-case (ground)
	Voltage Withstand	2.5kV rms 1min, input-to-case (ground) 2kV rms 1min, input-to-input
	Frequency	15-70Hz

Sampling System			
Sample Rate	128 samples per cycle		
Data Update Rate	Amps, Volts	Available every ¼ cycle	
	Watts, VAs, VARs, PF	Available every cycle	
Number of Bits	16		

Accuracy

Accuracies are specified at nominal Frequency and 25C, unless otherwise specified. Temperature Coefficient <25ppm. All values are true RMS and include Harmonics to the 63rd (minimum)

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Voltage	AC: Better than 0.1% of reading (20 to 425V rms, input-to-case). DC (AUX Inputs): +/- 0.2V (24 to 250Vdc, input-to-case)
Current (S10, S13,	Better than 0.1% of reading +/- 500μA (0.5A to 100.0A),
S16 bus 2)	Better than 0.1% of reading +/- 1mA (0.05A to 0.5A).
Current (S11, S14,	Better than 0.1% of reading +/- 100μA (0.5A to 20.0A),
S16 bus 1, S17 bus 2)	Better than 0.1% of reading +/- 250μA (0.05A to 0.5A).
Current (S12, S15,	Better than 0.1% of reading +/- 20μA (0.1A to 4.0A),
S17 bus 1)	Better than 0.1% of reading +/- 50µA (0.01A to 0.1A).
Current (S1C, S2C) External Split-Core CTs	Better than 0.1% of reading +/- 2mA (0.05A to 100.0A, -10C to 70C)
Frequency	+/- 0.001 Hertz (accuracy is specified at nominal Frequencies and over operating temperature range)
Phase Angle	+/- 0.2 Deg
Power	Better than 0.2% of reading (>20% of nominal inputs, 1PF to 0.7PF)
Power S1C, S2C	For S1C and S2C split core versions, better than 0.2% of reading +/- 250mVA (>20% of nominal inputs, 1PF to 0.7PF)

Environmental		
Operating Temperature	-40C to 70C	
Relative Humidity	0-95% non-condensing	
Installation Category	IC III (Distribution Level) Refer to definitions below.	
Pollution Degree	Pollution Degree 2 Refer to definitions below.	
Enclosure Protection	IP20 to IEC60529:1989	
Altitude	Up to and including 2000m above sea level	
	Indoor use; Indoor/Outdoor use when mounted in an appropriately rated protective enclosure to NEMA or IP protection classifications, as required for the installation.	

Physical



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(Signal Input Modules)	Current (S10, S11, S12)	Terminal block with 10-32 Studs for current inputs. Use ring lugs sized for #10 stud. Accepts #10-16 AWG (5.3-1.3mm²) wire. Recommended Torque: 16 In-Lbs, 1.81 N-m. Current inputs are connected to the output from the secondary of permanently installed Current Transformers (CTs). Grounding of CT signals per ANSI/IEEE C57.13.3-1983 is required.
		Terminal block with 8-32 Screws for current inputs. Use ring lugs sized for #10 screw thread. Accepts #10-22 AWG (5.3-0.33mm²) wire. Recommended Torque: 16 In-Lbs, 1.81 N-m. Current inputs are connected to the output from the secondary of permanently installed Current Transformers (CTs). Grounding of CT signals per ANSI/IEEE C57.13.3-1983 is required.
	External Split- Core CTs (S1C, S2C)	2 position removable terminal block, accepts 26-14AWG stranded wire. Recommended Torque 7 in-lbs, 0.79N-m.
	Overcurrent protection for Voltage (measurement) input (VT) connections	To maintain the safety features of this product, a 3 Ampere time delay (T) fuse must be connected in series with the ungrounded/non-earthed (hot) side of the supply input connected to the voltage measurement (VT) input of the instrument prior to installation. The fuse must carry a voltage rating appropriate for the power system on which it is to be used. A 3 Ampere slow blow UL Listed fuse in an appropriate fuse holder should be used in order to maintain any UL product approval.
	Voltage (CE units)	Removable Terminal Block, accepts #22-12 AWG (0.35 to 3.3mm²) wire, or terminal lugs up to 0.250" (6.35mm) wide. Standard 0.200" (5.08mm) header socket accepts other standard terminal types. Precautions must be taken to prevent shorting of lugs at the terminal block. A minimum distance of 1/8" (3mm) is recommended between uninsulated lugs to maintain insulation requirements. Recommended Torque: 10 In-Lbs, 1.13 N-m
	Voltage (non-CE)	Removable Terminal Block, accepts #22-12 AWG (0.35 to 3.3mm²) wire, or terminal lugs up to 0.325" (8.25mm) wide. Standard 0.200" (5.08mm) header socket accepts other standard terminal types. Precautions must be taken to prevent shorting of lugs at the terminal block. A minimum distance of 1/8" (3mm) is recommended between uninsulated lugs to maintain insulation requirements. Recommended Torque: 10 In-Lbs, 1.13 N-m
		Class I equipment to IEC61140: 1997

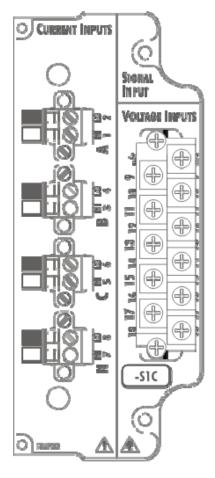




7.4 Current Input (CT) Connections

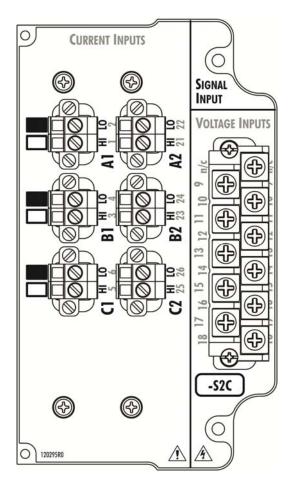
The current input terminal block for units with internal CTs features 10-32 terminals (M871) or 8-32 screws (M872) to assure reliable connections. Current from the inputs flow through the current transformers via #12 AWG SIS, 600V wire, and crimped ring-lugs with brazed seams. This results in a robust current input with negligible burden to ensure that the user's external CT circuit can never open-circuit, even under extreme fault conditions. The M871 has four independent current inputs, one for each phase being measured, plus neutral while the M872 has 6 independent current inputs for two sets of three-phase measurement. Current signals are connected directly to #10-32 studs (M871) or #8-32 screws (M872) on the current input terminal block on the front of the Signal Input module. See Section 7.3 for connection recommendations. It is intended that the instrument connect to the output from the secondary of permanently installed Current Transformers (CTs). Grounding of CT signals per ANSI/IEEE C57.13.3-1983 is required. The current input terminal block

For the M871 and M872 with split-core CTs, external split core CT secondary wires connect to the current terminal block. The current inputs for this model are touch safe. No internal current isolation is provided within the meter. DO NOT CONNECT Hazardous Live voltages to the current input terminal block. Only connect the external Split Core CT secondary current outputs to the meter's current input terminal block. Isolation is provided from the external Split Core CTs. Recommended torque is 9 In-Lbs, 1.02 N-m



Signal Input Module S1C Used with Split-Core CTs on M871





Signal Input Module S2C Used with Split-Core CTs on M872



7.5 Voltage Input (VT) Connections

The voltage terminal block is removable after unscrewing the mounting screws on the ends of the block. Voltage signals are measured using a $7.5M\Omega$ resistor divider with a continuous voltage rating of 7kV. This ideal impedance provides a low burden load for the VT circuits supplying the signals. Wiring diagrams, which represent the various measurement configurations that are applicable for the instrument, are provided in Figure 9. Grounding of VT & CT signals per ANSI/IEEE C57.13.3-1983 is recommended. The polarity of the applied signals is important to the function of the instrument.

The Auxiliary Voltage Input channels (M871 only) are physically identical to the other voltage inputs on the Signal Input Module.



7.5.1 Overcurrent protection for Voltage input (VT) Connections



To maintain the safety features of this product, a 3 Ampere time delay (T) fuse must be connected in series with the ungrounded/non-earthed (hot) side of the supply input connected to the voltage measurement (VT) input of the instrument prior to installation. The fuse must carry a voltage rating appropriate for the power system on which it is to be used. A 3 Ampere slow blow UL Listed fuse in an appropriate fuse holder should be used in order to maintain any UL product approval.



7.6 Current Measurements

The M871 has four current inputs, and the M872 has 6 current inputs, with an internal CT on each channel. These inputs can read to a maximum of 100A_{RMS} (symmetrical), or 141A_{PEAK}, for the S10 and S13 and S16 (bus 2) input modules under all temperature and input frequency conditions. No range switching is used, allowing a high dynamic range. Refer to section 7.3 for the current measurement input ranges and specifications for the signal input modules that are offered.

7.6.1 Neutral Current (Residual Current) for WYE Connections

The M871 directly measures the neutral current from the neutral CT. Residual current is calculated from the vector sum of the 3 per-phase currents on both the M871 and the M872.

7.7 Voltage Measurements

The M87x inputs are a unique advancement in voltage measurement technique. All three phases, and the neutral, are measured relative to a common reference point (essentially panel ground). Because all signals are sampled at the same instant in time, common mode signals can be removed by subtraction of samples in the DSP, instead of the more traditional difference amplifier approach. This greatly simplifies the external analog circuitry, increases the accuracy, and allows measurement of the Neutral-to-Ground voltage at the panel. The 7kV input divider resistors are accurate to within +/-25ppm/DegC, and have a range of 600VPEAK, from any input to panel ground.

A signal must be present on any of the phase-voltage or current inputs for the M87x to attain Frequency lock.

7.8 Changing Transformer Ratios

The M87x has the capability to store values for Current Transformer (CT) and Potential Transformer (VT) turns ratios. The VT and CT values are factory set to 1:1 CT and 1:1 VT. These values can be entered into the M87x over the network or via the Configurator software, and will be stored in internal non-volatile memory located on the Signal Input Module. All measurements are presented in primary units, based on these ratios. Refer to the appropriate protocol manual for information on changing transformer ratios.

7.9 User (External Transformer) Gain and Phase Correction

It is possible to correct for both gain and phase errors in external current and voltage instrument transformers connected to the M87x, when these errors are known. These Correction Factors can be entered via a protocol or by using the 70 Series Configurator Software.

User Gain Correction is a multiplier (from -2 to +2) that can be used to adjust for known gain errors in the system. User Gain Correction is "1" by default. For example, a gain correction of 1.01 would increase the effective ratio by 1%. Entering a negative number will reverse the phase of an input.

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User Phase Correction is used to adjust for known phase errors in the system. User Phase Correction is measured in degrees from -180 to 180. The default value is "0". When a User Phase Correction is entered, it will have an effect on Watts and VARs, Fundamental Watts and VARs, PF and Displacement PF, and the phase angles reported for fundamental values. It will have no effect on the magnitudes of phase-to-phase Fundamental Volts.

7.10 Calibration

Routine re-calibration is not recommended or required. A field calibration check every few years is a good assurance of proper operation.

7.11 Installation and Calibration for the S1C Option

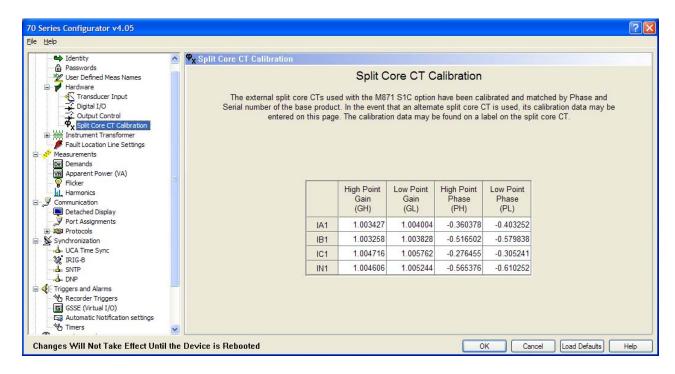
Each M871 with the S1C option is calibrated at the factory with a set of external split core CT's. During this process four calibration constants are generated for each CT. As with all previous M871 input options, these constants are stored in the M871 non-volatile memory. Additionally, these constants are now also printed to a label affixed to each CT along with the M871 Serial Number and the phase (A,B,C,N) the CT was calibrated on.

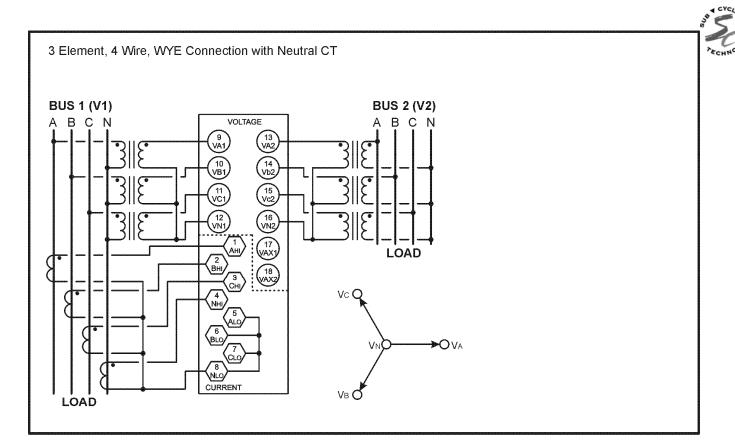
For normal installation, connect the external split core CT to the M871 input terminal with the matching serial number and phase. As noted above, the factory calibration is already stored in the M871 and accuracy will meet published specifications.

If for some reason the above installation method cannot be used, then the M871 factory calibration may be altered. Locate the four calibration constants (GH, GL, PH, PL) on the label of the external split core CT. Note the M871 serial number and phase to which the CT is attached. Connect to the M871 with the Configurator. On the Split Core CT Calibration page, enter the four calibration constants (GH, GL, PH, PL) into the appropriate locations.

After save and reboot, the entered calibration will replace the original factory calibration. Accuracy will be comparable to original and within published specifications.







CT's and PT's SHOULD BE GROUNDED PER ANSI/IEEE C57.13.3

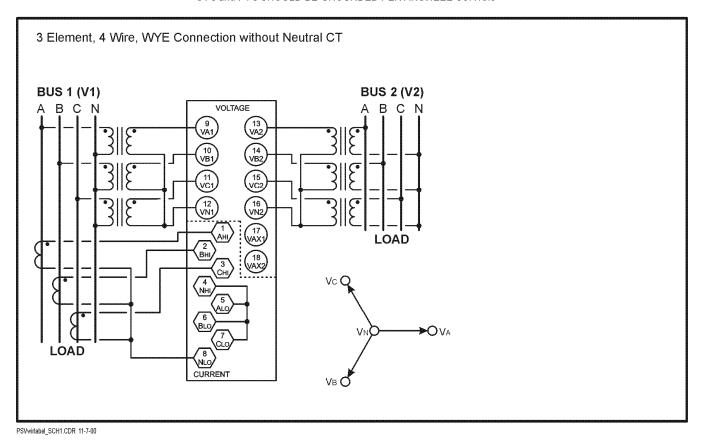
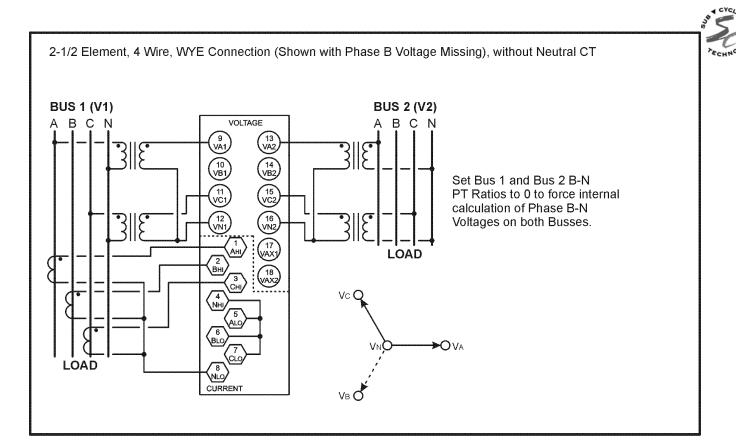


Figure 9 - Signal Connections (M871)



CT's and PT's SHOULD BE GROUNDED PER ANSI/IEEE C57.13.3

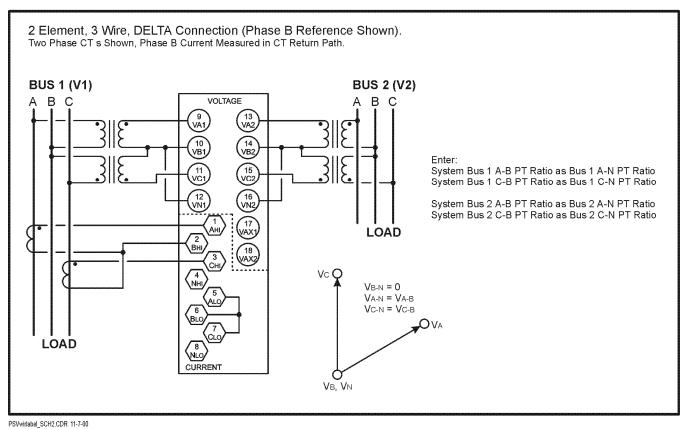
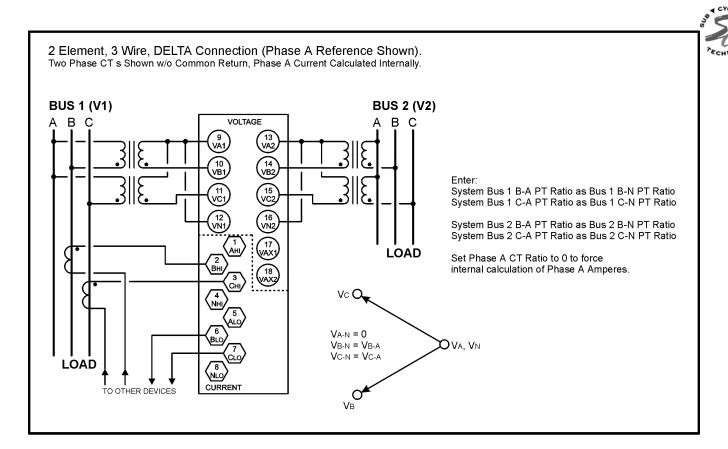


Figure 9 - Signal Connections (M871)



CT's and PT's SHOULD BE GROUNDED PER ANSI/IEEE C57.13.3

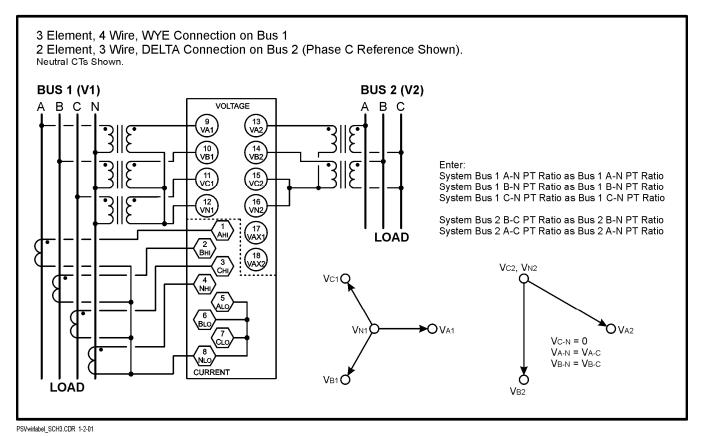
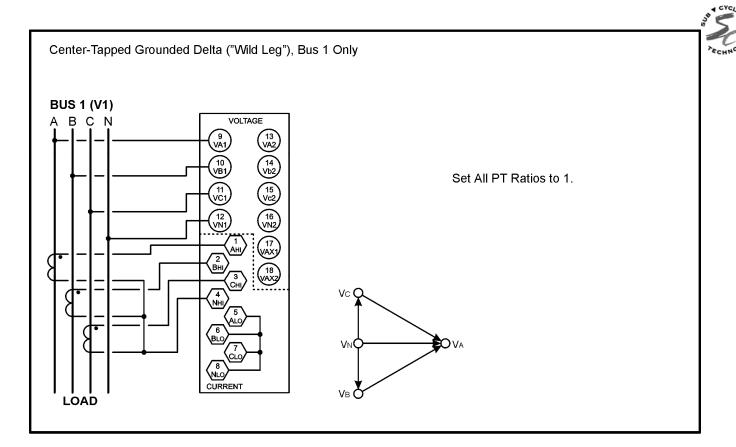


Figure 9 - Signal Connections (M871)



CT's and PT's SHOULD BE GROUNDED PER ANSI/IEEE C57.13.3

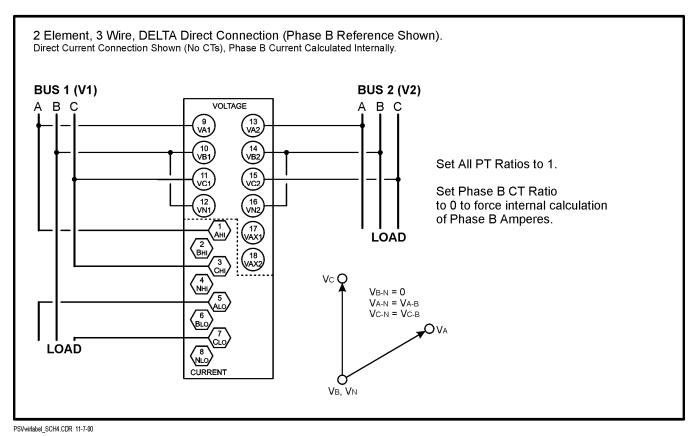
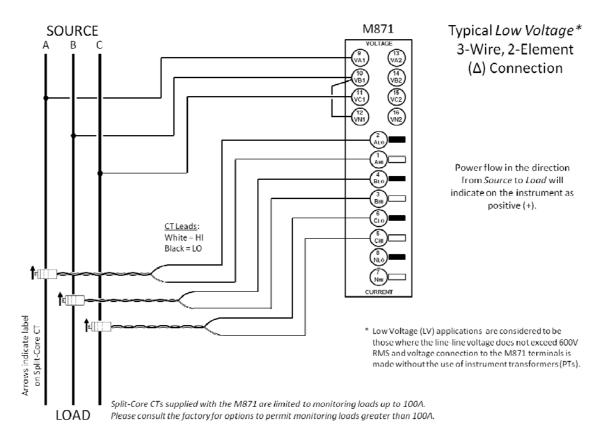


Figure 9 - Signal Connections (M871)





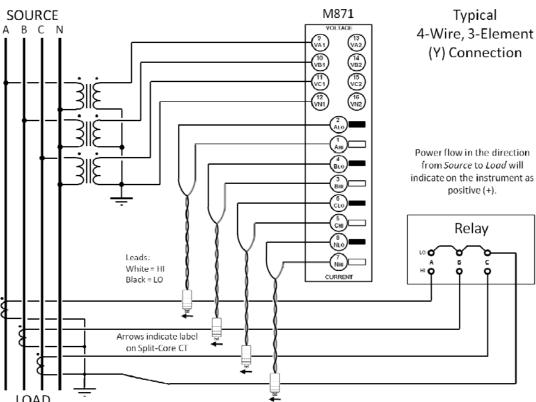


Figure 9 - Signal Connections (M871)



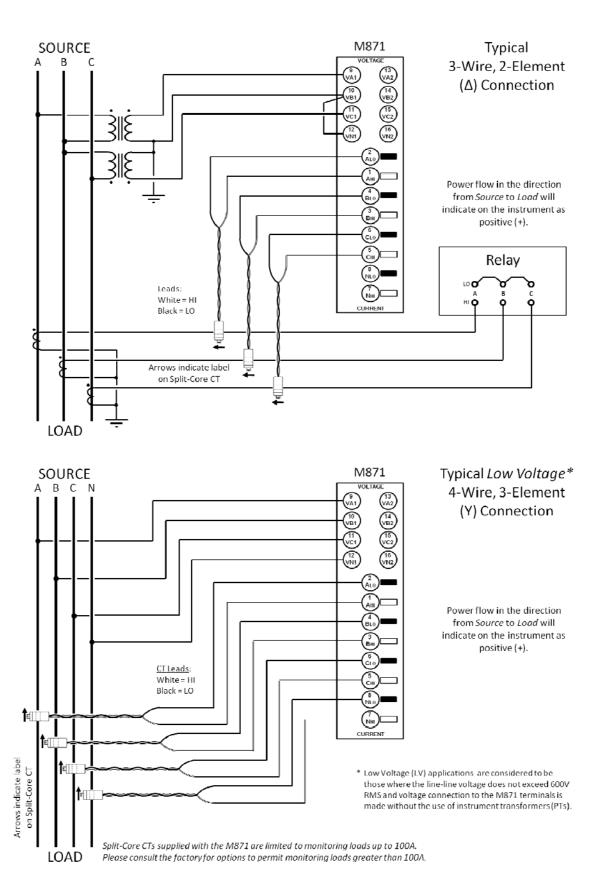
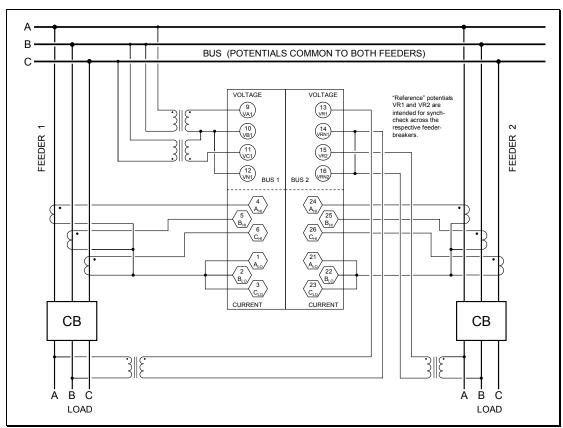
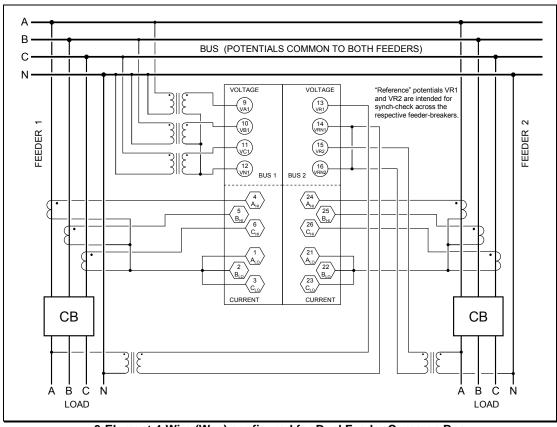


Figure 9 - Signal Connections (M871)





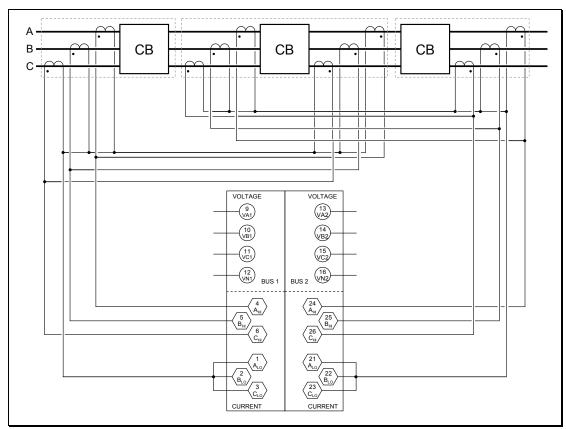
2-Element 3-Wire (Delta) configured for Dual Feeder Common Bus



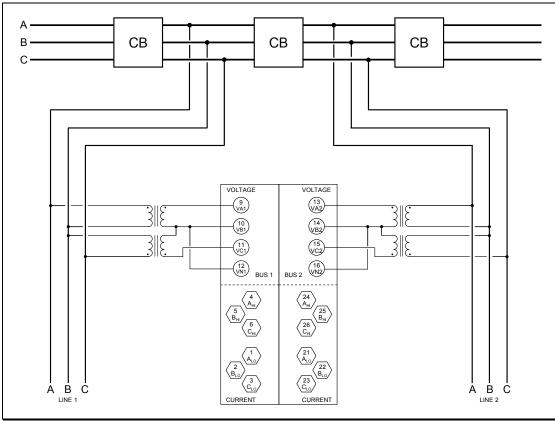
3-Element 4-Wire (Wye) configured for Dual Feeder Common Bus

Figure 9 - Signal Connections (M872)





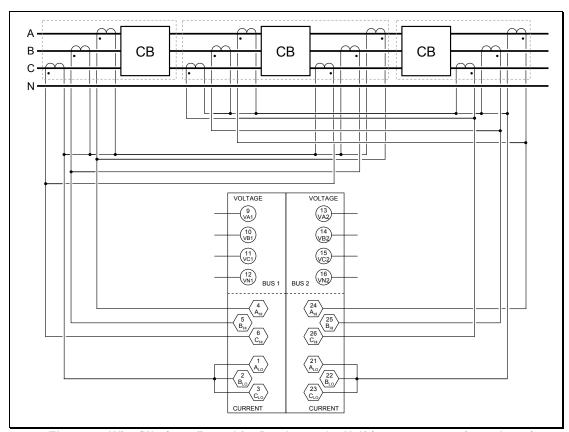
2-Element 3-Wire (Delta) configured for Breaker-and-a-Half (current connections shown)



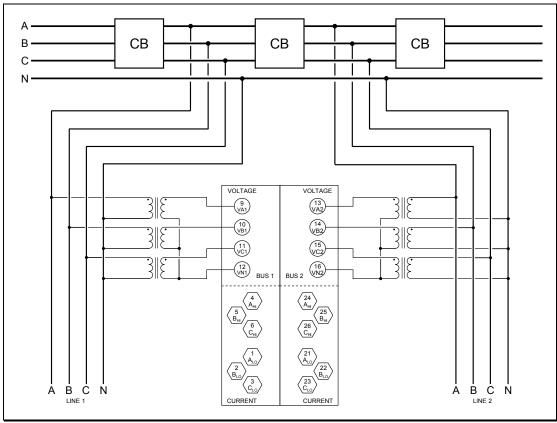
2-Element 3-Wire (Delta) configured for Breaker-and-a-Half (voltage connections shown)

Figure 9 - Signal Connections (M872)





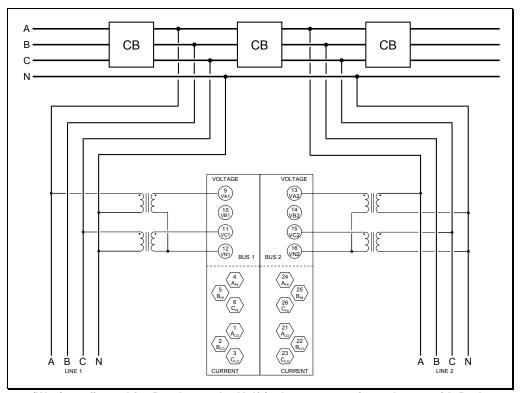
3-Element 4-Wire (Wye) configured for Breaker-and-a-Half (current connections shown)



3-Element 4-Wire (Wye) configured for Breaker-and-a-Half (voltage connections shown)

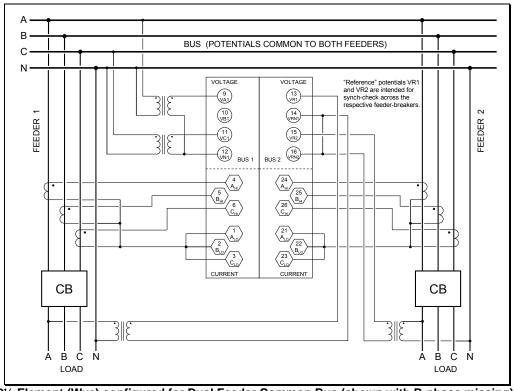
Figure 9 - Signal Connections (M872)





2½ Element (Wye) configured for Breaker-and-a-Half (voltage connections shown, with B-phase missing)
Current connections are the same as for 3-element 4-wire (wye) shown on the preceding page.

When configuring the unit, set the VT ratio for the missing phase equal to 0. This will cause the M872 to calculate the voltage of the missing phase from the vector sum of the two phases present (assumes balanced voltage).



2½ Element (Wye) configured for Dual Feeder Common Bus (shown with B-phase missing).

When configuring the unit, set the VT ratio for the missing phase equal to 0. This will cause the M872 to calculate the voltage of the missing phase from the vector sum of the two phases present (assumes balanced voltage).

Figure 9 - Signal Connections (M872)



8.0 ETHERNET MODULE P10, P11, P12 OR E1, E3 OPTION WITH H12 HOST

8.1 Introduction

The CompactPCITM high-speed Ethernet interface is available as an option for the M87x as either a stand-alone module when used with the H11, or consolidated with the H12 host module (H12E1 or H12E3). Both the stand-alone board and the consolidated options meet or exceed all requirements of ANSI/IEEE Std 802.3 (IEC 8802-3:2000) and additionally meet the requirements of the EPRI Substation LAN Utility Initiative "Statement of Work" version 0.7. The Ethernet interface is also compliant with IEC 61850 Part 3 and Part 8-1 TCP/IP T-profile for physical layer 1 (Ethernet copper interface) and physical layer 2 (for P12 with 100 Megabit fiber). These documents define an interface designed to interoperate with other devices with little user interaction ("Plug-and-Play").

M87x instruments with the H11 host module are offered with three versions (P1x) of the Ethernet interface board:

- The P10 features a 10/100 Megabit (Mb) RJ45 (copper) interface (10BASE-T and 100BASE-TX) which automatically selects the most appropriate operating conditions via auto-negotiation.
- The P11 has the features of P10 plus a 10 Mb fiber-optic port (10BASE-FL) operating at 820 nm (near infra-red) using ST connectors.
- The P12 has the features of P10, plus a 100 Mb fiber-optic port (100BASE-FX) operating at 1300 nm (far infra-red) using ST connectors.

All interfaces are capable of operating either as half-duplex (compatible with all Ethernet infrastructure) or full-duplex interfaces (which allow a potential doubling of network traffic). Note that only one port may be connected to a network at one time.

With the H12 host module, the E1 consolidated option mirrors the functionality and performance of the P10, while the E3 option performs like the P12 module.

The 70 Series IEDs come preconfigured for TCP/IP interface with an IP address, a SUBNET mask, and a ROUTER (GATEWAY) address. They also have a preconfigured NSAP address for an OSI network. It is very important that the network have no duplicate IP or NSAP addresses. Configuration of these addresses may be accomplished by using UCA, by using the 70 Series Configurator, or via a front panel serial port using a terminal emulator such as HyperTerminalTM or ProCommTM. Please refer to sections 3.1.1 and 5.5.2 that provide additional information and commands for changing these addresses.

If using the IEC61850 protocol the IP address may be configured from either the 70 Series Configurator software or from the IEC61850 IED Configurator software. A user radio button selection is provided on the 70 Series Configurator Identity page, giving a user the flexibility to decide which software tool will control the IP address configuration setting, which is loaded upon reboot. IP address configuration settings will be stored in either the INI file or MCL file. The INI files are loaded by the 70 Series Configurator and the MCL file is loaded by the IEC61850 IED Configurator.

The units are pre-configured for TCP/IP with an IP address/subnet mask/gateway address



192.168.0.254 / 255.255.255.0 / 192.168.0.1

and for OSI with an NSAP of:

49 00 01 42 49 09 01 01

The 70 Series IEDs use the following port numbers for each type of protocol:

PROTOCOL	PORT NUMBER
DNP	20000 (TCP, UDP)
FTP (recommend passive mode)	20, 21 (TCP)
Modbus	502 (TCP)
MMS (UCA & 61850)	102 (TCP)
SMTP (electronic mail)	25 (TCP)
SNTP (network time sync)	123 (UDP)
Telnet	23 (TCP)

8.2 Features

- □ 10/100 Megabit auto-negotiable copper interface with RJ-45 connector (P1x, E1, E3).
- Optional 10 Megabit fiber optic interface with ST connector for 62/125um glass fiber (P11)
- Optional 100 Megabit fiber optic interface with ST connector for 62/125um glass fiber (P12 and E3)
- Compliant to IEEE 802.3-1996 and IEEE 802.3u-1995
- Compliant to UCA Utility Initiative Statement Of Work Rev 7
- Compliant with IEC61850 Part 3 and Part 8-1 TCP/IP T-profile physical layer option 1 (copper)
- Compliant with IEC61850 Part 3 and Part 8-1 TCP/IP T-profile physical layer option 2 (100 Mb fiber - P12 only).
- Fully automatic port switching with manual override capability
- □ Six indicator LEDs (P1x)/Two indicator LEDs (E1, E3)

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Protected, utility-grade copper interface

8.3 Specifications (For P1x Modules Unless Otherwise Noted)

Ethernet Connection:

- (-P10/E1) 10/100 Megabit (Mb) RJ45 (copper) interface (10BASE-T and 100BASE-TX)
- (-P11) 10/100 Megabit (Mb) RJ45 (copper) interface (10BASE-T and 100BASE-TX) 820 nm 10 Mb fiber-optic port (10BASE-FL).
- (-P12/E3) 10/100 Megabit (Mb) RJ45 (copper) interface (10BASE-T and 100BASE-TX) 1300 nm 100 Mb fiber-optic port (100BASE-FX).



Indicator LEDs: P1x: Link, 10/100Mb, Collision, Duplex, Transmit, Receive

E1: Activity, Link; E3: Activity, Duplex

Bus Interface: Standard 5V CompactPCITM Backplane

Power Requirements: 50mA @ 3.3Vdc and 500mA @ 5Vdc (supplied from

backplane)

Complies with Hot Swap specification PICMG 2.1 R1.0 for Hot Swap (P1x only):

Basic Hot Swap (requires Host Processor re-boot).

This product contains fiber optic transmitters that meet Class I Laser Safety requirements in accordance with the US FDA/CDRH and international IEC-825 standards.

8.4 Environmental

Operating Temperature: -40 to 70C

Relative Humidity: 0-95% non-condensing

Installation Category: IC III (Distribution Level), Pollution Degree 2. Refer to definition

on page 9.

8.5 Physical

Connections: RJ45 (copper), ST connectors (62/125um glass fiber)

Package: CompactPCI[™] (3U, 4HP) removable module (P1x only)

Option integrated into H12 host module (E1, E3 options)

8.6 Hot Swap (HS) Compatibility (P1x Modules)

The blue Hot Swap LED located on the front panel is illuminated to indicate when it is permissible to extract a board in systems that support the *Full* Hot Swap System Model. The M87x currently supports the *Basic* Hot Swap System Model. The Basic Hot Swap System Model does not illuminate the blue LED. The blue LED will turn on briefly when a card is inserted into an energized device or when the device is reset. If the blue LED remains illuminated after insertion into an M87x or remains illuminated after the S10 Host module has booted, the associated card is malfunctioning.

8.7 Hardware Configuration

Configuration of the Ethernet interface is not normally required. The M87x is normally able to detect and adapt to any type of equipment attached to it. Under very rare circumstances, the user will need to manually configure the link for P1x modules using a jumper block on the Ethernet interface board. For the vast majority of cases, the factory default jumper settings (which is equivalent to having no jumpers installed) will provide the best possible link speed and reliability. The factory default locations for the two jumpers are 1-2 and 5-6. Section 8.13.1 details other jumper setting suitable for special situations.

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8.8 Cabling

The Ethernet interface uses a RJ-45 connector for copper interfaces and ST connectors for the optional fiber interfaces. "Straight-through" copper cables rated Category 5 (Cat5) or above up to 100 meters (328 feet) in length can be used The cable used for the P1x modules MUST be 100Ω STP (shielded twisted pair) for proper EMI/RFI performance. For the E1 or E3 options UTP (unshielded twisted pair) cable is satisfactory for the network connection. If a connection to a non-networked PC is desired, a "cross-over" cable can be used between the Ethernet card and the PC. Category 3 (Cat3) cable is not recommended due to the lack of upgradeability to 100 Mb Ethernet. Fiber-optic cable up to 2000 meters (6500 feet) in length (412 meters or 1350 feet for 100 Mb half-duplex) can be used. The cable should be multimode glass with a 62.5 mm core and 125 mm cladding (62/125). ST connectors for the M87x end and proper terminations for the network end (either ST or SC). The M87x supports only one Ethernet connection.

8.9 Connections

Copper network connections are made by simply plugging in the two cable ends. Ensure that the network end terminates in a port that is not labeled "uplink". An optical connection is made by connecting the TX port of the Ethernet interface to the RX port of the network hub or switch. The RX port then connects to the TX port. Use of external equipment using SC connectors is possible by using properly terminated cable or adapters. A few seconds after connection, green LINK indicators at each device should illuminate to indicate a proper connection has been established.

8.10 Troubleshooting the Connection

If a link is not established, verify that the RX and TX signals are not swapped (either by misapplying a "cross-over" cable or an "uplink" port or swapping the optical cables). If a connection is still not made, refer to Section 8.13.2 for suggestions.

8.11 Indicators

The Ethernet interface has six LEDs for use by users on the P1x modules, but only two LEDs on the E1 or E3 option.

LED			FUNCTION
P1x	E1	E3	
LK	LNK		Indicates a valid Physical connection. Must be on before any communicates takes place.
100			On when operating at 100 Mb, off for 10 Mb. Valid only when LINK is on.
COL			Flashes when an Ethernet collision occurs. See explanation below.
FULL		FULL	On when operating in full-duplex mode, off for half-duplex.
TX			Flashes when packet is being transmitted
RX			Flashes when any packet is being received (even packets not addressed to this
	ACT	ACT	Flashes activity when packets are transmitted and received

The collision LED, in particular, is a good indication of network health. It lights whenever the M87x and another device attempt to use the link at the same time (by definition, full



duplex links cannot have collisions). Collisions are an expected part of normal half-duplex Ethernet operations and the hardware transparently retries up to 16 times to send the message. If collisions occur more often than about once per second, it indicates a very heavily loaded network which is probably delivering messages late. If a large number of collisions occur, it is suggested that either the network speed be increased to 100 Mb or the hubs replaced with Ethernet switches.

8.12 Software Configuration

The M87x is able to determine the capabilities of the network equipment if the equipment supports auto-negotiation. If auto-negotiation is not supported, the M87x will be able to determine the network speed through a process known as parallel detection, but it cannot determine the duplex capability. In order to allow the M87x to operate in half or full-duplex, the user must supply the choice for the cases where the mode cannot be determined. Each communication protocol will supply a method to individually set the 10 Mb and 100 Mb duplex values for these cases. Half-duplex is always the safest choice since it is compatible with all legacy equipment. Full-duplex allows a potential doubling of the network speed and an extension of the 100 Mb fiber length. Consult your network administrator before setting the duplex configuration to full since this can cause serious network problems if misapplied.

8.13 Technical Details

Bitronics has secured a block of Ethernet addresses from the IEEE. They are of the form:

00-D0-4F-xx-xx-xx

The actual unique 48-bit address is marked on the circuit board above the jumper block.

The remainder of this section may be skipped by casual users and is pertinent only to P1x modules. The Ethernet board uses an AMD 79C972 ("Pcnet Fast+") media access controller (MAC) which interfaces directly to shared PCI memory on the cPCI bus. It interfaces to a National DP83843 ("PHYTER") Physical Layer Controller (PHY) via an onboard MII interface. The PHY interfaces directly to the magnetics module of the copper interface and the 100BASE-FX optical transceiver. It indirectly interfaces to the 10 Mb optics via a Micro Linear ML4669 10BASE-FL to 10BASE-T adapter. The user jumper block connects to the PHYTER ANO/AN1 pins and allows all 9 combinations of these pins to be used. The Ethernet software driver allows access to a modified copy of the 16-bit PHYSTS (PHY status) within the PHY for link type determination.

The Ethernet driver automatically manages link state changes. If the link is ever determined to be lost, it continuously searches for a new link. This search begins by resetting the PHY to allow the jumper block setting to be used. If this fails to provide a link, the PHY is configured to auto-negotiate while advertising all combinations or 100BASE-TX, 10BASE-T, half-duplex, and full-duplex. This will attempt linkage using both autonegotiation and parallel detection. If this fails and 10BASE-FL is supported, the PHY is reconfigured for forced 10 Mb mode to allow the 4669 to transmit an optical link idle signal (some network vendor's equipment refuse to generate the optical link idle unless they receive a link idle). If 100BASE-FX is supported, the PHY is reconfigured for forced 100 Mb mode using the PECL signals and an unscrambled data stream.



Once a link is established, the link type is tested. If the link was established through autonegotiation, which did not provide an indication of duplex capability, it is set according to the user configuration as described in the previous section.



8.13.1 Jumper Settings (P1x)

The jumper block allows setting of the Ethernet card to emulate less capable equipment or to force speed and/or duplex of the network interface. For most systems, the factory default (no jumpers) will provide the best connection. Use of other modes should be done only after careful consideration.

JUMPER			MODE			
100FX	AN1	AN0				
none	1-3	none	Force 10BASE-T (or 10BASE-FL) half duplex			
none	3-5	none	Force 10BASE-T (or 10BASE-FL) full duplex			
none	none	2-4	Force 100BASE-TX (or 100BASE-FX) half duplex			
none	none	4-6	Force 100BASE-TX (or 100BASE-FX) full duplex			
none	none	none	Auto-negotiate 10BASE-T half+full duplex, 100BASE-TX half+full duplex (FACTORY DEFAULT)			
none	1-3	2-4	Auto-negotiate 10BASE-T half+full duplex			
none	1-3	4-6	Auto-negotiate 100BASE-TX half+full duplex			
none	3-5	2-4	Auto-negotiate 10BASE-T half-duplex + 100BASE-TX half-duplex			
none	3-5	4-6	Auto-negotiate 10BASE-T half			
7-8	none	2-4	Force 100BASE-FX half duplex			
7-8	none	4-6	Force 100BASE-FX full duplex			

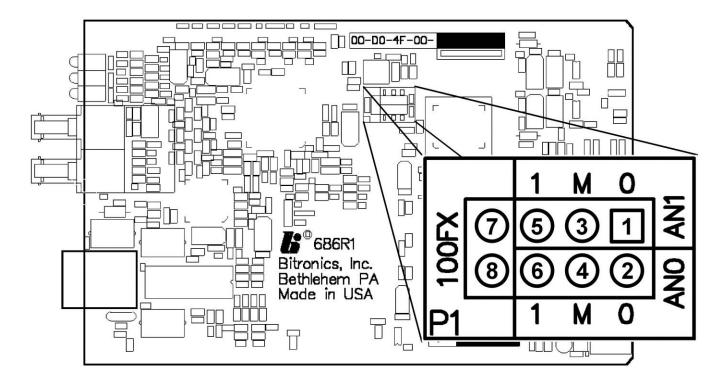


Figure 10 - Ethernet Board Jumper Locations (Rev 1 and Later Boards)

8.13.2 Troubleshooting



If the Link LED fails to illuminate, this is an indication that there is trouble with the connection and communication will not proceed without solving the problem. If a copper connection is used between the M87x and the hub/switch, check the following items:

- Verify that the connectors are fully engaged on each end.
- Verify that the cable used is a "straight-through" cable connected to a "normal" port.
 Alternatively, a "cross-over" cable *could* be connected to an "uplink" port (this could later cause confusion and is not recommended).
- □ Verify that both the M87x and hub/switch are powered.
- Try another cable.
- □ If a long CAT-5 cable is used, verify that is has never been kinked. Kinking can cause internal discontinuities in the cable.
- Try removing the jumpers (the factory default).

If a fiber-optic connection is used:

- Verify that the hub/switch matches the Ethernet card port. A 100BASE-FX port will NEVER inter-operate with the 10BASE-FL port (fiber auto-negotiation does not exist).
- □ Try swapping the transmit and receive connector *on one end*.
- Verify that the hub/switch uses the proper optical wavelength (10BASE-FL should be 820 nm and 100BASE-FX should be 1300 nm). Note that the Ethernet card may take up to 12 seconds before it enables the 10BASE-FL transmitter, but it leaves the transmitter on for about 5 seconds before giving up.

If a copper connection is used to an off-board fiber converter:

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- □ Verify that the LINK LED on the converter is lit on at least one side. Both sides need to be lit for a valid connection to be established.
- At least one brand of converters will not output an optical idle unless it receives a forced 10 Mb copper link pulse (for some reason, auto-negotiation pulses confuse it). Some hubs/switches will not output an optical idle unless they receive an optical idle. This then inhibits the converter from outputting a copper link pulse enabling the M87x to link. In this condition, no device completes the link. To get around this condition, some device needs to start a valid signal to "get the ball rolling". The M87x Ethernet card can be manually configured via jumpers for either "Force 10BASE-T half duplex" or "Force 10BASE-T full duplex" which guarantees that the converter will see a valid 10 Mb copper link pulse. This then causes it to output an optical idle which the hub/switch turns around to an output optical idle which the converter then turns into a copper idle signal which then allows the Ethernet card to link and everything works. See the above section for the proper jumper settings. This method even works if a fiber-to-copper converter is also used at the hub end (i.e., using copper Ethernet interfaces on both ends with a fiber-optic cable between them).
- Follow the suggestions for the all copper and all fiber system troubleshooting.

If both the LINK LED and the RX LED are both constantly on and the hub/switch indicates that it is not transmitting, the system is in the "false link" state. One known cause is using a non-auto negotiating 100BASE-TX hub/switch and setting the jumpers for "force 10BASE-T" mode. Moving the jumpers back to the factory default locations will cure this problem.



8.13.3 PHYSTS Register Contents (P1x)

The Ethernet software driver supplies to the upper protocol layers a modified copy of the PHYSTS register of the PHY controller chip at the time a link is established. Many of the bits in the register are of no use to the M87x user. Bit 0 is the least significant bit.

BIT	DESCRIPTION
9	1=Auto-negotiation enabled for the M87x
3	1=Link partner auto-negotiable, 0=network hub/switch does not support auto-negotiation
2	1=Full Duplex, 0=half duplex (differs from PHYTER register definition) (reflects duplex LED)
1	1=10 Mb speed in use, 0=100 Mb speed (if 100 LED on, then this bit is zero)
0	1=Link valid (follows Link LED).



8.13.4 Statistics Gathered by Ethernet Driver

The Ethernet driver gathers various statistics (stats) on transmit and receive activity. These can be useful to diagnose network problems or to simply determine network loading. The stats are gathered into a contiguous group of 4-byte unsigned integers. The first integer represents the number of receive stats. The second integer is a constant representing the number of transmit stats. This is followed by all receive stats, then all transmit stats. This format was chosen to allow extending the number of stats without affecting software that read old stats. For example, regardless of the number of receive stats, the first transmit stat will be offset by 2+number of receive stats. In the "C" programming language, this means the first receive stat would be at array[2] and the first transmit stat would be at array[array[0]+2]. The array content is:

ARRAY	OFFSET	DESCRIPTION		
0	-	Number of receive statistics (constant == 14)		
1	-	Number of transmit statistics (constant == 9)		
2	0	Total received bytes (only multicast frames which pass logical address filter are counted)		
3	1	Total received frames (multicast frames rejected by logical address filter are not counted)		
4	2	Multicast bytes received (this is mainly OSI ES/IS Hello messages)		
5	3	Multicast frames received		
6	4	Broadcast bytes received (this is normally IP ARP messages)		
7	5	Broadcast frames received		
8	6	Broadcast frames accepted by hardware hash filter but rejected by software		
9	7	Frames with CRC errors (does not included packets with non-integral number of bytes)		
10	8	Frames with CRC errors and non-integral number of bytes		
11	9	Frames with FIFO overflow (this are really bad errors indicating system malfunction)		
12	10	Frames discarded because byte count exceeded Ethernet maximum of 1518		
13	11	Frames with "BUFF" error (this is a really bad error indicating system malfunction)		
14	12	Frames dropped because memory not available (this is a really bad error)		
15	13	Frames dropped because infrequent interrupt response (this is a really bad error)		
16	0	Total transmitted bytes		
17	1	Total transmitted frames		
18	2	Frames not sent on first try due to another device transmitting in half-duplex (deferred)		
19	3	Frames never sent due to "excessive deferral" (this is a really bad network error)		
20	4	Frames sent after one collision		
21	5	Frames sent after between 1 and 16 collisions		
22	6	Frames never sent due to more than 16 collisions ("excessive collisions").		
23	7	Frames only partially sent due to transmit underflow (really bad system error)		
24	8	Frames with late collisions (probably due to full-duplex network and we are half-duplex)		

9.0 DIGITAL INPUT / OUTPUT MODULE P30A, P31, P33



9.1 Introduction

The high speed Digital I/O module features 8 (P30A) or 16 (P31) inputs that are fully isolated from each other and the case. The terminals of 4 of these are shared with 4 output relays. Other than the terminals themselves, the output relay circuits are completely independent of the inputs. The P33 has no inputs and 8 output relays.

Because the output relay terminals are shared with inputs, they may be monitored to provide feedback verifying proper operation of output commands. Protection and control industry standard-type output relays ensure system reliability.

The inputs are jumper-selectable for input level and threshold (thresholds of 15Vdc or 70Vdc). The outputs are jumper-selectable for "normal" output state (Normally Open or Normally Closed) and for relay condition (energized or de-energized). The input LED indicator is green when an input is driven high, and the output LED is amber when an output is activated (relay activated).

The Digital I/O Module inputs can be read by the Host Processor Board and/or the Analog-Digital Signal Processor Board. Input transition times are time-stamped. Outputs can be turned on or off by the Host Processor based on commands received over communication links, or by internal states generated by energy pulses, recorders, etc.

The Analog-Digital Signal Processor Board reads the state of the digital inputs every time it samples the analog inputs, and the sample rate of the digital inputs is tied to the frequency of the analog inputs. The Waveform and Disturbance Recorders may be configured to record the status of the digital inputs.

Consult the appropriate Protocol manual for information on reading the digital inputs or setting the digital outputs.

9.2 Features

- □ Two input ranges, for nominal system voltages of up to 100V or from 100 to 300V.
- Inputs protected against continuous overload to 300Vdc on low input range.
- All Input / Output terminals protected with internal transient limiting devices.
- Protection and control industry standard-type output relays and circuitry ensure system reliability.
- Outputs on the P30A/P31 have "wrap-around" inputs to allow confirmation of circuit operation.
- 2000Vac, 1min isolation, I/O to Case; 1500Vdc, 1min isolation, I/O to I/O
- Removable terminal block for ease of installation.

9.3 Specifications

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Inputs: 8 (P30A) or 16 (P31) uni-directional, isolated inputs (4 are shared with output

relays) jumper selectable for voltage range. Input terminals have internal

510V clamp.

Low Input Voltage Range

Input Range: 0 to 100Vdc

Threshold Voltage: 15V dc +/-1V (at 25C)

Input Resistance: 33kΩ

High Input Voltage Range

Input Range: 0 to 300Vdc

Threshold Voltage: 70Vdc +/-3.5V (at 25C)

Input Resistance: $153k\Omega$

Input Channel-to-Channel Time Resolution: 200µs (maximum)

Outputs: 8 isolated outputs on P33; 4 isolated outputs, terminals shared with 4 inputs

(P30A, P31); jumper selectable for Normally Closed (NC) or Normally Open

(NO) operation and for energized or de-energized condition. Output

terminals have internal 510V clamp.

Output Maximum Switched Current (Resistive)

Voltage	Tripping (C37.90 Resistive)	Continuous Carry	Break (Inductive)
24Vdc	30A	5A	8A
48Vdc	30A	5A	700mA
125Vdc	30A	5A	200mA
250Vdc	30A	5A	100mA

Input De-bounce Time: Selectable, from 60ns to 260s in 60 ns steps.

Output Operate Time (time from command by Host, does not include protocol delays)

Assert (Close time with "N.O." jumper): 8ms Release (Open time with "N.O." jumper): 3ms

Input Delay Time (from terminals): <100µs

Indicator LEDs

Inputs: Green, on when input voltage exceeds threshold.

Outputs: Amber, on when relay coil is energized.

Isolation

I/O Terminals to Case: 2000Vac, 1min I/O Channel to Channel: 1500Vdc, 1min



1400pF Input / Output Capacitance, any Terminal to Case:

3.3Vdc, 5Vdc, +/-12Vdc (supplied from backplane) Power Supply Requirements:

P30A, P31 complies with Hot Swap specification PICMG 2.1 Hot Swap:

R1.0 for Basic Hot Swap (requires Host Processor re-boot)

9.4 Environmental

-40C to 70C Operating Temperature:

Relative Humidity: 0-95% non-condensing

IC III (Distribution Level), Pollution Degree 2. Refer to definition Installation Category:

on page 9.

9.5 Physical

Connections: Removable Terminal Blocks, accepts #16-28AWG (1,4-

> 0.09mm) wire. Recommended Torque Rating is 2.2 In-Lbs. 0.25 N-m. Standard 0.150" (3,81mm) header socket accepts

other standard terminal types. Solid core wire is

recommended, or stranded wire with the use of "bootlace

ferrules," where these are available.

P30A: CompactPCI[™] (3U, 4HP) removable module Package:

> P31: CompactPCI™ (3U, 8HP) removable module P33: CompactPCITM (3U, 4HP) removable module

9.6 Hot Swap (HS) Compatibility

The blue Hot Swap LED located on the front panel is illuminated to indicate when it is permissible to extract a board in systems that support the *Full* Hot Swap System Model. The M87x currently supports the *Basic* Hot Swap System Model. The Basic Hot Swap System Model does not illuminate the blue LED. The blue LED will turn on briefly when a card is inserted into an energized device or when the device is reset. If the blue LED remains illuminated after insertion into an M87x or remains illuminated after the Host module has booted, the associated card is malfunctioning.

9.7 Description

9.7.1 P30A

The Digital I/O Module consists of two circuit boards, the CompactPCITM Interface Board (692), and the I/O Board (693). The Interface Board contains the CompactPCI™ backplane connector and interface circuitry, front panel LEDs, and jumper blocks for output relay power-up configuration.



The I/O Board contains the analog input and isolation circuitry, output relay and drive circuitry, as well as input protection and EMI/RFI suppression.

9.7.2 P31

The P31 Digital I/O Module consists of four circuit boards, the CompactPCITM Interface Board (692), the LED Daughterboard (717), and two I/O Boards (693 supports pins 1-16, and 716 for pins 17-32). The Interface Board assembly contains the CompactPCITM backplane connector and interface circuitry, front panel LEDs, and jumper blocks for output relay power-up configuration.

The I/O Boards (693 and 716) contain the analog input and isolation circuitry, input protection and EMI/RFI suppression, as well as output relay and drive circuitry (693 only).

9.7.3 P33

The P33 Digital Output Module consists of two circuit boards, the main board (803) contains the CompactPCITM Interface and all of the output circuitry. Moveable jumpers are located on this board that are used to set each relay output as either normally open (NO) or normally closed (NC). Daughterboard (803A) consists of the LED's used to indicate the relay status. An LED is turned on when its respective relay coil is energized.

9.8 System Design Considerations



9.8.1 Input / Output Impedance

On the P30A and P31, all of the output relay terminals are shared with the circuitry for a digital input. As a result, there is always an impedance across the output relay contacts, even when the relay is not energized. The value of the impedance depends on the configuration of the input, or more specifically, the setting for the input threshold. The input circuitry is shown in Figure 11 (pg.112). THIS PARALLEL IMPEDANCE WILL CAUSE A CURRENT TO FLOW THROUGH ANY LOADS THAT ARE CONTROLLED BY THE RELAY WHEN THE RELAY CONTACTS ARE OPEN. IT IS IMPORTANT TO CONSIDER THIS CURRENT WHEN SELECTING THE INPUT THRESHOLD, AND WHEN DESIGNING SYSTEMS USING THE OUTPUT RELAYS.

If the input is set for a low threshold (15V), then the impedance across the relay terminals is $33k\Omega$. On a 125Vdc system, this equates to a maximum of 3.8mA, depending on the impedance of any loads in the loop. If the input is set for a high threshold (70V), then the impedance across the relay terminals is $153k\Omega$. On a 125Vdc system, this equates to a maximum of 817μ A, depending on the impedance of any loads in the loop.



9.8.2 Input Assignments

Due to the shared nature of some of the I/O circuitry, careful planning should be used in assigning the inputs and outputs of the P30A/P31 module. The user is reminded that the first four inputs on either module are shared with the four outputs. **SERIOUS SYSTEM AND/OR PRODUCT DAMAGE COULD RESULT FROM HAVING AN OUTPUT RELAY OPERATE WHILE CONNECTED TO AN INPUT.** For this reason, it is recommended that the user assign inputs 5-8 (those not shared with inputs) prior to using the first four inputs.



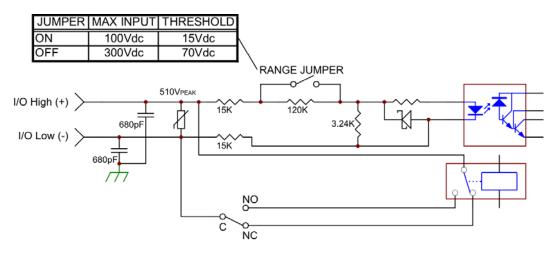
The output relays can be completely disabled on a per-channel basis enabling the safe operation of the first four inputs if desired. See section 9.10.4.

9.9 Debounce Time Setting

The Digital Input Module can filter the inputs to compensate for "chattering" relays, etc. The debounce time may be set using the 70 Series Configurator software, via the various protocols. An input transition is not recognized until the input remains in the new state for a time longer than the debounce time. Values between 60 ns and 4 minutes are acceptable.

An event triggered from the digital inputs will be subject to the debounce time setting for the digital input. Digital input traces in the Waveform and Disturbance files are the instantaneous status of the inputs, and DO NOT reflect any debounce time settings. If a long debounce time is set, it is possible to see an event on the digital input that does not cause a trigger.





Simplified Input/Output Circuitry - Inputs 5 to 16 do not have Output Relay and Jumper

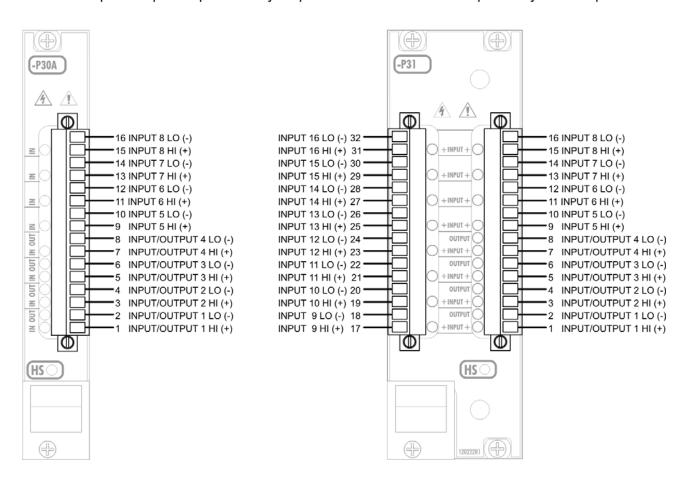
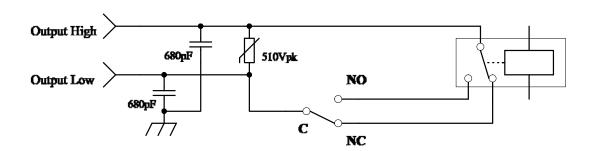


Figure 11 - Simplified Input / Output Circuitry and Terminal Assignment P30A, P31





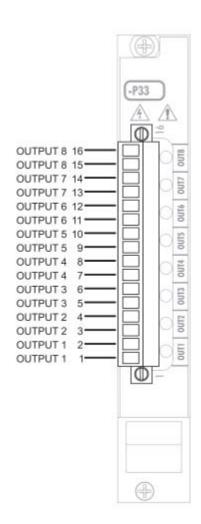


Figure 12 – Simplified Output Circuitry and Terminal Assignment P33

9.10 Setting Digital I/O Module Jumpers



9.10.1 Disassembly of the P30A Module

To set the jumpers on either board of the Digital I/O Module, the boards must first be separated:

1. Remove the three screws as shown:

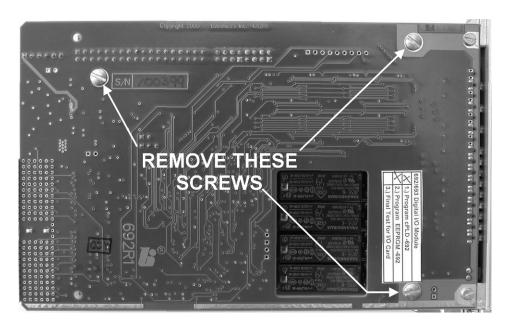


Figure 13 - P30A Module Disassembly

2. Gently pull apart the boards by the inter-board connector near the back of the module.

Reassembly is performed in the reverse order.

9.10.2 Disassembly of the P31 Module

- 1. Remove the six screws (three per side) indicated in Figure 13, and set aside the shields labeled PCB 712. Identify the main circuit boards that comprise the P31 assembly. They are labeled 693, 692, and 716.
 - a. PCB 693 contains:
 - Terminal block for I/O points 1-8 (pins labeled 1-16 in blue).
 - Range jumpers for input points 1-8.
 - Normally open/normally closed jumpers for output points 1-4.
 - b. PCB 692 contains:
 - Power-up condition jumpers for output points 1-4.
 - c. PCB 716 contains:
 - Terminal block for I/O points 9-16 (pins labeled 17-32 in red).
 - Range jumpers for input points 9-16.

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2. Note: If you only need access to the jumpers for configuring the digital output



relays, there is no need to remove PCB 716, and you may skip this step. Otherwise, (for access to the range jumpers for input points 9-16) remove the two screws indicated in Figure 14. Locate P8 (the 16 pin array connecting PCB 716 to PCB 692) and gently pry the pins from the header.

3. For access to the range jumpers for input points 1-8, the normally open / normally closed jumpers for output points 1-4, and the power-up (energized / de-energized) condition jumpers, locate P1 (the 36 pin array connecting PCB 693 to PCB 692) and gently pry the pins from the header.

Reassembly is performed in the reverse order.

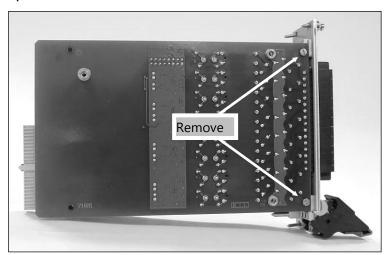


Figure 14 - P31 Module Disassembly

9.10.3 CompactPCI[™] Interface Board (692) Jumper Settings

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The CompactPCITM Interface Board (692) has jumper blocks (P7) to set the output relay power-up configuration, which is the state (coil energized or de-energized) at which the relays go to when power is first applied to the module. The actual contact state is determined by the relay Normally Open (NO) or Normally Closed (NC) jumper (Section 9.10.4). By default, no P7 jumpers are installed at the factory, which sets the output contact state to de-energized (open when configured for NO), which should be sufficient for most applications. If it is necessary to change the power-up configuration, jumpers may be installed on P7 as follows:

Power Up Configuration					
Jumper	Function	ON	OFF	Output Relay NO	Output Relay NC
P7	PUC1		Х	Output 1 set to OPEN	Output 1 set to CLOSED
P7	PUC1	Χ		Output 1 set to CLOSED	Output 1 set to OPEN
P7	PUC2		Х	Output 2 set to OPEN	Output 2 set to CLOSED
P7	PUC2	Χ		Output 2 set to CLOSED	Output 2 set to OPEN
P7	PUC3		Х	Output 3 set to OPEN	Output 3 set to CLOSED
P7	PUC3	Χ		Output 3 set to CLOSED	Output 3 set to OPEN
P7	PUC4		Х	Output 4 set to OPEN	Output 4 set to CLOSED
P7	PUC4	Χ		Output 4 set to CLOSED	Output 4 set to OPEN



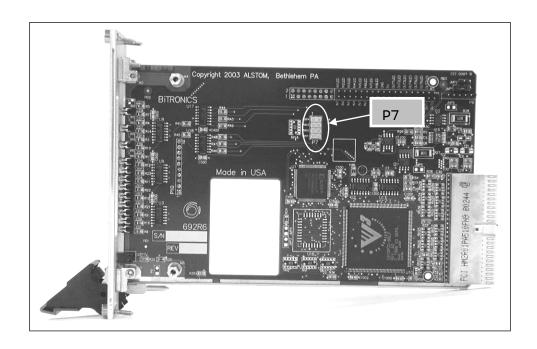


Figure 15 – P7 Jumper Location

9.10.4 I/O Board (693) Jumper Settings

There are several jumpers for setting the input range and threshold on the I/O board and for the normal state of the output relay contacts. The board and jumper locations are shown in Figures 16 and 17. Range jumpers for Inputs 1-8 are located on PCB 693; inputs 9-16 (P31 only) are on PCB 716. The jumpers are red in color for high visibility. Refer to the beginning of this section for the procedure to access the jumpers.



When the input jumper is installed, the input is in LOW RANGE mode. Removing the jumper places the input in HIGH RANGE mode. THE FACTORY SETTING IS HIGH RANGE (JUMPER IS PLACED IN THE STORAGE POSITION). REFER TO SECTION 9.8.

The relay outputs can be set for Normally Open (NO) or Normally Closed (NC) operation. To enable Normally Open operation, which is the factory setting, place the jumper from "C" (common) to "NO". To enable Normally Closed operation, place the jumper from "C" to "NC".

The relay outputs can be disabled if desired by placing the jumper vertically, from the "NC" to the "NO" contacts, or by removing the jumper entirely. This may be desirable if only the inputs are going to be used on these terminals, and the user wishes to guarantee the outputs do not operate (see figure 18).



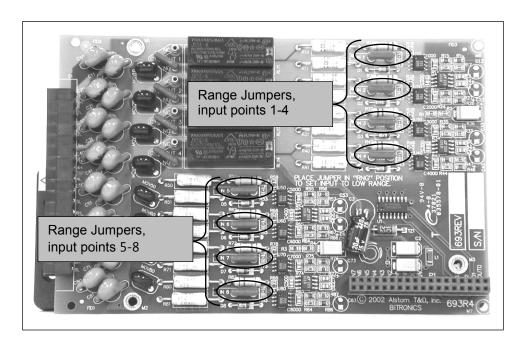
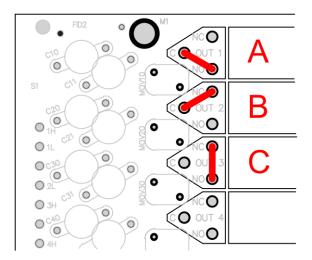


Figure 16 - Jumper Locations for Digital Input / Output Module (693)



Figure 17 - Jumper Locations for Digital Input / Output Module (716)



- A Normally Open
- B Normally Closed
- C- Relay Disconnected (Storage)

Figure 18 - Relay Output Configuration Jumper

9.10.5 Health Status Digital Output Setting (Optional assignment of Digital Output 1 of Module 0)

Digital Output 1 of Module 0 may be assigned to operate when the value of the Health variable is <1. To set up Digital Output 1 in this manner, it is necessary that the Relay Output 1 Connection Jumper be set for Normally Closed operation. Therefore, during normal operation, the unit is actively holding the contacts of the output relay open (no alarm). If an erroneous operation is detected, or there is a power supply failure, the contacts of the output relay will close (alarm).

The function of this output may be assigned for Health status by using the 70 Series Configurator, along with the Normally Closed jumper connection installed for Relay output 1.

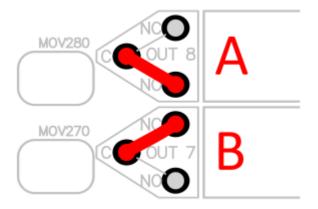
9.10.6 Disassembly of the P33 Module

No additional disassembly is required, aside from removing the module from the chassis, to access the relay jumpers.

9.10.7 Digital Output Board (803) Jumper Settings

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There are several jumpers for setting the normal state of the output relay contacts. The board and jumper locations are shown in Figure 19.



- A Normally Open Default B Normally Closed

Figure 19 - Relay Output Configuration Jumper

10.0 TRANSDUCER INPUT MODULE P40

10.1 Introduction

The Transducer Input Module features 8 separate inputs each with two terminals, one which provides a unique return path for each input. This permits the inputs configured as current inputs to be series connected to multiple transducer input devices and inputs configured as voltage inputs to be parallel connected to multiple transducer input devices. The input terminal assignments are shown in figure 20.

The inputs are jumper-selectable for three different transducer input formats. The inputs can be jumpered for either 0–1 mA or 4-20 mA current inputs or for 0–10V voltage inputs. Both the 0-1 mA and 0 -10 V formats are bipolar (bi-directional) such that they span (-)1mA to (+)1mA and (-)10V to (+)10V respectively. Each format allows for input over-range such that inputs exceeding the normal range can still be reported accurately. The reportable range for each input type is approximately: (+/-) 2.5 mA for 0-1mA inputs; (+/-) 12.5V for the 0-10V inputs; and 0 to 25mA for 4-20mA inputs.

Each transducer input can be independently configured for any of the three input formats. This permits one Transducer Input Module to be used to read eight analog inputs with any mix of the three standard current and voltage formats. Transducer Input Modules can only be ordered pre-configured for one standard input type (all inputs are pre-configured at the factory for one input type), however, each input on every Transducer Input Module is calibrated to support all format types. Changing an input's type is easy and only requires changing that input's jumper setting. The jumper settings are documented in section 10.8.1, below.

Each transducer input is sampled by a 24-Bit delta sigma analog to digital converter, adjusted by a factory set pre-stored gain and offset calibration constant, and then converted to a 16-Bit integer value. The Host Processor Board updates the transducer input values in the floating point database every 500msec by reading each input's 16-Bit integer value and converting it to a floating point value. By default the floating point value represents the actual current (in mA) or voltage (in volts) present at the input. The Host Processor can be configured (via the Mx70 Series Configurator software) to independently scale each transducer input's floating point value. The scaling is accomplished by assigning a floating point value to the extreme values of the transducer input's format. Input scaling is described in detail in section 10.8.2, below.

Consult the appropriate Protocol manual for information on reading the transducer inputs and the available calculation types.

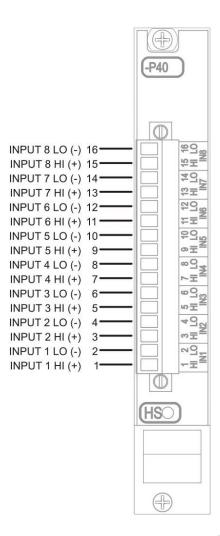


Figure 20 - Terminal Assignment

10.2 Features

- □ Each input has jumper selectable ranges for support of 0 to (+/-)10 volt, 0 to (+/-)1mA, and 4-20mA transducer input formats.
- All input terminals protected with internal transient limiting devices and spark gap protection.
- Module meets CompactPCI Hardware Hot Swap specification.
- □ Design includes local microcontroller with 24-bit sigma delta analog-to-digital converter.
- □ Robust local microcontroller design incorporates local watchdog and continuously monitors offset and gain calibration constants integrity via checksum calculation.
- □ Removable terminal block for ease of installation

10.3 Specifications

Inputs: 8 bi-directional, jumper selectable for voltage or current range. Input

terminals have internal transorb clamp and 90V spark gap protection.

0 – 10V Voltage Range

Overload Range: -12.5 V to +12.5 Vdc

Resolution: 0.381 mV Input Resistance: $10K\Omega$

0 – 1mA Current Range

Overload Range: -2.5 mA to +2.5 mA

Resolution: $0.0763 \mu A$ Input Resistance: 500Ω

4 – 20mA Current Range

Overload Range: 0 mA to +25 mA

Resolution: 0.381 μ A Input Resistance: 50 Ω

Common Mode Input Range +/- 9V, Input to Chassis

Common Mode Error

Vcm DC: 0.3% of FS @ 9Vp Common Mode Vcm 50/60Hz AC: 0.1% of FS @ 9Vp Common Mode

Accuracy 0.25% of Full Scale Input

Data Update Rate (poll rate): 100 ms minimum (single P40 Transducer input module)

500 ms minimum (multiple P40 Transducer input

modules)

Input Capacitance, any Terminal to Case: 470pF

Power Supply Requirements: 3.3Vdc, 5Vdc, +/-12Vdc (supplied from backplane)

Hot Swap: Complies with Hot Swap specification PICMG 2.1 R1.0

for Basic Hot Swap (requires Host Processor re-boot)

10.4 Environmental

Operating Temperature: -40C to 70C

Relative Humidity: 0-95% non-condensing

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Installation Category: IC III (Distribution Level), Pollution Degree 2. Refer to

definition on page 9.

10.5 Physical

Recommended Wire:

Connections: Removable Terminal Blocks, accepts #16-28AWG (1.4-

0.09mm) wire. Recommended Torque Rating is 2.2 In-Lbs, 0.25 N-m. Standard 0.150" (3.81mm) header socket accepts other standard terminal types.

Twisted pair, solid core wire (preferred), or stranded wire

with the use of "bootlace ferrules," where these are

available.

Package: CompactPCITM (3U, 4HP) removable module

10.6 Hot Swap (HS) Compatibility

The blue Hot Swap LED located on the front panel is illuminated to indicate when it is permissible to extract a board in systems that support the *Full* Hot Swap System Model. The M87x currently supports the *Basic* Hot Swap System Model. The Basic Hot Swap System Model does not illuminate the blue LED. The blue LED will turn on briefly when a card is inserted into an energized device or when the device is reset. If the blue LED remains illuminated after insertion into an M87x or remains illuminated after the Host module has booted, the associated card is malfunctioning.

10.7 Description

The Transducer Input Module is a one board design that contains the CompactPCI[™] backplane connector and interface circuitry, jumper blocks for the input type selection, the input transient protection circuitry, an analog-to-digital converter, a local microcontroller and the input terminal block.

10.8 System Design Considerations

10.8.1 Input Type Jumper Settings

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Transducer Input Modules are ordered by specifying an input type and the module is shipped from the factory with all inputs configured for that specified transducer input type. The input type configuration is determined by jumper settings and can easily be reconfigured in the field. Each input of the Transducer Input Module can be independently configured to support either the 0 to 1mA, 4 to 20mA, or 0 to 10V transducer input formats.

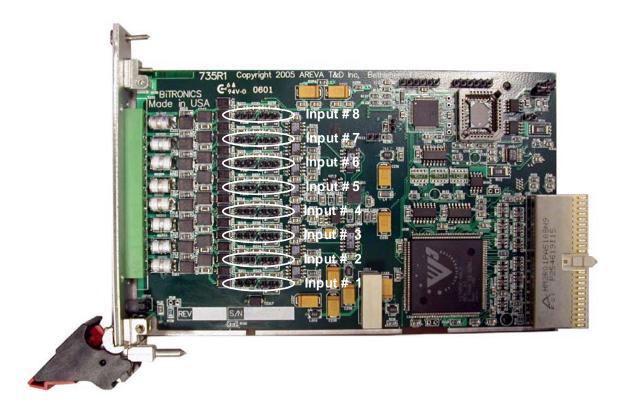


Figure 21 – P40 Input Type Jumper Locations

Each input has two configurable jumper blocks. One jumper block configures the hardware (the actual input circuitry), the other jumper control block configures the firmware and software driver (informs drivers of the status of the hardware selection). It is extremely important that when reconfiguring any input, that both the hardware jumper setting and firmware jumper setting for that input match (select the same input type).

Figure 21 (P40 Input Type Jumper Locations) shows the location of each input's jumper block pair. Each jumper block pair consists of two three pin headers and each header is shipped with a shorting block. The position of the shorting block on the header determines the input type configuration. Figure 22 (P40 Input Type Jumper Configuration) demonstrates the shorting block positions for the three valid input configuration options.

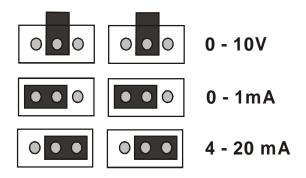


Figure 22 – P40 Input Type Jumper Configuration

10.8.2 Transducer Input Scaling Configuration

The floating point values for the Transducer Input points on all present Transducer Input Modules will appear in the M87x floating point database. By default, values for Transducer Inputs configured as voltage inputs will be in volts and values for Transducer Inputs configured as currents will be in milliamps. Database points for which there are no corresponding Transducer Input points will report as zero.

The 70 Series Configurator software provides for gain and offset scaling for each Transducer Input. This permits transducer inputs to appear in primary units. The 70 Series Configurator allows the user to enter two specific primary values for the associated transducer input values and automatically calculates the correct offset and gain corrections. See Figure 23 (70 Series Configurator Software Transducer I/O Configuration Screen).

In the screen snap shot shown in the Figure 23, the first Transducer Input card has the first three inputs configured for type 0-1mA, inputs 4 through 6 configured for type 4-20mA inputs, and the remaining two inputs configured as type 0-10V inputs. All inputs except for 5 and 6 will appear in the database in default units (milliamps for inputs 1 through 4 and volts for inputs 7 and 8).

10.8.3 Setting the Data Update Rate (Poll rate) for P40 Transducer Inputs

The poll rate is now settable through the Transducer Input page. Poll rate has been added as a settable value starting with the release of Configurator v3.02. A poll rate as low as 100 ms can now be set for certain applications. Refer to the specifications when setting the poll rate for Transducer Inputs on M87x. See Figure 23, which shows an example of settings made using the 70 Series Configurator Software on the Transducer Input page.

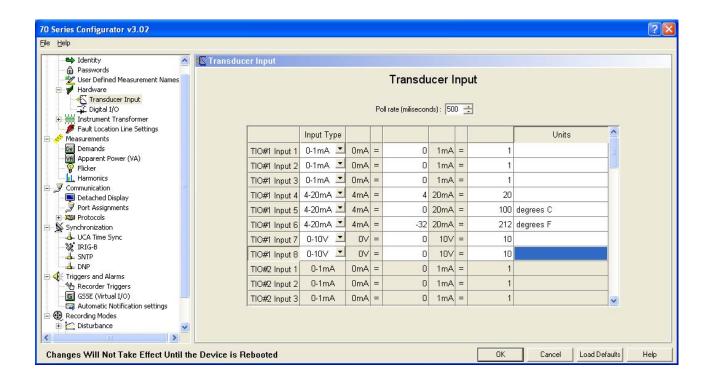


Figure 23 – 70 Series Configurator Software Transducer Input Configuration Screen

Suppose the device connected to input 5 is a temperature transducer with an output range from 4 to 20mA that corresponds to a temperature of 0 to 100 degrees C. Configuring the 4mA setting to report as 0 and the 20mA setting to report as 100 will scale the value in the M87x database to the primary units of the transducer. If this same transducer is connected to input 6 and the scalings are changed to -32 and 212 respectively, the value will appear in the M87x database in degrees F.

APPENDIX A - CROSS TRIGGERING

Cross-Triggering

There are many possible uses for the Input / Output functions available from 70 Series Recorders, but Cross-Triggering deserves special attention since it is prerequisite to the application of distributed recording.

Intelligent Electronic Devices (IEDs) like microprocessor-based relays or 70 Series Recorders are generally used to measure the electrical parameters associated with a particular load, such as a feeder for example. In contrast, most dedicated Sequence-of-Events (SOE) Recorders or Digital Fault Recorders (DFRs) collect measurements from all points of interest throughout an entire substation or load center. Those devices generally produce recordings that include the activity of all points in a single document facilitating analysis by showing everything on a common time scale. A consolidated document like that can be produced by time-synchronized distributed IEDs by combining files captured by each of the recorders.

In order to consolidate all the recordings from IEDs distributed throughout a substation, all the IEDs must first be made to trigger simultaneously whenever an event of interest is sensed by any one unit in the substation. That mechanism is referred to as Cross-Triggering. Recordings are then downloaded and combined by software designed for that purpose (described elsewhere). This appendix will concentrate on methods available for cross-triggering distributed IEDs.

70 Series Recorders support two mechanisms for cross-triggering one another. These mechanisms are vendor-independent so may be used in combination with protective relays and other IEDs to the extent that status and control points are available or that protocols are supported by the other devices.

 Hard-wired, using discrete digital I/O. Contacts wired in parallel on a dedicated cable pass a voltage signal to the status inputs on each IED when an event is sensed. The status input on each device can then be configured to trigger a recording.

2. Ethernet:

- **a. using GOOSE.** Status points are communicated across an Ethernet LAN using the IEC-61850 standard. The principal advantage of GOOSE messaging is that it does not require a separate dedicated control cable for physical contacts.
- **b. using GSSE.** Status points are communicated across an Ethernet LAN. The principal advantages of GSSE are interoperability with legacy equipment and simplicity of configuration. All 70 Series firmware released from April 2004 to June 2008 supported UCA. The term "GOOSE" when used in the UCA context is equivalent to GSSE as defined by IEC-61850. GSSE messaging can be set up with the 70 Series Configurator alone. The IED Configurator is not required for GSSE.

The 70 Series Recorder provides considerable flexibility in how a user could customize

these methods to fit the constraints of any particular application. An exhaustive description of all possible variations is not practical, but it is useful to provide an example of each method in a typical application.

Example 1. Discrete Digital I/O:

Please refer to Figure A1 for wiring, Figure A2 through A4 for configuration, and Figure 11, section 9.9 for the pin-out of the Digital I/O cards and internal resistor values that are not shown in Figure A1.

Note: Standard Digital I/O cards (P30A and P31) incorporate an internal parallel current path on all digital outputs which conducts through a resistance even when the output contacts are open. This is normally used as a parallel digital input circuit but it makes the standard card unsuitable for cross-triggering because it tends to pull-up the switched conductor when contacts are open. **To use cross-triggering as shown in this example, be sure to specify optional P30AW (8-point) and P31W (16-point) Digital I/O cards when ordering M87x models.**

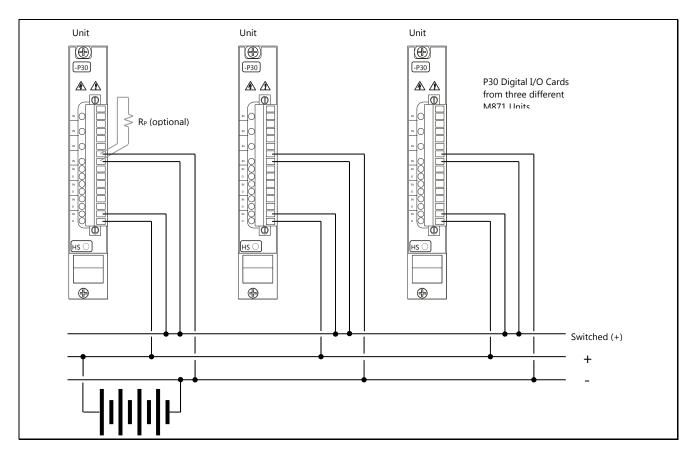


Figure A 1

Wiring:

Figure A1 illustrates one digital output (lower pair, pins 1 and 2 on a P30AW card) from each of three M871 units wired in parallel. Closing the Output 1 contact on any M871 will energize the switched conductor. The upper pair, pins 9 and 10, are digital inputs wired in parallel between the switched and negative conductors. All three units will sense a status change on Input 5 whenever the switched conductor is energized or de-energized. All digital inputs on the M871 incorporate an internal current limiting resistor so no external

resistor is required to prevent shorting (+) to (-) when digital outputs operate. It may be advisable, however, to place one pull-down resistor (R_P, in Figure A1) between the switched and negative conductors to prevent chatter on the inputs. Acceptable values for R_P depend on the application, but something in the $100k\Omega$ to $500k\Omega$ range should generally be safe in most cases.

Configuration:

Figure A2 illustrates a typical configuration that will initiate an oscillography recording and an SOE Log entry when the current exceeds a threshold on any of the three phases.

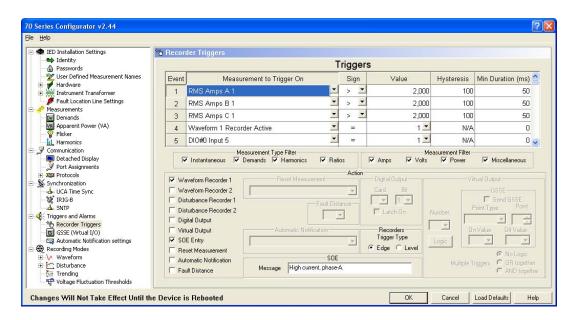


Figure A 2

Since a high current on one feeder would not normally be sensed by any other IEDs in a substation, a cross-trigger is necessary to initiate the oscillography recorders on all other IEDs. Figure A3 shows how any condition that triggers Waveform Recorder 1 also operates Digital Output 1 which initiates the cross-trigger. In this example, the contact dwells in the closed position for the length of time that Waveform Recorder 1 is running. (The characteristics of WR1 are set on a different page of the 70 Series Configurator.)

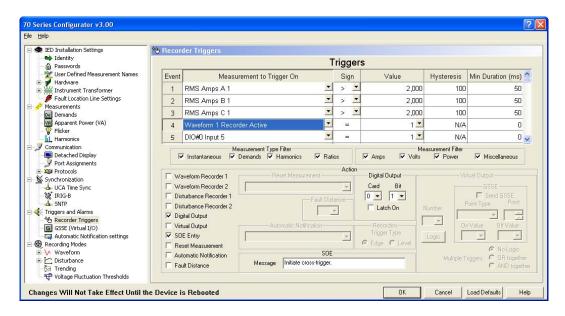


Figure A 3

Figure A4 shows the action taken when a cross-trigger on Digital Input 5 is sensed. In general, receiving a cross-trigger from another device should have the same effect as triggering on something sensed directly by the IED.

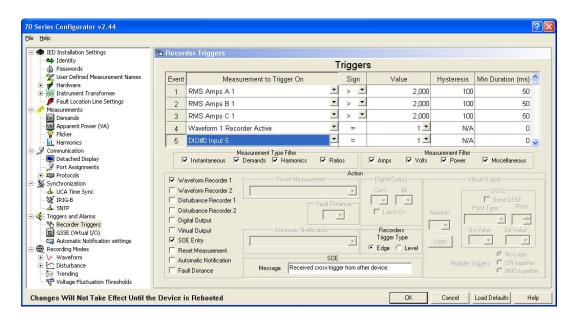


Figure A 4

Example 2. Ethernet, using GOOSE:

GOOSE is a function defined within the context of the IEC-61850 standard but there is no requirement to make use of any other aspect of 61850 just to use GOOSE for cross-triggering 70 Series IEDs. Due to the level of multi-vendor support for IEC-61850, cross-triggering between 70 Series IEDs, microprocessor based relays, and other devices may be an advantage of using GOOSE for cross-triggering. If a broader use of IEC-61850 is not intended, however, the user may find cross-triggering via GSSE (see Example 3) just as effective and somewhat simpler to set up.

In a broader application of IEC-61850, GOOSE could be used for much more than what is described in this example, but when applied simply for cross-triggering, it can be envisioned as a method to communicate a binary status over an Ethernet medium, exactly analogous to status and control performed by discrete I/O points (see Example 1). GOOSE messages are reliable enough to be used for controlling interlocks and protective relay blocking schemes, and can be propagated even faster than discrete digital contacts because of the time that it takes for moving mechanical parts to operate.

GOOSE operates by means of publication and subscription to unsolicited, unacknowledged, multicast (sometimes anycast) messages on an Ethernet LAN, so GOOSE messages can not pass through a router into another network. In its simplest form, such a network could consist of as little as an Ethernet switch and the inter-triggered IEDs connected via conventional Cat. 5 cables. There is no need to uplink into any wider LAN or to operate with any other clients or servers on the network (except for the purpose of configuring the IEDs). So in a substation, security could be accomplished easily just by restricting physical access to the network.

Otherwise, when used in a secure general purpose network, GOOSE messaging can coexist unobtrusively with other network traffic including file transfer services useful for collecting the recordings captured by the IEDs.

Connection:

The M87x must be fitted with one of the available Ethernet options and be connected to a Local Area Network (LAN). The minimum hardware requirement for an M87x to support 61850 is 64MB SDRAM on the Host Processor. Older units built with 16MB SDRAM can either be upgraded with a new Host Processor Card (H11 or H12), or else cross-triggering could be accomplished via GSSE (see Example 3) instead of GOOSE.

Configuration:

As implemented on the 70 Series IED, IEC-61850 requires two separate software programs to configure. These are the *IED Configurator* (used to set up functions specific to 61850, like defining Datasets, GOOSE publication and subscription, etc.) and the *70 Series Configurator* (for trigger logic, recorder settings, and other legacy functions). Both programs are supplied at no cost with the M87x and are also available for download from the company's public FTP site.

The following steps illustrate a typical configuration:

1. In the *70 Series* Configurator, Figure A5 shows how any event of interest measured directly by an M871 is configured to initiate an oscillography recording and make an SOE Log entry. (Only Phase-A Amps is shown, but the Trigger window scrolls vertically and can hold up to 120 separate independent events.)

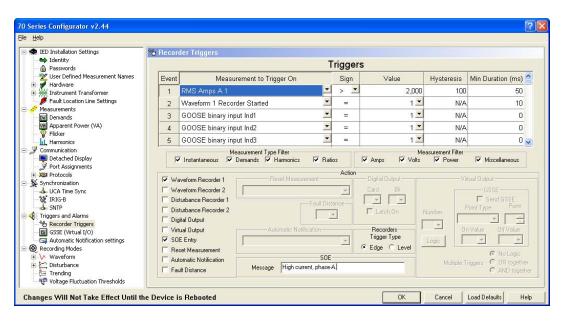


Figure A 5

2. The condition "Waveform Recorder 1 Started" is represented by a soft bit which is an element in the IEC-61850 Object Model (Records/WrxRDRE1.ST.RcdStr.stVal). Other soft bits are available to represent recorders WR2, DR1 and DR2 as needed (see 70 Series IEC-61850 manual, MICS document). The IED Configurator will be used in steps 4 and 5 below to make the M871 publish a GOOSE message when this bit changes status. The bit is set when WR1 begins recording. It remains set until it is reinitialized.

Note: No self-initializing bits are defined by the 61850 object model so an entry must be made in the 70 Series Configurator to re-initialize the bit a short time after it is set. Event 2 in Figure A6 illustrates that instruction. The choice of a particular duration (Event 2, far right column) as the dwell time before the bit is reset is more-or-less arbitrary, but should generally be shorter than the run-time of the recorder. No new cross-trigger can be sent via GOOSE until the bit is re-initialized and WR1 has completed recording.

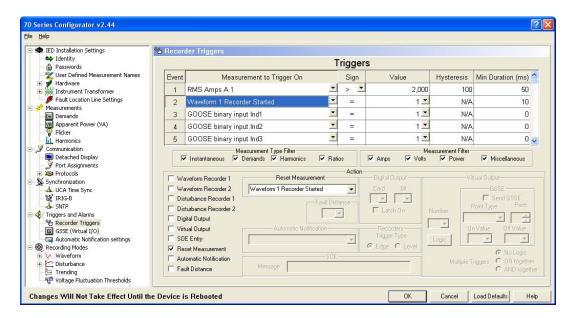


Figure A 6

3. When a cross-trigger is received from another unit, it comes in the form of a GOOSE subscription (set up in the *IED* Configurator in step 7, below). GOOSE subscriptions are represented in the *70 Series* Configurator by binary inputs that can be used to trigger WR1 and make an entry in the SOE Log. In this example, events 3, 4, and 5 shown in Figure A7 are the binary inputs received by subscribing to the GOOSE messages published by three other M871s on the network. This completes the settings that are made in the *70 Series* Configurator.

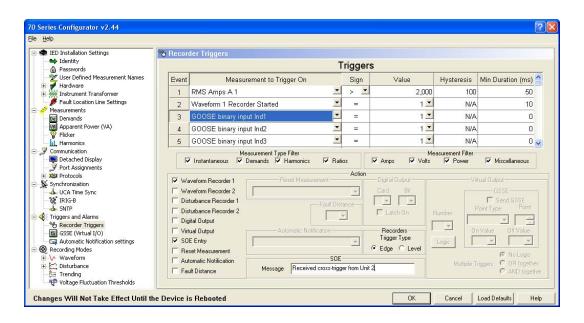


Figure A 7

4. The following settings must be made in the *IED* Configurator: Configuring an M871 to publish a GOOSE is a two step process. Figures A8 and A9 illustrate the first step, defining a Dataset that includes the soft bit described in step 2, above (Records/WrxRDRE1.ST.RcdStr.stVal).

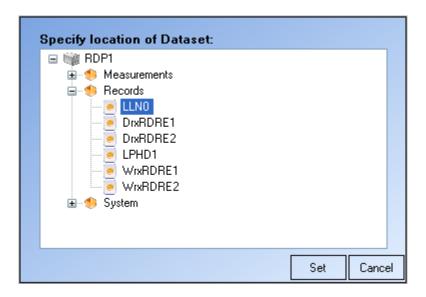


Figure A 8

Note: In order to be used for GOOSE publication, the Dataset must be defined under System\LLN0 as shown in Figure A9.

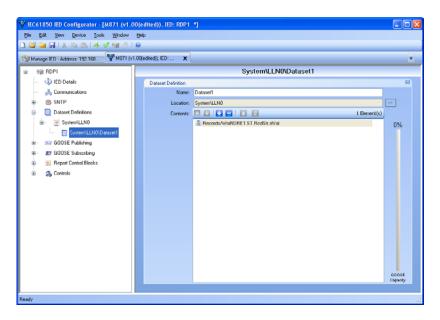


Figure A 9

5. The second step in publication is defining a GOOSE message, Figure A10. Up to eight independent GOOSE publications may be defined for each device. Only one is required for cross-triggering any number of other devices. System\LLN0\gcb01 is used in this example. All default entries shown in Figure A10 should generally be used in most cases, but the user must select the dataset defined in step 4, above, from the pull-down menu in the box Dataset Reference. Then the Configuration Revision must be incremented to at least 1 (usually incremented automatically by the IED Configurator). This Revision number must match the corresponding GOOSE subscription settings on all the other inter-triggered IEDs on the network (see step 7, below).

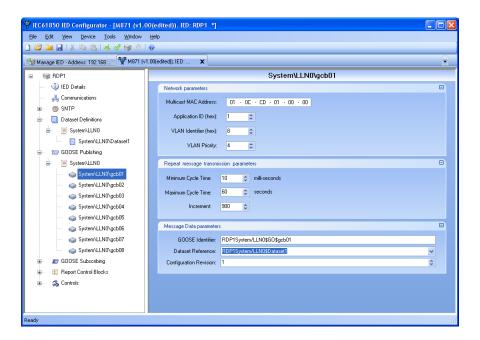


Figure A 10

6. Each IED only needs to publish one GOOSE to cross-trigger any number of other devices. When setting up subscriptions, however, the device must subscribe to every other device from which a cross-trigger may be expected. For example, in a substation with four inter-triggered M871 units, each unit would publish one and subscribe to three GOOSE messages. Up to thirty-two separate status points may be defined for each device. These status points correspond to elements in the Dataset transmitted by the GOOSE message.

Refer to the points named System\GosGGIO1\Ind1.stVal through System\GosGGIO1\Ind32.stVal in Figure A11. These are the points in the *IED* Configurator that correspond to the points in the *70 Series* Configurator which were described in step 3, above. In the 70 Series Configurator these points are named GOOSE binary input Ind1 through GOOSE binary input Ind32. See Figure A7, Events 3, 4, 5, etc.

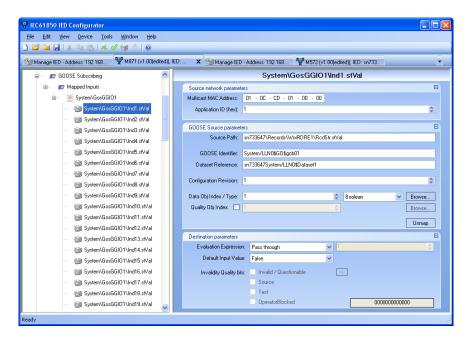


Figure A 11

- 7. The IED Configurator makes it relatively simple to configure subscriptions when the MCL files for all devices are open at the same time and the GOOSE publications have already been configured on each of the other devices. See Figure A12. By clicking on the Browse button, a window appears allowing the user to select the status point (green dot shown in Figure A12). Selecting the point (Records/WrxRDRE1.ST.RcdStr.stVal) causes a subscription to be configured for the GOOSE message that contains that status point. After selecting that point, next click on System\GosGGIO1\Ind2.stVal (see left side of Figure A11) and repeat step 7 selecting the same status point from the second M871 for the second subscription, and again with
 - **System\GosGGIO1\Ind3.stVal** for the third subscription, etc. until a subscription has been made to each of the other IEDs on the network.

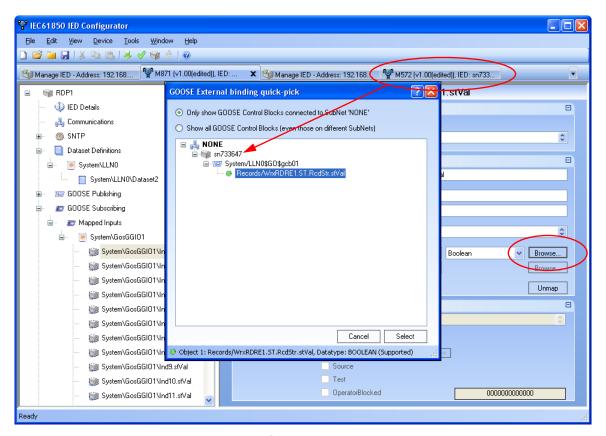


Figure A 12

8. Under **Destination Parameters** (see Figure A11 near bottom) verify that the pull-down menu labeled **Evaluation Expression** indicates **Pass through**. This completes the configuration settings for GOOSE subscription.

Example 3. Ethernet, using GSSE:

The GSSE service, as defined by IEC-61850, is identical to what has been called GOOSE in connection with UCA2.0 in past years. In order to reduce confusion as far as possible, all previous references to GOOSE in the UCA context have been replaced by the expression GSSE in 70 Series documentation because IEC-61850 supersedes UCA as a communications standard.

The use of GSSE to perform cross-triggering carries all the practical advantages of GOOSE and is simpler to set up, but has much narrower multi-vendor support. It is, however, available on all 70 Series IED firmware versions released since April 2004, so GSSE may be a better choice when it is either unnecessary to trigger other devices, or when triggering other vendors' devices might as easily be accomplished with discrete digital I/O while using GSSE among the 70 Series IEDs installed.

As with GOOSE, there is no need to make use of any other aspect of 61850 or UCA protocols just to use GSSE for cross-triggering.

GSSE can generally be envisioned as a way to communicate a binary status over an Ethernet medium, exactly analogous to status and control performed by discrete I/O points (see Example 1). GSSE messages are reliable enough to be used for controlling interlocks and protective relay blocking schemes, and can be propagated even faster than discrete digital contacts because of the time that it takes for moving mechanical parts to operate.

GSSE operates by means of transmitting and receiving unsolicited, unacknowledged, multicast messages on an Ethernet LAN, so GSSE messages can not pass through a router into another network. In its simplest form, such a network could consist of as little as an Ethernet switch and the inter-triggered IEDs connected via conventional Cat. 5 cables. There is no need to uplink into any wider LAN or to operate with any other clients or servers on the network (except for the purpose of configuring the IEDs). So in a substation, security could be accomplished easily just by restricting physical access to the network.

Otherwise, when used in a secure general purpose network, GSSE messaging can coexist unobtrusively with other network traffic including file transfer services useful for collecting the recordings captured by the IEDs.

Connection:

The M87x must be fitted with one of the available Ethernet options and be connected to a Local Area Network (LAN). There is no other minimum hardware requirement for an M87x to support GSSE. Older units that support UCA but not 61850 can exchange cross-triggers via GSSE from newer units that support 61850.

Configuration:

All settings required for cross-triggering with GSSE are made in the 70 Series Configurator. The following steps illustrate a typical configuration:

1. In the 70 Series Configurator, Figure A13 shows how any event of interest measured

directly by an M871 is configured to initiate an oscillography recording and make an SOE Log entry. (Only Phase-A Amps is shown, but the Trigger window scrolls vertically and can hold up to 120 separate independent events.)

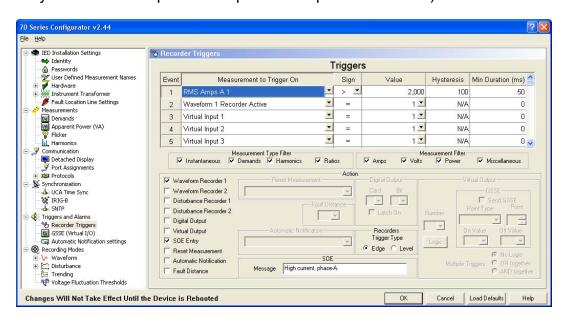


Figure A 13

2. The condition "Waveform Recorder 1 Active" is used to drive a Virtual Output that is linked to a GSSE message as illustrated in Figure A14. A Virtual Output can be driven by individual conditions (like RMS Amps A1 > 2000, in this example) or it could be the result of a combination of several conditions defined through rudimentary triggering logic.

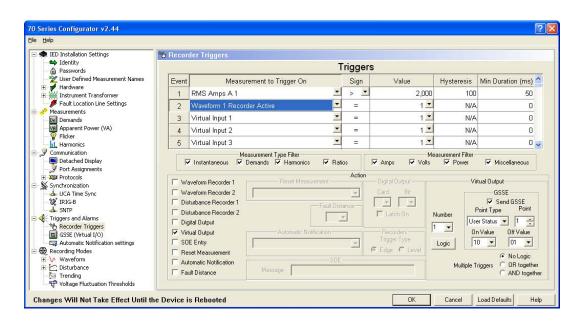


Figure A 14

Note: "Waveform Recorder 1 Active" can be considered to be a self-initializing

condition since it transitions from 0 to 1 when the recorder starts then returns to 0 (its initialized state) when the recording is completed. Therefore, no deliberate step is necessary to re-initialize a soft bit, as was required for "Waveform Recorder 1 Started" in step 2 of Example 2.

3. On the GSSE (Virtual I/O) page, define a GSSE Tx Name ("Unit 1" in this example) which is unique to the device sending the GSSE message as illustrated near the bottom of Figure A15.

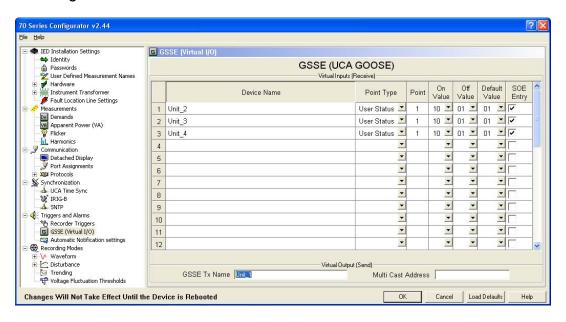


Figure A 15

- 4. When a cross-trigger is received from another unit, it comes in the form of a GSSE message. Each unique GSSE message must be associated with specific numbered Virtual Input as seen on top half of the GSSE (Virtual I/O) page of the 70 Series Configurator shown in Figure A15. Each device only needs to transmit one GSSE to cross-trigger any number of other devices. When setting up for receiving a crosstrigger, however, the device must be configured to receive GSSE messages from every other device from which a cross-trigger may be expected. For example, in a substation with four inter-triggered M871 units, each unit would transmit one GSSE and be configured to receive GSSE messages from all three other units. Up to thirty-two separate Virtual Inputs may be defined for each device.
- 5. On the Recorder Triggers page of the 70 Series Configurator, each of the Virtual Inputs defined in step 4, above, is then used to initiate the oscillography recorder and make an entry in the SOE Log. See Figure A16. This completes the configuration settings for cross-triggering by means of GSSE.

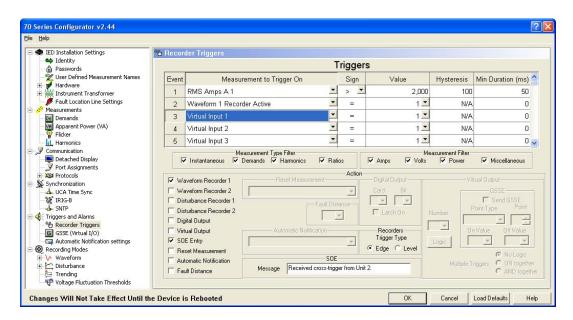


Figure A 16

APPENDIX B - FIRMWARE VERSION HISTORY

v1.11 New feature additions include user selection of measurements for the Trend Recorder, user selection of overwrite mode for file storage, and user selection of binary or ASCII Comtrade formats. Firmware changes have been made to correct a time set error encountered during daylight savings time. The Select-Before-Operate (SBO) configuration in UCA has also been changed to correct a problem discovered in earlier versions. v1.12 Fixed update of digital outputs via DNP

- v1.13 New product release adds event system, sequence of events, UCA GOOSE, and support for the P31 Digital Input/Output module.
- v1.14-1.17 Maintenance Upgrades.
- v1.18 Initial Firmware release for H11 host module. Support added for DNP event reporting.
- v1.19 Maintenance Upgrades
- v1.20 Add support for H11 host module and enable configurable measurement names.
- V1.21 Add auto-blanking for extremely low-level measurement readings
- v1.22-1.23 Maintenance Upgrades.
- v1.24 Added support for multiple Digital I/O cards. Supports Rate of change Triggers.
- v1.25-1.26 Maintenance upgrade
- v1.27 Added Measurements – Real & Reactive & Impedance for each phase. Added Telenet protocol. Added DNP analog events & DNP frozen counters. State of Time sync is now in database, viewable from Modbus, DNP, and Display protocols and can trigger recorders. Various maintenance upgrades
- v1.28-1.29 Maintenance upgrades.

APPENDIX B

Firmware Version History

v2.05 New features

- Support for new Mx72 hardware (dual bus signal inputs).
- Support for new P40 module (transducer inputs).
- Added the following new measurements: bus 2 currents, bus 2 power, bus 2 energy, bus 2 demands, unbalanced, transducer inputs.
- Added voltage fluctuation table
- Improved SOE log including adding user's message
- Support CT wiring of CBA.
- All Digital Inputs are now recorded in Waveform Recorders.
- Digital inputs can support resetting the demands
- Created counters for digital and virtual inputs
- Added Zmodem command "attrib" .
- Added Recorder Active Bits for DR1,DR2,WR1,WR2.

Maintenance upgrades

v2.06 Maintenance upgrade

v2.12 **New Features**

- AND/OR logic and timers for triggers for virtual outputs
- Added the derivative of any measurement that has a rate of change trigger to the measurement database
- **Auto Event Notification**

Maintenance upgrade

v2.15 Maintenance upgrade

v2.17 **New Features**

- Fault location (distance-to-fault)
- Adjustable sampling rate on waveform capture

Maintenance upgrade

V2.18 **New Product Release**

Added per phase Watts ,VAr, & VA.

Configurator & Biview improvements w/ modems.

Change to Digital I/O default watchdog contact (Configurator (setup not firmware dependent).

Support new version of hardware on P3x, P4x modules.

V3.01 New Product Release

Implementation of IEC 61850 protocol

August 15, 2018

Added Support of SNTP for time synchronization

Added average 3-phase Amps & average 3-phase Volts

V3.02 **New Product Release**

Simplified configuration for distance-to-fault measurement Improved transducer input data update rate Improved accuracy on frequency measurement to 1mHz Increased waveform capture length of individual file

V3.03	Maintenance Upgrade
V3.04	New Product Release Added Peak Fault Current Measurements Added Virtual I/O into Disturbance Recorders Added support of control characters for text/SMS messages Improved password security
V3.05	New Product Release Added support for dual peak current input range M872 (S16, S17), Added IEEE C37.232 naming convention Added periodic triggering Increased to 4 IEC 61850 buffered reports
V3.06	Maintenance Upgrade
V3.07	New Product Release Increased pre and post trigger times for DR recorders Modified base memory to 1MB
V3.08	Maintenance Upgrade
V3.09	Support for split core CT in M571 only Added maximum voltage difference as additional trigger value
V4.01	Support for H12 and H12 Ethernet (E1, E3) modules
V4.02	Support for IEC 61850 deadbands
V4.07	Support for IEC 61850 configuration option and DNP3 certification Maintenance upgrade
V4.082	Support for S1C Split-Core Option
V4.084	Maintenance upgrade
V4.09	Support for P33 module
V4.10	Maintenance upgrade
V4.11	Add double point status object for input bit pairs, add IEC61850 support for P33 module

V4.13	Added SER .csv file; maintenance upgrade
V4.15	Maintenance upgrade
V4.16	Support for S2C Split-Core Option
V4.17	Maintenance upgrade



Measurement Products

Change of Company Name / Ownership

Product Technical Compliance, Type Test Certificates & Declarations of Conformity

Areva's Transmission & Distribution Measurement Unit based in Bethlehem Pennsylvania, USA was purchased by NovaTech LLC on July 1, 2008, and henceforth continues to operate as an affiliate of NovaTech LLC under the company name of:

Bitronics LLC 261 Broadhead Road Bethlehem, PA 18017, USA

The change of ownership and company name at the Bethlehem location has resulted in the Measurement organization and it's operations remaining substantially the same. In regards to product technical compliance and performance claims, the following points indicate business continues as usual for the Bethlehem site:

- · Technical Staff have been retained.
- · Instruments will continue to be designed in Bethlehem.
- · Production processes are unchanged.
- Measurement products are retained.
- A revision on product labels to indicate Bitronics as the company name shall be implemented.
- A strategic partnership agreement has been entered with Areva T&D, such that Bitronics LLC will manufacture products to be globally distributed under the AREVA T&D MICOM brand. A revision to product labels is anticipated.

Continuing to the subject addressing some of the necessary technical documentation, which is relied upon, the intent is to utilize existing product Type Test Certificates and Declarations of Conformity. The change of company name will not be implemented retroactively on these types of documents. Instead the change of company name to Bitronics will appear on new documents moving forward, that are created after July 1, 2008. Existing product approvals will be relied upon.

Andre Wagner – R&D Manager

Date: Oct 2, 2008

Issue 1

Declaration of Conformity (for CE marked models of M87x)

The Declaration of Conformity, DOC B001 that appears in this manual is applicable for M87x models that are CE marked. The CE mark, if applicable, will be located on the case label found on the side of the product.

If the CE mark is not contained on the product, then the Declaration of Conformity, DOC B001, is not applicable for those particular products that do not bear the CE mark.



EU Declaration of Conformity

This declaration of conformity is issued under the sole responsibility of the manufacturer.

We, the undersigned:

Manufacturer:	Bitronics LLC	Authorized	NovaTech Europe BVBA
	261 Brodhead Road	Representative	Kontichsesteenweg 71
	Bethlehem, PA 18017-8698, USA	in the	2630 Aartselaar, Belgium
	T +610.997.5100	European Union:	T +32.3.458.0807
	F +610.997.5450		F +32.3.458.1817
	E <u>bitronics@novatechweb.com</u>		E info.europe@novatechweb.com

hereby declare that the following product(s):

Product type:	M870 Series	
Description: M87x IEDs / Multi-Function Recording Transducers and Event Monitors		
Models (Object of	M871 - using chassis C07A5, C10A7, or C12x8 with any of the following modules or components: A10, H10, H11, H12, P10, P11, P12, P20, P30A, P31, P32, P40, S10uc, S11uc, S12uc, V10, M870-MODIRIGBCV.	
Declaration): [Modules in gray text	M872 - using chassis C10A7, or C12x8 with any of the following modules or components: A10, H10, H11, H12, P10, P11, P12, P20, P30A, P31, P32, P40, S13uc, S14uc, S15uc, S16uc, S17uc, V10, M870-MODIRIGBCV.	
= NOT RoHS compliant]	878 - using chassis C07A5, C10A7, or C12x8 with any of the following modules or components: H10, H11, H12, P10, P11, P12, P20, P30A, P31, P32, P40, V10, M870-MODIRIGBCV.	

Conform(s) with the protection requirements of the following directive(s):

- 1. European Community Directive on EMC (EMCD) 2014/30/EU, superceding 2004/108/EC, and Directive 91/263/EC [TTE/SES]. Fulfilment of the essential requirements set out in Annex I has been demonstrated.
- 2. European Community Directive on Low Voltage (LVD) 2014/35/EU, superceding 2006/95/EC

Fulfilment of the safety objectives referred to in Article 3 and set out in Annex I has been demonstrated.

3. European Community Directive on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS "recast"), 2011/65/EU.

Fullfillment of the essential requirements referred to in Article 4 has been demonstrated.

To the best of our knowledge,

The object of the declaration described above is in conformity with the relevant Union harmonisation legislation:

2014/30/EU - EMCD Directive (from April 20th, 2016), superceding 2004/108/EC (withdrawn April 19th, 2016),

2014/35/EU - LVD Directive (from April 20th, 2016), superceding 2006/95/EC (withdrawn April 19th, 2016),

2011/65/EU - RoHS ("recast") Directive of the European Parliament and of the Council of 8 June 2011.

Reference Number: Issue: S DOC B001

Date of issue: 12-January-2018

August 15, 2018

The following route(s) were used to establish conformity:

1. 2014/30/EU: (EMCD) In accordance with

Article 14, Annex II (internal production control) supported by a Technical File,

superceding 2004/108/EC, in accordance with Article 7, Annex II.

Technical Construction File No. :	RFI/TCFT1/43054JD02 including Annex/Appendices	
Date Revised :	14-Dec-2016 or later- New Legislative Framework & EMC Directive	
	(original issue dated 07-January-2003);	
	(prior re-issue dated 30-November-2012)	
Conformity Assessment Body : (C.A.B.)	Radio Frequency Investigation Ltd Ewhurst Park, Ramsdell, Basingstoke, Hampshire, England. RG26 5RQ.	
	Underwriters Laboratories, Inc., Melville Division 1285 Walt Whitman Road, Melville, NY 11747-3081 USA	
Compliance Certificate / Test Report:	RFI/CBCB2/43054JD03 E164178, 03ME15424, M871, MA/EMC; E164178, 03ME15424/04ME06474, M877, MA/EMC; E164178, 04CA42217, M871 in C12X8, MA/EMC; E164178, 06CA09838, M87x IRIG-B Converter, EMC, File MC15156; E164178, 06CA43637, M872 with P40 Module in C10A7, MA/EMC; E164178, 1001052984, M87x, M57x, M870D, M570Dx EMC 09CA09082; E164178, 12ME06094, M87x with H12, EMC, incl. tests by MFG.	

2. 2014/35/EU: (LVD)

Self Certification supported by a Technical File, in accordance with Article 12, Annex III (internal production control), superceding 2006/95/EC.

Technical File No. :	TF B001	
Date Revised :	21-Dec-2016 or later - New Legislative Framework & LVD Directive (original issue dated 02-December-2002); (re-issue dated 01-October-2013 covered transition to IEC 61010-1 Ed. 3)	
Conformity Assessment Body : (C.A.B.)	UL Northbrook, 333 Pfingsten Rd, Northbrook, IL 60062-2096, USA	
Compliance Certificate / Test Report:	CB Certificate No. US-22412-UL issued by National Certification Body: UL (US), 333 Pfingsten Rd., IL 60062, Northbrook, USA / CB Test Report E164178-A3-CB-1-Original and E164178-A3-CB-1-Correction-1, Models M87x, or 87x, Product Safety Assessment, Project 13ME04905 & SR40508.20439.	

Reference Number: DOC B001 Issue: S

Date of issue: 12-January-2018

3. 2011/65/EU: (RoHS "recast") Restriction of the use of certain hazardous substances in electrical and electronic equipment(*) Self Certification supported by a Technical File, in accordance with Article 4 (internal production control).

Technical File No. :	TF B001-RoHS2 (ANNEX)
Date Revised :	12-Jan-2018 or later - New Legislative Framework & RoHS (recast)
	Directive

The objects declared as RoHS compliant have a maximum concentration of 0.1% by weight in homogeneous materials for lead, hexavalent chromium, mercury, polybrominated biphenyls (PBB), polybrominated diphenyl ethers (PBDE), and 0.01% for cadmium, or qualify for an exemption to the limits as defined in Annex III or Annex IV of the RoHS Directive. Bitronics LLC certifies that the object(s) of declaration meet(s) the material requirements of the RoHS Directive 2011/65/EU, except where an exemption is allowed by the Directive. Compliant means that the substances restricted by the RoHS Directive and the subsequent amendments of the European Parliament are not contained in the finished product above the Maximum Concentration Limits, as stated below, unless the restrictive substance is subject to an exemption contained in Annex III or Annex IV of the RoHS Directive and subsequent amendments.

RoHS part compliance information has been determined based upon reasonable inquiries of our suppliers and represents our current actual knowledge based on the information provided.

Restricted Substance for EU RoHS	Maximum Concentration Limit (Allowable limit at homogeneous material level*)	
Lead (Pb)	0.1% by weight (1000 ppm)	
Mercury (Hg)	0.1% by weight (1000 ppm)	
Cadmium (Cd)	0.01% by weight (100 ppm)	
Hexavalent chromium (Cr)	0.1% by weight (1000 ppm)	
Polybrominated biphenyls (PBB)	0.1% by weight (1000 ppm)	
Polybrominated diphenyl ethers (PBDE)	0.1% by weight (1000 ppm)	
Bis(2-ethylhexyl) phthalate (DEHP)	0.1% by weight (1000 ppm), effective from 22 July 2021	
Butyl benzyl phthalate (BBP)	0.1% by weight (1000 ppm), effective from 22 July 2021	
Dibutyl phthalate (DBP)	0.1% by weight (1000 ppm), effective from 22 July 2021	
Diisobutyl phthalate (DIBP)	0.1% by weight (1000 ppm), effective from 22 July 2021	

'homogeneous material' means one material of uniform composition throughout or a material, consisting of a
combination of materials, that cannot be disjointed or separated into different materials by mechanical actions such
as unscrewing, cutting, crushing, grinding and abrasive processes;

<u>RoHS Exemptions</u>: Parts that exceed the maximum concentration limits at the homogeneous material level rely exclusively on the following exemption(s):

- 3.1 Exemptions allowed in Annex III, entitled Applications exempted from the restrictions in Article 4(1):
 - 6(c): Copper alloy containing up to 4% lead by weight.
 - 7(a): Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead).
 - 7(c)-1: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.
- 3.2 Exemptions allowed in Annex IV, entitled Applications exempted from the restriction in Article 4(1) specific to medical devices and monitoring and control instruments, as amended by Directive 2014/74/EU:
 - 36. Lead used in other than C-press compliant pin connector systems for industrial monitoring and control instruments. Expires on 31 December 2020. May be used after that date in spare parts for industrial monitoring and control instruments placed on the market before 1 January 2021.

Reference Number: DOC B001 Issue: S

Date of issue: 12-January-2018

The following standards were used for reference and to establish conformity:

IEC/EN 61010-1, Edition 3, 2010 UL 61010-1, Edition 3, 2012/05/11 CAN/CSA No. 22.2, No. 61010-1-12, Ed. 3, 2012/05/01	Safety requirements for electrical equipment for measurement, control, and laboratory use. Part 1: General requirements
IEC/EN 61010-2-030, Edition 1, 2010 UL 61010-2-030, Edition 1, 2012/05/11 CAN/CSA No. 22.2, No. 61010-2-030-12, Ed. 1, 2010/06/10	Safety requirements for electrical equipment for measurement, control and laboratory use. Part 2-030: Particular requirements for testing and measuring circuits
EN 61326-1: 2013	Electrical Equipment for measurement, control and laboratory use – EMC requirements
IEC/EN 60255-26: 2013 + AC: 2013 product standard used in part - reliance on basic standards	Electrical relays, Electromagnetic compatibility requirements for measuiring relays and protection equipment
EN 61000-6-4: 2007 + A1: 2011	Electromagnetic compatibility Part 6-4: Generic emission standard – Industrial environment.
EN 61000-6-2: 2005 + AC: 2005	Electromagnetic compatibility (EMC) Part 6-2: Generic standards - Immunity for Industrial environments.
EN 55011: 2009 + A1: 2010, EN 55011: 2016, Group 1 Class A	Radiated Emissions Electric Field Strength, AC Powerline Conducted Emissions
EN 55022: 2010 + AC: 2011 EN 55032: 2012 + AC: 2013 EN 55032: 2015 + AC: 2016-07 Group 1 Class A (Conducted on Ethernet port)	Electromagnetic compatibility of multimedia equipment - Emission Requirements
EN 61000-4-2: 2009	Electrostatic Discharge (ESD)
EN 61000-4-3: 2006 + A1:2008 + A2: 2010, Class III	Immunity to Radiated Electromagnetic Energy (Radio Frequency)
EN 61000-4-4: 2012, Severity Level 4	Electrical Fast Transient / Burst Immunity
EN 61000-4-5: 2014, Installation Class 3	Surge Immunity
EN 61000-4-6: 2014, Level 3	Immunity to Conducted Disturbances Induced by Radio Frequency Fields
EN 61000-4-8: 2010	Immunity to Power Frequency Magnetic FileIds
EN 61000-4-11: 2004	AC Supply Voltage Dips and Short Interruptions
IEC 60255-22-1: 1988, Class III	Electrical disturbance tests for measuring relays and protection equipment. Part 1: 1 MHz Burst disturbance tests.
EN 50581: 2012	Technical documentation for the assessment of electrical and electronic products with respect to the restriction of hazardous substances

Signed for and on behalf of the Company :	Olan Start
	Alan Staatz, Vice President, Engineering, Novatech, LLC / Lenexa, Kansas USA

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A/B 05/01/2009 Update Bitronics Name, Logo, cover page C 9/25/2009 C 9/25/2009 Updates per New Firmware release: Updated frequency accuracy specification in 1.3 a. 7.3 Updated standards in 1.4.2; Updated P40 Transducer input module poll rate specification in 1.0.3, 10.8.3, & Figure 21. Increased waveform recorder limit in 5.4.1 from 99 to 2000 cycles (or from 16.7 to 33.3 seconds at 60Hz). Added several paragraphs to address processing limits associated with generating long length waveform recorder COMTRADE files and recommendations to alleviate loss of data in long WR files. Removed paragraph entitled "5.4.2c Using the Disturbance Recorder for Fault Distance" and in 4.13 removed the reference to 5.4.2c. Moved Network Time Synchronization from Section 5.8 to 5.8.5. Moved SNTP from section 5.8.1 to 5.8.6. Rewrote section 5.8 through 5.8.7 to summarize Time sync methods. Added the ability for a DNP slave to solicit a request for time sync from the DNP master in order to periodically set the DNP time. Added SNTP Time Sync. DNP Time Sync and Best Clock to 4.14 List of Available Measurements. D 10/15/10 10 163 for SMS control characters, modifications in fault analysis section 5.4 including adding Peak Fault Measurement, updated Measurement table in 6.15 E 2/28/11 Updates per new firmware release: inserted new section 5.4.5 covering IEEE long file naming convention, 5.3.8 Periodic Triggering and updated signal input and accuracy and revenue accuracy sections for dual peak range current options. F 11/27/11 Updates per new firmware release: Note regarding reallocation of memory for recording and change to length of pre- and post-trigger time in DR in section 5.4 G 12/12/12 Added/corrected burden information on signal input modules S11, S14, and S17 on pages 2 - 4 and in section 7.3. Updated standards in section 1.4.2 Environment. Added information for new H12 host module and H12E1 and H12E3 H08/Ethemet options in sections 2, 3, and 8. Modified input range spec for digital I/O in low input range. Updated for change	Revision	Date	Changes	Ву
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